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Controllable growth, microstructure and electronic structure of copper oxide thin films

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DISSERTATION

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书山有路勤为径　学海无涯苦作舟

There is no royal road to learning.

−Yu Han

To my family,

To all the people who cared for me.

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Abstract

Copper oxide (Cu_2O, Cu_4O_3 and CuO) thin films have been deposited on unmatched substrates by sputtering at room temperature. The influence of oxygen flow rate and total pressure on the film structure and preferred orientation has been studied. The total pressure is a relevant parameter to control the texture of Cu_2O and Cu_4O_3 films, while the oxygen flow rate is effective to tune the preferred orientation of CuO films. Local epitaxial growth, where epitaxial relationship exists in columns of sputtered films, has been observed in Cu_2O and Cu_4O_3 films by using a seed layer. The seed layer will govern the growth orientation of top layer via the local epitaxy, independently of the deposition conditions of top layer. Unusual microstructure that both phases have the vertically aligned columnar growth has been evidenced in biphase Cu_2O and Cu_4O_3, which may relate to the local homoepitaxial growth of Cu_2O. The lower resistivity than that in single phase films has been observed in this biphase film. Annealing in air can increase the transmittance of Cu_2O films in visible region by the reduction of the impurity scattering, while the optical band gap is enlarged due to the partial removal of defect band tail. The optical properties and electronic structure of copper oxides calculated by *GW* approach with an empirical on-site potential for Cu *d* orbital, are in good accordance with experimental results from optical absorption, photoemission and electron energy loss spectroscopies.

Résumé

Des films minces d'oxydes de cuivre (Cu_2O, Cu_4O_3 et CuO) ont été déposés à température ambiante sur des substrats en verre et en silicium par pulvérisation magnétron réactive. Une attention particulière a été portée à l'influence des conditions de synthèse (débit d'oxygène et pression totale) sur la structure et l'orientation préférentielle des dépôts. La pression totale est le paramètre principal influençant la texture des films de Cu_2O et de Cu_4O_3. En revanche l'orientation préférentielle des films de CuO est contrôlée par le débit d'oxygène. Pour des films de Cu_2O et de Cu_4O_3, un phénomène de croissance épitaxique locale (CEL) a été mis en évidence. Il résulte de l'utilisation d'une première couche qui joue le rôle d'une couche de germination lors du processus de croissance. Ainsi, les films peuvent croître avec une texture donnée indépendamment de leurs conditions de synthèse. Cet effet de CEL a été mis à profit pour élaborer des films biphasés (Cu_2O + Cu_4O_3) qui présentent une microstructure originale. L'augmentation de la transmittance optique et du gap optique de films de Cu_2O a été rendue possible par des traitements thermiques dans l'air qui permettent de diminuer la densité de défauts dans les films. Finalement, les propriétés optiques et la structure électronique des oxydes de cuivre qui ont été calculées par la méthode *GW* sont en accord avec des résultats expérimentaux obtenus par absorption optique, photoémission et spectroscopie de perte d'énergie des électrons.

Zusammenfassung

Kupferoxiddünnschichten (Cu$_2$O, Cu$_4$O$_3$ und CuO) wurden selektiv auf amorphen Substraten durch Sputtern von einem Kupfertarget bei Raumtemperatur abgeschieden. Der Einfluss der Sauerstoffflussrate und des Gesamtdrucks auf die Schichtstruktur wurde untersucht. Der Gesamtdruck kontrolliert die Textur von Cu$_2$O und Cu$_4$O$_3$ Schichten, während die Sauerstoffflussrate die bevorzugte Orientierung von CuO Schichten beeinflusst. Lokales epitaktisches Wachstum kann genutzt werden um die Wachstumsrichtung der Schichten zu kontrollieren. Eine Saatschicht steuert die Wachstumsrichtung der oberen Schicht über epitaktisches kolumnares Wachstum unabhängig von den Abscheidungskonditionen der oberen Schicht. In Zweiphasen Cu$_2$O und Cu$_4$O$_3$ Schichten wurde vertikal ausgerichtetes kolumnares Wachstum in beiden Phasen nachgewiesen. Diese ungewöhnliche Mikrostruktur hängt mit dem lokalen epitaktischen Wachstum von Cu$_2$O zusammen. In den Zweiphasenschichten wurde eine höhere Leitfähigkeit als in Einphasenschichten beobachtet. Wärmebehandlung an Luft kann die Transmission von Cu$_2$O Schichten im sichtbaren Spektrum durch die Reduktion von Streuung an Verunreinigungen erhöhen, während die optische Bandlücke durch die partielle Entfernung des Defektbands vergrößert wird. Die durch den GW-Ansatz berechneten optischen Eigenschaften und Bandstrukturen von Kupferoxiden sind in guter Übereinstimmung mit den experimentellen Ergebnissen der optischen Absorption, Photoemission und Elektronenenergieverlustspektroskopie.

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Chapter 3   Tuning the structure and preferred orientation in reactively sputtered copper oxide thin films

Chapter 4   Self-assembled growth of vertically aligned columnar copper oxide nanocomposite thin films on unmatched substrates

Introduction

The binary copper-oxygen system contains two stable phases: Cu_2O (cuprite) and CuO (tenorite). Such compounds are used for decorative or antibacterial purposes since a few centuries [1]. In addition to these stable phases, a metastable one is also reported: Cu_4O_3 (paramelaconite) [2]. This oxide has been discovered as mineral during the late 1870s in Arizona [3]. Since copper atoms exhibit two oxidation states in Cu_4O_3, wet processes cannot be used to synthesis this metastable oxide with high purity rate. Although copper oxides may be considered as "old" materials, they are still attractive for several applications in optoelectronics [4], photocatalysis [5], Li-ion batteries [6], and low-cost solar cells [7], [8], due to their peculiar electrical and/or optical properties. Specially, the p-type conductivity and large optical absorption in the visible region enable 3 copper oxides to be p-type absorbers in solar cells. Although the first copper oxide based solar cell with the structure of $Cu-Cu_2O$ was fabricated in 1926 by L.O. Grondahl et al. [9], there was no continuous interest on this topic until ten years ago. Recently, copper oxides have been renewed to be a hot topic with respect to low cost solar cell applications, due to the copper elemental abundance, non-toxicity, easy fabrication and high theoretical efficiency (such as 20% in Cu_2O-based cells). However, up to now, the maximum measured efficiency only reaches 6.1% for $Cu_2O:Na/Al_xGa_{1-x}O$ heterojunction solar cells [7], and the origin of this weak efficiency is still ambiguous. Besides, the metastable phase Cu_4O_3 has drawn less attention as the difficulty to synthesize by traditional methods, yielding a mysterious veil on this material. Moreover, the electronic structures of CuO remain unclear, e.g. the type of band gap is still controversial, though this material has been widely studied since the discovery of copper-based superconductors. Therefore, it is of great interest to have a comprehensive understanding of growth, microstructure characterizations, electrical properties and electronic structures of binary copper oxides.

In this manuscript, the tunable phase structure and growth orientation, microstructure,

electronic structures, optical and electrical properties of copper oxides have been investigated. A main focus was dedicated to control the preferred growth orientation of reactively sputtered single phase copper oxide thin films by tuning the deposition parameters or using the concept of local epitaxial growth. Besides, the unusual microstructure of biphase thin films has been revealed in details. A joint experimental and theoretical study has been carried out to investigate the optical properties and electronic structures. For these investigations, copper oxide thin films have been deposited on glass and silicon substrates at room temperature by reactive magnetron sputtering from a metallic target. The phase structures of thin films have been determined by X-ray diffraction and Raman spectrometry. Transmission electron microscopy has been used to study the film microstructure. Optical properties and electronic structures have been investigated by optical absorption, ultraviolet photoemission spectroscopy and electron energy loss spectroscopy. The electrical properties have characterized by resistivity, Hall-effect and Seebeck coefficient measurements.

This manuscript is organized as below:

Chapter 1: A general review of basic physical properties of binary copper oxides, and recent progress of copper oxide based solar cells.

Chapter 2: An introduction of experimental and calculation methods, including the thin film growth and characterization methods, as well as the theoretical calculation appraoch.

Chapter 3: Tuning the structure and preferred orientation in reactively sputtered copper oxide thin films.

Chapter 4: Self-assembled growth of vertically aligned columnar copper oxide nanocomposite thin films on unmatched substrates.

Chapter 5: Optical properties and electronic structures of copper oxide thin films.

Chapter 6: Conclusions and outlook

Chapter 1   Basic properties of copper oxides and their application in low cost solar cells

1.1   Introduction

Copper oxide thin films have been studied for a long time. Since they exhibit p-type conductivity, the present studies are more and more dedicated to their use as p-type absorber layer in copper oxide based solar cells. Hence, the physical properties of copper oxides, including optical band gap, optical absorption coefficient, defect, mobility, carrier concentration and minority diffusion length, have strong influence on the performance of cells. Besides, the interface quality, band alignment and architecture between absorber and n-type window layer are also significant issues. In this chapter, a review of basic physical properties of copper oxides, including some debating points, and the recent progress of copper oxide based solar cells are presented.

1.2   Basic physical properties of copper oxides

1.2.1   Crystal structure

Cu_2O (cuprite or cuprous oxide) is a stable phase in the binary copper-oxygen system that crystallizes in a cubic structure (space group Pn3m). Its unit cell is composed of six atoms. Four copper atoms are located at a face-centred cubic lattice, and two oxygen atoms are positioned at tetrahedral sites, as shown in Fig.1.1(a). Copper atoms are coordinated with two oxygen atoms as the nearest neighbours, and oxygen atoms are fourfold coordinated with copper atoms, consequently the interatomic Cu-O, O-O and Cu-Cu distances are unique. The crystallographic properties are presented in Table 1.1.

Due to the metastable character of Cu_4O_3, this compound is scarcely mentioned in phase diagram calculations or experiments. This point may explain that the properties of paramelaconite are not well described in the literature. In this compound, the copper has mixed valence of Cu^{1+} and Cu^{2+}, but it cannot be considered as a mixture of Cu_2O and CuO as

it was previously described. The tetragonal crystal structure with I4$_1$/amd (141) space group is composed of the inter-penetrating chains of Cu^{1+}-O and Cu^{2+}-O, resulting in three kinds of interatomic Cu-O distances(Cu^{1+}-O(1), Cu^{2+}-O(2) and Cu^{1+}-O(2)), as shown in Fig.1.1(b). Here O(1) and O(2) just mean the different positions. One O(1) and four Cu(1) atoms form a tetrahedral, and O(1) locates on the centre. Similar situation occurs in O(2).
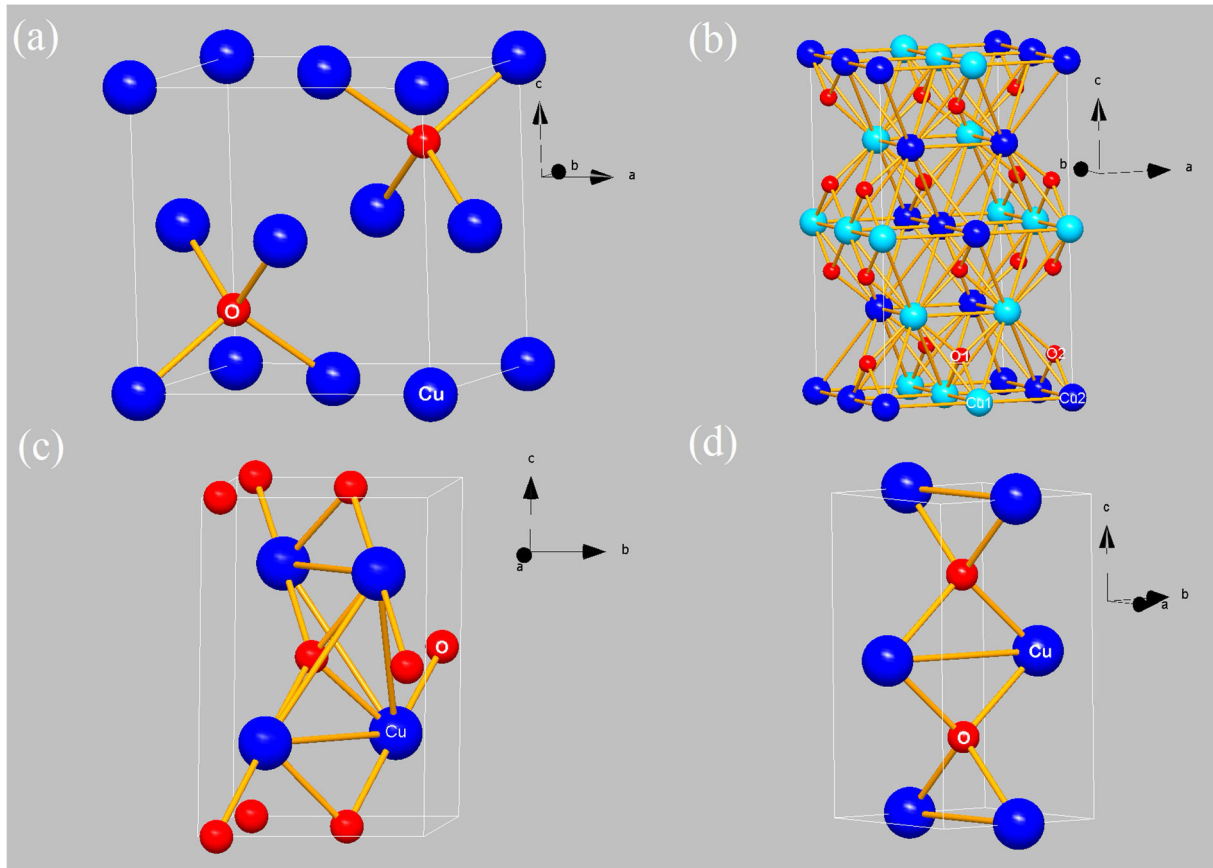
Fig. 1.1 Crystal structure of binary copper oxides. (a) Cubic Cu$_2$O. (b) Tetragonal Cu$_4$O$_3$. Cu1 (in sky blue) and Cu2 (in sky blue) represent Cu^{1+} and Cu^{2+}, respectively. O1 and O2 represent two kinds of oxygen positions. (c) Monoclinic CuO. (d) Tetragonal CuO.

The composition of CuO has two phases: monoclinic and tetragonal. In most case, CuO naturally stabilizes as the monoclinic phase (tenorite), with a C2/c space group. Each copper atom is coordinated to four co-planar oxygen atoms at the corners of a parallelogram, while every oxygen atom is coordinated to four copper atoms at the corners of distorted tetrahedron, as shown in Fig.1.1(c). Recently another structure has been reported for the equiatomic

composition that can be described as a distortered rocksalt-like structure along the *c*-axis (see Fig. 1.1(d)). This tetragonal structure is only stabilized with a few units thickness for thin films epitaxially grown on $SrTiO_3$ substrates. In tetragonal CuO, the Cu ions locate at the center of edge-sharing elongated CuO_6 octahedra, leading to numerous CuO planes stacked along c-axis. The Cu-O-Cu bond angle in this phase is 180°, while this angle is only 146° in monoclinic phase, indicating the high-symmetry of this tetragonal phase [11], [12]. Since the tetragonal CuO film is only stable in ultra-thin thickness, most of its properties are still unrevealed.

Table 1.1   Crystallographic properties of Cu_2O, Cu_4O_3 and CuO. (Ref.[12]–[18])

	Cu_2O Cubic	Cu_4O_3 Tetragonal	CuO Monoclinic	Tetragonal
Lattice constant (Å)	a=4.269	a=5.837 c=9.932	a=4.684 b=3.423 c=5.129 β=99.549°	a=3.9 c=5.3
Space group	Pn-3m	$I4_1$/amd	C2/c	$P4_2$/mmc
Density (g cm^{-3})	6.11	5.931	6.516	
Melting point (°C)	1230		1278	
Young's modulus (GPa)	30	55	81.6	
Gibbs free energy (kJ/(mol atom)	-39.22	-40	-45.89	
Special interplanar distance (Å)	(111) 2.464 (200) 2.134	(202) 2.516 (004) 2.483 (220) 2.064	(002) 2.529 (-111) 2.523	

It is worth of noting that some interplanar distances in cubic Cu_2O, tetragonal Cu_4O_3 and monoclinic CuO are quite close (see Table 1.1 and Fig. 1.2). Then it is hard to determine the phase structures directly by X-ray diffraction, especially in the case of textured polycrystalline thin films.
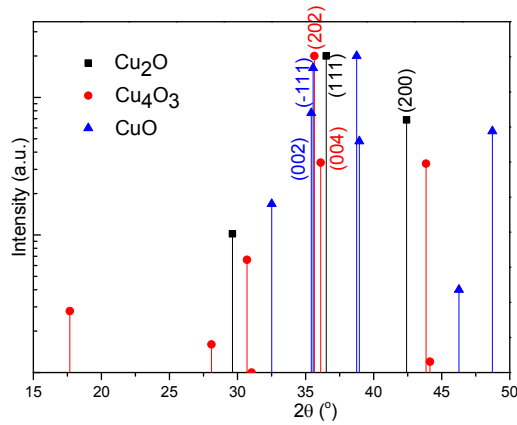
Fig. 1.2   X-ray diffraction information of binary copper oxides from JCPDS cards [12].

Raman spectrometry is a complementary tool to identify the phase structures of copper oxides, as these three oxides have significant difference in Raman active vibrational modes. Debbichi et al have combined the calculation (local density approximation with Hubbard-U correction, LDA+U) and experiments together to study the Raman vibrational modes in these three oxides, and the results are shown in Fig.1.3 [19]. It is worth noting that Debbichi et al believed that there is only one active vibrational mode of T_{2g} in Cu_2O, and other Raman peaks are due to resonant excitation or non-stoichiometry [19]. Referring to space group of Cu_2O, each unit cell contains two formula units, yielding fifteen optical phonon modes and acoustic lattice modes. The symmetries of vibrational models at k=0 are:

$$\Gamma_{Cu_2O} = A_{2u} + E_u + 3T_{1u} + T_{2u} + T_{2g} \tag{1-1}$$

Among these vibrational modes, only the T_{2g} one should be active in Raman. Sander et al have studied the correlation of intrinsic point defects and Raman modes systematically in Cu_2O by generalized gradient approximation (GGA) calculation and experiments, and more vibrations have been predicted due to the breaking of selection rules from defects [20]. This calculation seems to be more close to the experiment results. The calculated Raman frequencies of Zone-Center (Γ) phonons are summarized in Table 1.2, comparing with experimental ones. It should be pointed out the nominal activity has some contradiction with the experiments. The calculation in Cu_4O_3 predicts 42 vibrational modes with the following irreductible representations:

6

$$\Gamma_{Cu_4O_3}= 3E_g +A_{1g} +2B_{1g}+9E_u +6A_{2u}+5B_{2u}+2B_{1u} + 2A_{1u} \qquad (1\text{-}2)$$

6 of the 42 modes are Raman active (A_{1g}, B_{1g} and E_g) (see Fig. 1.3) [19]. The symmetries of vibrational models in CuO can be written as:

$$\Gamma_{CuO}= A_g + 2B_g + 4A_u + 5B_u \qquad (1\text{-}3)$$

which produces 12 photons vibrational modes, and 3 of them (A_g+2B_g) are Raman active (see Fig. 1.3) [19]. To be pointed out, all the Raman modes discussed here are the first-order process, not including the second-order scattering process.
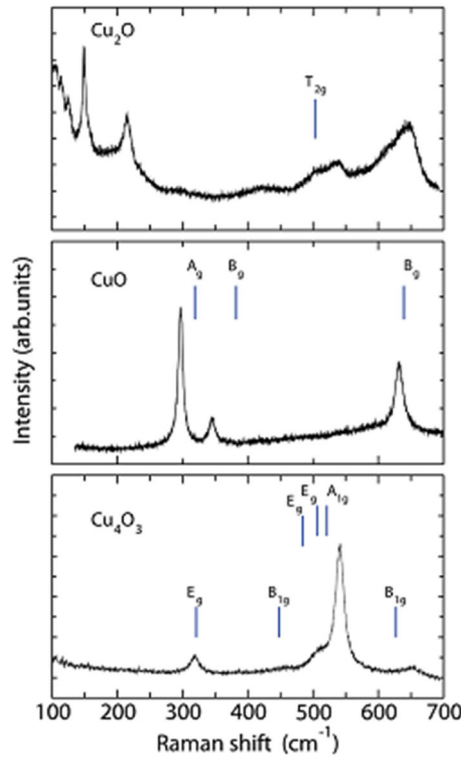
Fig. 1.3   Experimental Raman spectra of cubic Cu_2O, tetragonal Cu_4O_3 and monoclinic CuO. The calculated Raman active vibrational modes are indicated by vertical bar [19].

Table 1.2 Calculated (ω_c) and experimental (ω_e) Raman shift ((cm^{-1})) of Cu$_2$O [20], [21], Cu$_4$O$_3$ [19], [22] and monoclinic CuO [19], [22].

Cu$_2$O			Cu$_4$O$_3$			CuO		
Sym	ω_c	ω_e	Sym	ω_c	ω_e	Sym	ω_c	ω_e
T$_{2u}$	71	86~100	E$_g$	321	311~318	A$_g$	319	286~296
E$_u$	84	108~110	E$_g$	506	505~510	B$_g$	382	333~346
T$_{1u}$	147~148	147~152	A$_{1g}$	521	531~541	B$_g$	639	619~631
A$_{2u}$	338	308~350	B$_{1g}$	627	643~651			
T$_{2g}$	499	487~520						
T$_{1u}$(TO)	608	609~635						
T$_{1u}$(LO)	630	650~665						

1.2.2 Optical properties and band structures

1.2.2.1 Cu$_2$O

Early experiments on excitons of Cu$_2$O give a direct band gap of 2.17 eV at quite low temperature [23]. Recently, the first principle calculations predict a direct band gap of about 1.97-2.1 eV and an optical band gap of about 2.5-2.7 eV [24]–[26], while the experimental optical band gap is about 2.38-2.51 eV [27]. The band structure of Cu$_2$O is shown in Fig. 1.4(a), where the energies of valence band maximum (VBM, Γ_{25}), the first conduction band minimum (CBM, Γ_1) and the second CBM (Γ_{12}) are highlighted. The structure of Cu$_2$O, where the unit cell is rotated so that the O-Cu-O dumbbell motif is aligned along the z-axis is depicted in Fig. 1.4(b). The VBM is mainly composed of Cu-d orbital and has even parity. At the first CBM Γ_1, both the cation and the anion have contribution due to the O-Cu-O dumbbell structure, but the intrasite s-d hybridization results in a strong Cu-d_{z^2} contribution to first CBM, showing the even parity. Then, the optical transition between VBM and first CBM is dipole forbidden. However, the second CBM has a Cu-p_{xy} character, with odd parity. Hence, the optical transition between VBM and second CBM is allowed, and the value corresponds to the optical band gap [24]. The experimental energy difference between the first

CBM and the second CBM is about 0.45 eV. Although different methods, such as Heyd-Scuseria-Erzerhof (HSE), Green's function calculations with screened Coulomb interaction W (GW) and LDA+U, can well predict the band gap of about 2 eV, the conduction band ordering between the first CBM and the second CBM exhibits striking difference. Taking the $G_0W_0^{RPA}$(HSE) as an example, a band gap of 1.91 eV is obtained (close to the experimental 2.17 eV), but the energy difference between the first CBM and the second CBM is − 0.38 eV, contradicting to the positive values in experiments [24]. Among the various methods, HSE calculation has been demonstrated to be successful to describe the band gap and band ordering, at the expense of high computational overhead.
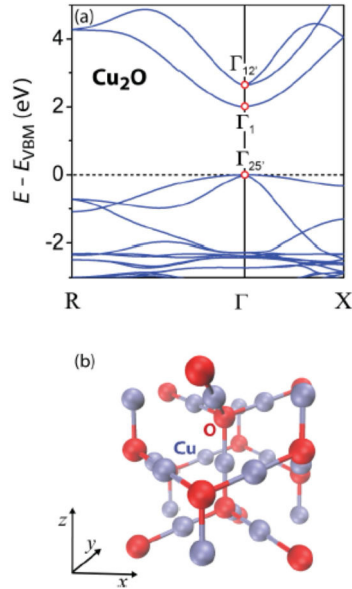
Fig. 1.4   (a) The band structure of Cu_2O. (b) The cuprite structure, shown so as to align the O-Cu-O dumbbell motif with the z-axis [24].

The computed density of states (DOSs) of Cu_2O by HSE+G_0W_0 are shown in Fig. 1.5. Comparing the full DOS with the partial DOS (PDOS), it is shown that the upper valence band is mainly composed of Cu $3d$ character, while the lower valence band part is of dominant O $2p$ character. There is a covalent mixing O $2p$ and Cu $3d$, yielding a more significant Cu $3d$ character in the upper valence band. The lower valence band part with O $2p$ states also mixes with the Cu $3d$ states and enhances the O $2p$ character.
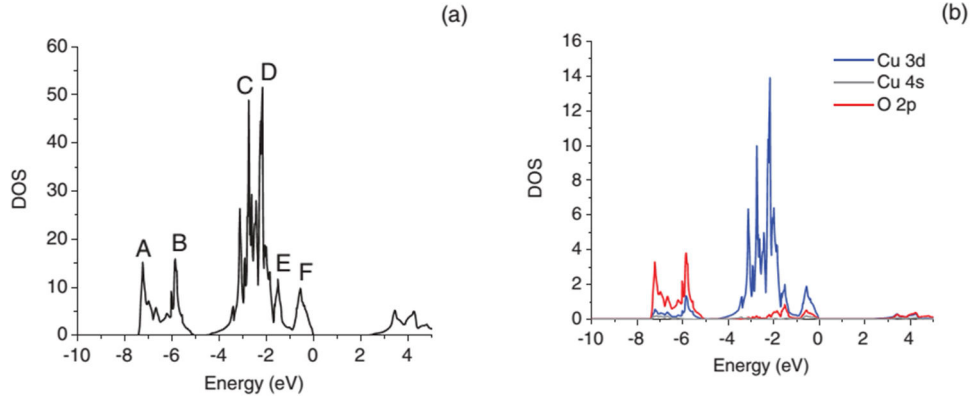
Fig. 1.5   Full (a) and partial (b) DOSs of Cu_2O calculated by by HSE+G_0W_0 [26].

1.2.2.2 Cu_4O_3

Although several groups have performed the first-principle calculation on band structure [25], [28], and the experiments on optical properties [23], [24], [5], the properties of Cu_4O_3 are still full of debating. For instance, the theoretical calculations predicate an indirect band gap of 0.78 eV by LDA+U [28]), and of 2.54 eV by HSE [25]. On the contrary, Ooi et al. concluded a direct band gap of 2.2 eV by optical method [30]. Additionally, Pierson et al. attained the experimental optical band gap of 1.34 eV or 2.47 eV, assuming either an indirect or a direct band gap, respectively [29]. An indirect band gap of 1.25 eV was deduced from linear augmented-plane-wave (LAPW) calculation [31].

Fig. 1.6 presents the electronic band dispersion of Cu_4O_3 calculated by LDA+U [28], which clear shows the indirect band gap of 0.78 eV. The corresponding DOSs are depicted in Fig. 1.7. Looking into the details of DOS, the lower valence band is of dominant $Cu^{1+/2+}$ $3d$ states, and here strong O $2p$ and Cu $3d$ hybridization exists, yielding more significant Cu $3d$ character. The upper valence band has O $2p$ character, accompanying with a hybridization. Moving on to the conduction band, the DOS of Cu^{1+} is quite smaller than that of Cu^{2+}, while the energy difference between main Cu^{2+} and Cu^{1+} empty states is about 2 eV.
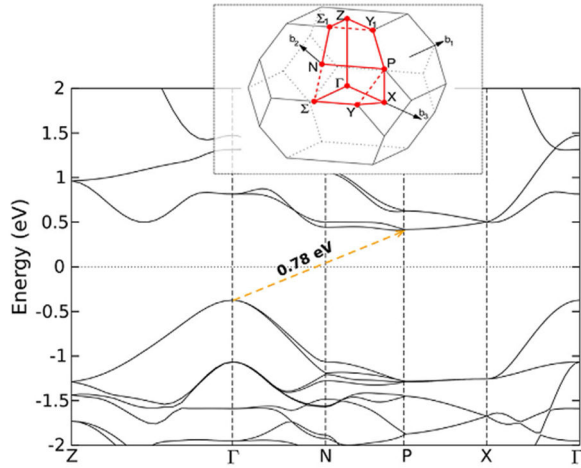
Fig. 1.6   Electronic band dispersion of Cu_4O_3 calculated by LDA+U [28].
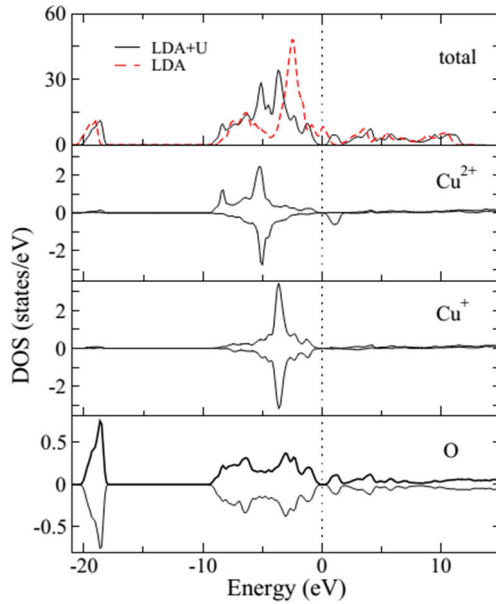
Fig. 1.7   Full and partial densities of states in Cu_4O_3. Energy with respect to the Fermi level.Top panel: Total DOS obtained in the LDA (with non-magnetic ground state) and LDA+U (AF_2 ground state). Lower panels: local spin-resolved DOSs on Cu^{2+}, Cu^{1+} and O sites (average) in LDA+U. Positive (negative) values for spin-up (down) [28].

1.2.2.3   Monoclinic CuO

Even though monoclinic CuO has been widely studied for decades, there are still divergent reports regarding its electronic and optical properties, due to its strong correlated interaction among charge, spin, orbital and lattice. For instance, there is a contradiction in the type of band gap: direct or indirect band gap. HSE and LDA+U calculations from Heinemann et al.

yield the indirect band gap of 2.74 and 1.39 eV, respectively [25]. Whereas, other articles suggest a direct band gap of about 1.4 eV [5], [32], [33]. Moreover, the electronic structure of CuO is still unambiguous, as the calculation electronic structure strongly depends on the calculated methods or parameters [34]. For instance, different nonlocal Hartree-Fock exchange α in HSE calculation will shift the states and change the band gaps, as shown in Fig. 1.9(a). Similar situations exist in Perdew-Burke-Ernzerhof with exchange correction functional (PBE+U) calculation when tuning the U values (see Fig. 1.9(b)) [34].
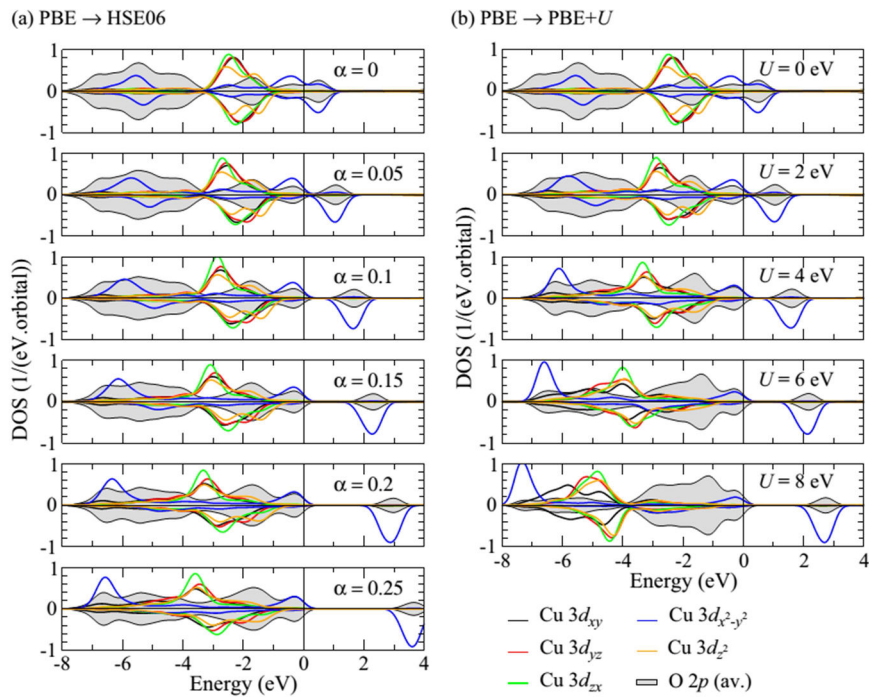
Fig. 1.9 Orbital-projected DOS calculated with the hybrid functional for varying α (a) or with the PBE+U functional for varying U (b). The spin-up (positive values) and spin-down (negative values) contributions of the individual Cu $3d$ orbitals and the O $2p$ orbitals are shown. The VBM is set to zero and all DOS are convoluted with a Gaussian of 0.5 eV full width at half maximum (FWHM) [34].

1.2.2.4 Tetragonal CuO

Recently, the tetragonal CuO (also called elongated rocksalt structure) has drawn increasing attention owing to its predicted high Néel temperature [10], [11], [17]. A recent experiment gets a Néel temperature of 600 K [35]. Besides, Bednorz et al. have stated that oxides containing transition metal ions with partially filled e_g orbitals (such as Cu^{2+}) will undergo

strong Jahn-Teller distortion and consequently can have strong electron-phonon interaction, possibly giving rise to superconductivity [36]. The valence band spectra of tetragonal and monoclinic CuO are shown in Fig. 1.10, which shows some differences in the valence band structure [17]. However, it remains to be difficult to understand the differences [17]. The comparison between calculated DOS and experimental valence band spectrum is shown in Fig. 1.11. The main peak at -3.5 eV mainly originates from $Cu\,d_{z^2}$ states. The low energy region below -4 eV is composed of strong hybridization between Cu and oxygen states [37]. Some unclear difference still exists between experiments and calculations.
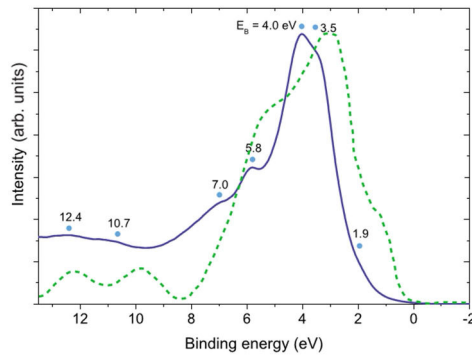
Fig. 1.10   Photoemission valence band spectra of tetragonal (solid line) and monoclinic (dotted line) CuO [17].
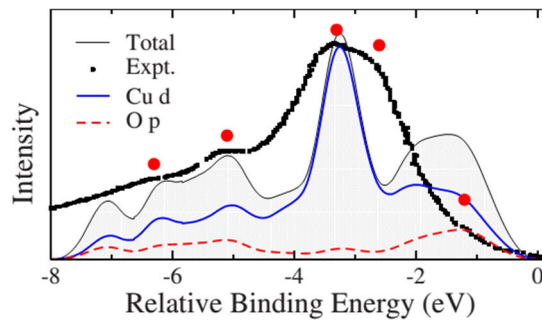
Fig. 1.11   Calculated DOS and experimental valence band spectrum of tetragonal CuO [37].

1.2.3   Electrical properties and defect mechanism

Cu$_2$O, Cu$_4$O$_3$ and CuO are intrinsic p-type semiconductors. Among these three oxides, Cu$_2$O has received intensive study, as it possesses larger experimental optical band gap (2.38-2.51 eV) [27] and higher mobility simultaneously than other p-type semiconductors.

Room temperature mobility of 100 $cm^2V^{-1}s^{-1}$ can be reached in single crystal Cu_2O, while thin films deposited at high temperature can produce room temperature mobility of 62 $cm^2V^{-1}s^{-1}$ easily [38]. 5 $cm^2V^{-1}s^{-1}$ has been attained by low temperature (225 ^oC) atmospheric atomic layer deposition (AALD) [39]. Such high mobility is one of the reasons that Cu_2O has drawn much attention in p-type transparent conductive materials [4], which may originate from its lower effective mass (0.575 m_o, m_o is the free electron mass) [27], [40]. However, it is a hard task to get the high mobility in Cu_4O_3 and CuO.

The origin of p-type conductivity in Cu_2O has been studied systematically by calculations and experiments. Theoretical calculations by different methods have confirmed that copper vacancies, including the simple V_{Cu} and the split complex configuration V_{Cu}^{Split} (it can be understood as the insertion of an interstitial copper atom in between two V_{Cu}), act as shallow hole-producers and account for the intrinsic p-type conductivity [32], [33], as shown in Fig. 1.12. The calculated (0/-) transition levels for V_{Cu} (0.22 eV) and V_{Cu}^{Split} (0.47 eV) are in agreement with the trap levels measured by deep level transient spectroscopy (DLTS) study at 0.25 and 0.45 eV above the valence band maximum [32], [34]. Besides, the existence of V_{Cu}^{Split} complex defects has also been proved by Raman [20]. In addition, the role of hydrogen related defects has been theoretically studied [44]. Hydrogen prefers to bind into V_{Cu} under O-poor and O-rich conditions, resulting in a complex H-V_{Cu} defect. This kind of defect has quite low formation energy and acts to kill p-type conductivity [44].
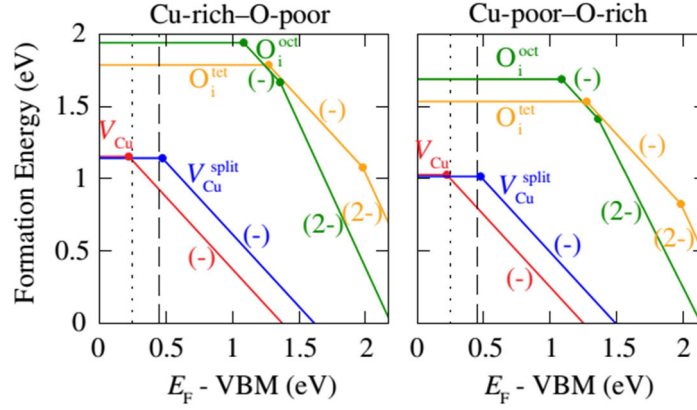
Fig. 1.12 Formation energy for intrinsic p-type defects in Cu_2O in (a) Cu-rich (or O-poor) conditions and (b) Cu-poor (or O-rich) conditions. The dotted and the dashed lines indicate the positions of two traps from experiments [41].

The defect mechanism of CuO has been calculated preliminarily by LDA+U, which predicts that V_{Cu} is the main defects to produce p-type conductivity [45], [46]. However, the selection of Brillouin zone in Ref. [45] is thought to be questionable [8]. The defect mechanism of Cu_4O_3 has not been reported.

The evolution of room temperature resistivity as a function of oxygen flow rate in sputtered copper oxide thin films is depicted in Fig. 1.13, where the shaded areas represent the single phase synthesis window [8]. In these three single phase oxides, there is a similar tendency that increasing the oxygen flow rate can decrease the resistivity. In Cu_2O, this behavior can be understood from the defect mechanism shown in Fig. 1.12. In oxygen rich conditions (high oxygen flow rate), the formation energies for V_{Cu} and V_{Cu}^{Split} are lower, giving rise to higher carrier concentration, consequently decreasing the resistivity. It is interesting to note that the biphase thin films (Cu_2O + Cu_4O_3 or Cu_4O_3 + CuO) have lower resistivity than single phase films, as shown in Fig. 1.13. However, the Ref. [8] does not give a detailed explanation of this experimental result.
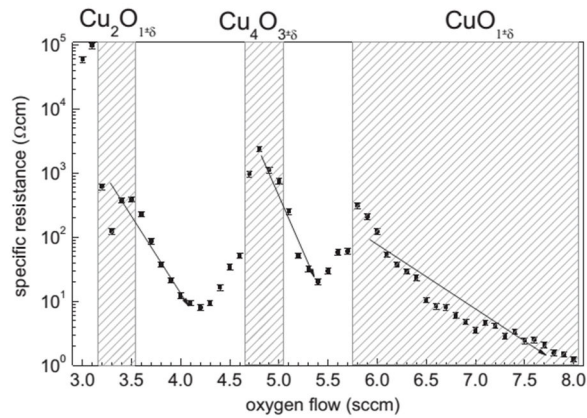
Fig. 1.13 Resistivity as a function of oxygen flow rate in copper oxide thin films [8]. Specific resistance means resistivity.

1.2.4 Debating issues

1.2.4.1 n-type Cu$_2$O: fact or fiction?

Although Cu$_2$O is well known to be a native p-type semiconductor, the literature surprisingly reports the n-type electrodeposited Cu$_2$O thin films by tuning the pH value [47]–[51]. However, up to now, there is no work that reports the n-type Cu$_2$O thin films deposited by physical methods, such as magnetron sputtering or pulsed laser deposition. The calculations have demonstrated that intrinsic defects are not the source of n-type conductivity in undoped Cu$_2$O thin films [52]. Hence, the origin of n-type conductivity in electrodeposited Cu$_2$O thin films remains unknown. Here, three key points about the electrodeposited Cu$_2$O thin films should be taken into consideration carefully. First, the electrodeposition process occurs in aqueous solution, where the contaminations cannot be avoided. Second, conductive substrates, such as indium tin oxide (ITO), fluorine doped tin oxide (FTO) or Au, are required for the electrodeposition. Then high resistivity Cu$_2$O thin films locate on the top of conductive substrates, making the physical measurements (like Hall effect and Seebeck coefficient measurements) to determine the conductive type impossible, unless the conductive substrates are removed. Third, all of n-type Cu$_2$O thin films have been characterized by the electrochemical or photochemical methods in solution atmosphere, which has more uncertainties than physical methods. Similar situation exists in n-type CuO thin films. Thus, special attention should be paid to the n-type copper oxide thin films.

1.2.4.2 Oxygen vacancy charge in Cu$_2$O: positive or neutral?

Most of the photoluminescence (PL) spectra assume that oxygen vacancy V_O is in positive charge [8], [53]–[55]. However, recent theoretical results obtained by several groups using different calculation methods tend to show that the oxygen vacancy in Cu$_2$O is only stable in the neutral state [42], [44], [56]. This also seems to mean that the assignments of defect peaks in previous PL spectra should be reconsidered.

1.3 Synthesis methods

Till now, different kinds physical depositions (including magnetron sputtering (MS) and pulsed laser deposition (PLD), chemical methods (such as chemical vapor deposition (CVD) and atomic layer deposition (ALD)) and liquid phase synthesis (such as electrodepostion and hydrothermal synthesis) have been widely used to grow copper oxide thin films. Here, we do not want to present the details of different methods, but it is valuable to discuss their advantages and disadvantages.

Physical deposition usually occurs in the vacuum atmosphere, whereas liquid phase synthesis exists in solution with non-vacuum atmosphere. This means the low content of H-related defects (acting as hole killer [44]) and other contaminations in films grown by physical methods, which may yield higher carrier concentration in physical deposited thin films. For instance, carrier concentration of 10^{16} - 10^{17} cm^{-3} in Cu$_2$O has been attained by magnetron sputtering with annealing treatment in the 200 - 300 $^{\circ}$C temperature range [27]. In contrast, electrodeposition only produces carrier concentration of 10^{13} - 10^{14} cm^{-3} with the same kind of annealing treatment [57]. In addition, it is a hard task to synthesize pure phase Cu$_4$O$_3$ by electrodeposition, as it is difficult to stabilize Cu^{2+} and Cu^{+} ions simultaneously via conventional aqueous chemistry.

Chemical deposition processes, such as CVD and ALD, are also commonly used to grow Cu$_2$O and CuO thin films with large area, which requires special precursors. But these precursors may introduce some contaminations [58], [59]. Besides, the synthesis of pure phase Cu$_4$O$_3$ by chemical deposition is rarely reported.

High temperature is generally required to synthesize pure phase Cu_2O by PLD [60], which will block its wide applications. This high substrate temperature, together with the compound target (like Cu_2O and CuO), will inhibit the growth of Cu_4O_3 by PLD.

Among the various thin film deposition technologies, reactive magnetron sputtering is a good choice to grow binary copper oxides. It allows the selective deposition of the three copper oxides, including Cu_4O_3 [23], [22], and it is also a very versatile technique for large area deposition technique at low cost. It is worth pointing out that the non-equilibrium process is required to grow single phase Cu_4O_3 thin films.

1.4 Recent progress of copper oxides based solar cells

1.4.1 Advantages of copper oxides

As the element abundance, non-toxicity, and easy fabrication, copper oxide based solar cells are a promising class of photovoltaic (PV) devices with the characteristics of being ¨ultra-low-cost¨ and of compatibility with terawatts-scale (TW) deployment. In 2009, Wadia et al. have examined materials extraction costs and supply constraints for 23 promising semiconductors, and copper oxides (Cu_2O and CuO) are good candidates to meet the annual worldwide electricity consumption of 17 000 TWh and much more lower cost than crystalline silicon [61], as shown in Fig. 1.14. To be pointed out here, Schockley-Queisser limits of Cu_2O and CuO with sole consideration of band gaps are used to calculate these indexed results [62], whereas other complicated physical properties (like optical absorption spectra and radiative/nonradiative recombination processes) with strong influence on PV performance are not taken into account, which gives rise to an overestimated index of CuO. In fact, the poor electrical properties of CuO make the performance of present CuO based PV devices not as good as Cu_2O. Hence, here we just discuss the Cu_2O-based heterojunction solar cells.
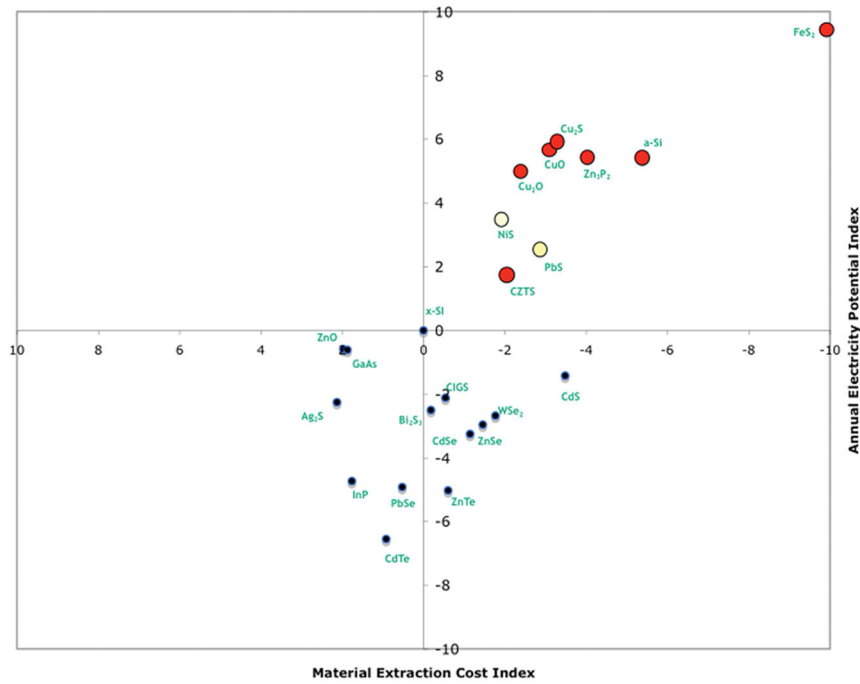
Fig. 1.14 Indexed results of 23 PV materials. The extraction costs, supply constraints and theoretical power conversion efficiency limit have been considered. All index values are divided by the calculated result of x-Si. The most attractive materials for large-scale future deployment are highlighted red and are in the upper right-hand quadrant [61].

1.4.2 Poor performance of Cu$_2$O-based solar cells

In the past ten years, Cu$_2$O-based solar cells have experienced a great improvement [7], [63]–[72] , as shown in Fig. 1.15(a). The conversion efficiency rises up from 1.21% in 2004 to 6.1% in 2015. The schematic structure of these solar cells is depicted in Fig. 15(b), where n-type transparent semiconductors (such as ZnO, Zn$_{1-x}$Mg$_x$O and Ga$_2$O$_3$) are usually used as the window layer. However, the maximum experimental efficiency of 6.1% remains to be far from its theoretical efficiency, and too poor to put into industry production. The origin of this weak efficiency is still unclear, and several relevant issues are thought to be the possible sources:

(a). Optical absorption of Cu$_2$O

20% efficiency limit was roughly predicted by Schockley-Queisser theory [62], which only considers the direct band gap of 2.17 eV measured at quite low temperature. In fact, Cu$_2$O is a dipole-forbidden direct band semiconductor, with an allowed transition optical band gap of

2.38-2.51 eV at room temperature [27]. The energy gap (Δ) between minimal band gap (E_g) and transition allowed band gap (E_g^a) will increase the non-radiative recombination losses, which plays negative roles in solar cells [73].

(b). Electrical properties of Cu_2O

In order to get the large carrier transport lengths in the absorber, high mobility and low density of defect are required to keep the high diffusion constants and large recombination lifetime. In addition, low resistivity is also required to reduce the series resistance and the contact resistance on the metal electrode. However, high density of defect is usually beneficial to the high carrier concentration and low resistivity. Consequently, mobility and carrier concentration compromise with each other in optimized conditions. Comparing most of the publications in Cu_2O-based heterojunction solar cells, it is found that Cu_2O prepared by thermal oxidizing at high temperature has higher efficiency (η) than other methods, which may result from the high mobility from this high temperature oxidizing. More recently, the 6.1% efficiency was achieved by the incorporation of sodium into the Cu_2O sheets, which maintains the high mobility and high carrier concentration simultaneously [7], [70].

(c). Conduction band offset between Cu_2O and n-type layer

It is of great value that any potential ¨spike¨-type in the conduction band at the heterojunction should be minimized for optimal minority carrier transport. Since the electron affinity of Cu_2O is as low as 3.2 eV, it is difficult to find a matched n-type partner exhibited so low electron affinity. Brandt et al have surveyed band offset between Cu_2O and a broad range of n-type materials, as shown in Fig. 1.16, which provide fruitful information [74]. The conduction band offset between Cu_2O and ZnO is as high as -1.34 eV, which could be the reason for its low open-circuit voltage. In contrast, a low offset of 0.38 eV was observed between Cu_2O and Ga_2O_3, which can explain its high performance to date. Besides, other n-type materials, such as ternary alloys $Zn(O,S)$ are thought to be potential candidates [74].
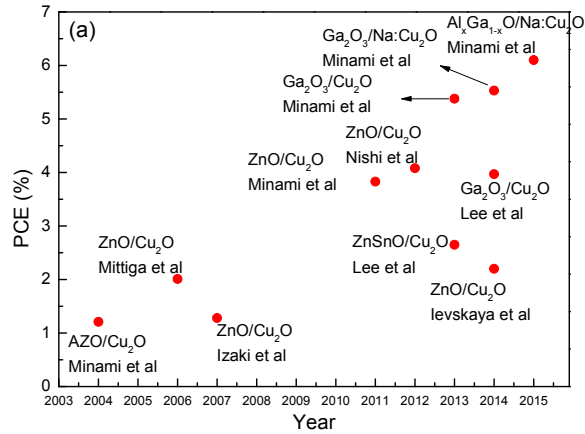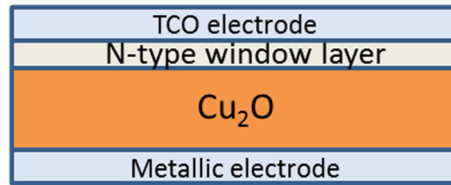
Fig. 1.15   (a) Development of Cu$_2$O-based solar cells in the past ten years. (b) A schematic structure of Cu$_2$O-based heterojunction solar cells.
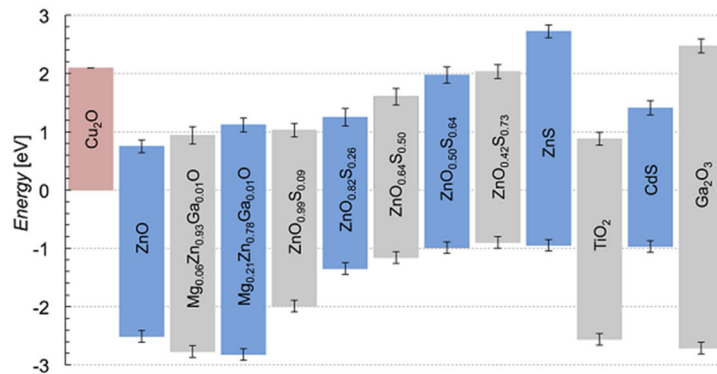
Fig. 1.16   Band energies (in flat-band conditions) of n-type materials with respect to Cu$_2$O and their respective error bars. All energies are referenced to the valence band of Cu$_2$O [74].

Since Cu$_2$O is prone to be oxidized into CuO at the top surface in non-vacuum atmosphere, this is detrimental to device performance. CuO will create new interfacial states and then enhance the recombination, or increase the conduction band-offset. Thus, it is of value to avoid or remove this CuO thin layer during the fabrication process [59], [75]. For instance, Lee et al. employ special Zn precursor (diethylzinc) for the starting sequence of n-type

amorphous zinc-tin-oxide window layer to reduce the CuO surface layer to Cu_2O by forming ZnO, yielding the efficiency of 2.85% [59]. In some extremal conditions, Cu_2O will be decomposed into Cu, which also should be averted.

1.5   Chapter conclusions

In this chapter, a general review of binary copper oxides focusing on their structural, electronic structure, optical and electrical properties, as well as the recent developments of copper oxide based solar cells has been presented. Basic needs include systematical investigations on controllable growth and characterization of Cu_2O, Cu_4O_3 and CuO thin films. There is a clear demand to understand the unusual properties, such as lower resistivity in biphase thin films, from the viewpoint of microstructure. Moreover, a joint experimental and theoretical study is required to understand their optical properties, valence and conduction band structures. Experimental optical absorption can be used to study the optical properties, while photoemission and electron energy loss spectroscopies are required to determine the band structure. Combining these experimental results with theoretical calculations, may yield a better understanding on their electronic structures, which may also provide a way to evaluate the calculation methods.

Chapter 2   Experimental and calculational details

2.1   Introduction

In this thesis, reactive magnetron sputtering has been used to synthesize the copper oxide and nickel oxide thin films. X-ray diffraction, Raman spectrometry, scanning electron microscopy (SEM) and transmission electron microscopy (TEM) have been employed to study the structure and the microstructure of the films. The electrical properties have been studied using the four point probe method and the Hall effect measurements. The electronic structures have been investigated by X-ray photoemission spectroscopy (XPS), ultraviolet photoemission spectroscopy (UPS) and electron energy loss spectroscopy (EELS). In addition, many-body perturbation theory in the *GW* approximation has been used to calculate the electronic structures and optical properties. In this chapter, an introduction of some of these experimental and theoretical methods will be presented.

2.2   Thin film growth

Reactive magnetron sputtering is one of the many so-called PVD techniques. In this process, target material is sputtered in the presence of a gas mixture such as argon-oxygen to deposit an oxide. The main role of argon is to sputter the metallic target while oxygen atoms react at the film surface with the metallic atoms to form the oxide. Then, the composition of the film is strongly influenced by the amount of reactive gas introduced into the deposition chamber. Nowadays reactive magnetron sputtering is a widely used for industrial coating deposition as well as for scientific research.

Fig. 2.1 shows the schematic view of the reactive sputtering chamber. The thin film growth process can be described like this:

- cleaning the substrates by ethanol;
- installing the substrates on the holder and switching on the pumping to the base vacuum (approx. 10^{-3} - 10^{-4} Pa);

- introducing Ar to etch the substrate surface using a radiofrequency plasma

- introducing oxygen and switching on the pulsed-DC plasma on the target and switching off the etching plasma.
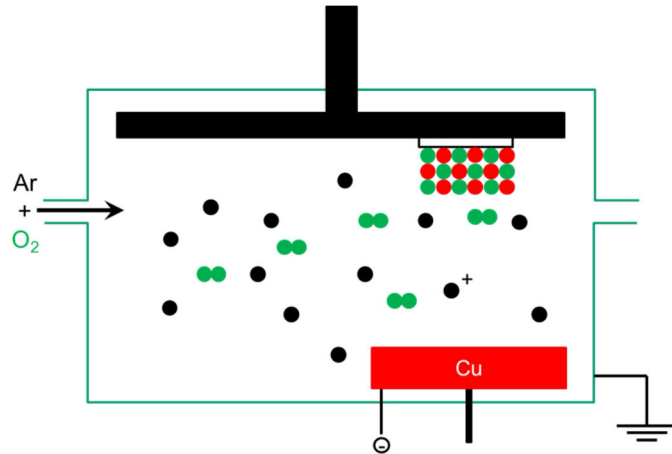
Fig. 2.1   Schematic drawing of reactive sputtering chamber. The black, red and green circles represent Ar, Cu and O, respectively.

All the copper oxide thin films in this thesis were deposited on glass (microscopy slides) and (100) silicon substrates by magnetron sputtering in various Ar-O$_2$ reactive mixtures. During the deposition, no intentional heating was applied to the substrates, and the deposition temperature was close to room temperature. The argon flow rate was fixed at 25 standard cubic centimeter per minute (sccm), while the oxygen flow rate varied in the 7-30 sccm range. Thin films were deposited at different total sputtering pressure (0.5, 1 and 2 Pa) by changing the pumping speed via a throttle valve. A pulsed-DC supply (Pinnacle+ Advanced Energy) was used to sputter the copper target (50 mm diameter and 3 mm thick with a purity of 99.99 %, Ampere Industry). The current applied to target was fixed to 0.3 A, the frequency and the off-time were 50 kHz and 4 μs, respectively. The distance between the substrate and the target was fixed at 60 mm. To be pointed out here, the target voltage and the oxygen partial pressure as a function of the oxygen flow rate have been recorded, in order to find the critical oxygen flow rate to synthesize the oxide thin films. However, the hysteresis effect is not observed neither in the target voltage nor in the oxygen partial pressure, making a difficulty to determine the elemental sputtering mode (ESM) and the reactive sputtering mode

(RSM). Such a behavior may be due to the low gettering effect of copper atoms, to the low wall area of our sputtering chamber and to the high pumping speed [76]–[78]. The thickness of copper oxide thin films deposited during 10 minutes is shown in Fig. 2.2. Taking the 0.5 Pa total sputtering pressure as an example, when the oxygen flow rate is between 12 and 20 sccm, the growth rate is quite close. The thickness decreases when the oxygen flow rate exceeds 20 sccm. Since the increase of the total pressure reduces the mean free path of sputtered copper atoms, a smaller amount of copper atoms attends the substrate surface and the film thickness is lower than that measured at 0.5 Pa. Meanwhile, a smaller amount of oxygen is required to oxidize the copper atoms when the total pressure is fixed at 1 Pa.
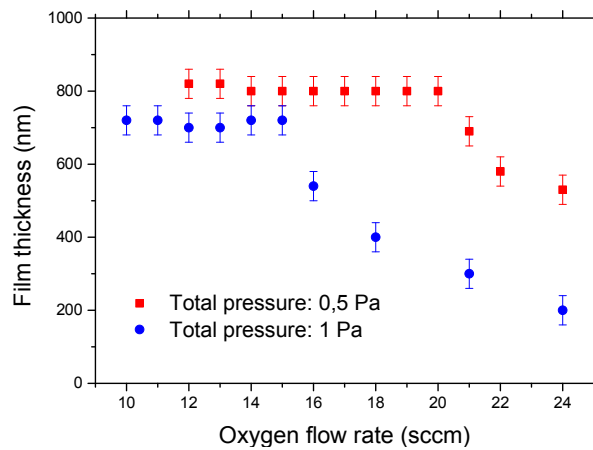
Fig. 2.2   Evolution of the copper oxide thin film thickness as a function of the oxygen flow rate using two values of total pressures. Whatever the oxygen flow rate or the total pressure, the deposition duration was 10 minutes.

Nickel oxide thin films have been also deposited using the same sputtering chamber. The deposition procedure for NiO films is similar to that used for copper oxide ones. For NiO thin film deposition, no intentional heating was applied to the substrate holder. The argon flow rate was fixed at 25 sccm, while the oxygen flow rate varied in the 4-11 sccm range, with the total pressure of about 0.5 Pa. A pulsed-DC supply (Pinnacle+ Advanced Energy) was connected to the metallic nickel target (2 in. diameter and 1 mm thick with a purity of 99.995%). The current applied to the target, the frequency and the off-time were fixed to 0.3 A, 50 kHz and 4 µs, respectively. The distance between the substrate and the target was fixed at 75 mm. The

voltage in the target and the oxygen partial pressure as a function of oxygen flow rate are shown in Fig. 2.3. The hysteresis effect is clear in oxygen partial pressure, but the behavior of voltage in the target is not usual. Since the voltage in the target is much more complicated and can be easily affected by other processes, the hysteresis effect in oxygen partial pressure is reliable and could be an indicator for the critical oxygen flow rate. The thickness of thin films deposited in a 6 minutes run is shown in Fig. 2.4. Compared to the Cu-O system, the Ni-O one only contains one defined compound: NiO. Then, the progressive decrease of the film thickness as a function of the oxygen flow rate is not due to a change of the film composition. This decrease mainly results from the increase of the oxygen ratio in the gas mixture, i.e. a decrease of the argon ratio. Since less argon ions attend the target surface, the amount of sputtered nickel atoms decreases.
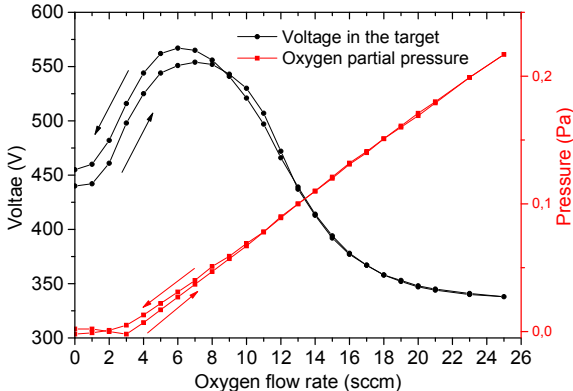
Fig. 2.3   Evolution of the nickel target voltage (in black) and the oxygen partial pressure (in red) as a function of the oxygen flow rate.
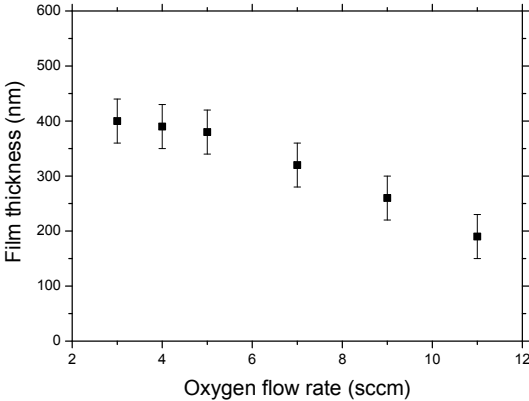
Fig. 2.4   Effect of the oxygen flow rate on the thickness of nickel oxide films. The deposition duration was 6 minutes.

2.3 Thin film characterization

2.3.1 X-ray diffraction

X-ray diffraction (XRD) relies on the dual wave/particle nature of X-rays to obtain the information of crystalline materials, including crystallographic structure, orientation, strain state, and so on. When an incident X-ray beam interacts with a material, the dominant effect is scattering of X-rays from atoms constituting the material. In crystalline materials, the scattered X-rays undergo constructive and destructive interference. This method of X-ray diffraction can be described by Bragg's law, as shown in Fig. 2.5. A set of crystallographic lattice planes with distances d_{hkl} is irradiated by plane wave x-rays impinging on the lattice planes at an angle θ. The relative phase shift of the wave depends on the configuration of atoms as is seen for the two darker atoms in the top plane and one plane beneath. The phase shift comprises of two shares, Δ_1 and Δ_2, the sum of which equals $2d\sin\theta$ for any arbitrary angle θ. Constructive interference for the reflected wave, however, can only be achieved when the phase shift is a multiple of the wavelength [79].

$$\Delta_1 + \Delta_2 = 2d\cos(90° - \theta) = 2d\sin\theta$$
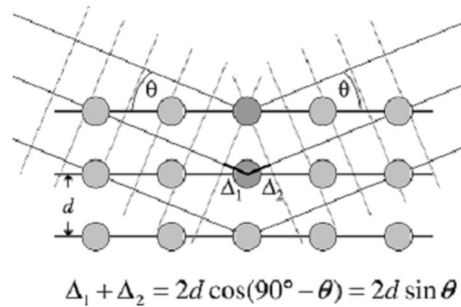
Fig. 2.5 Visualization of the Bragg equation. Maximum scattered intensity is only observed when the phase shifts add to amultiple of the incident wavelength [79].

In this thesis, the structure and growth orientation of thin films were checked by XRD (Brucker D8 Advance with $CuK_{\alpha1}$ radiation (λ = 0.15406 nm)) in Bragg Brentano configuration. The determination of the structure was performed using the JCPDS data and the EVA software provided by Brucker. Pole figures were obtained using a Brucker D8 Discover diffractometer (Co K_α radiation, λ = 0.17912 nm).

2.3.2 Raman spectrometry

Raman spectrometry is commonly used in materials science, since vibrational information is specific to the chemical bonds and crystallographic symmetry. Therefore, it provides a fingerprint by which the material can be identified. The Raman scattered light occurs at wavelengths that are shifted from the incident light by the energies of molecular vibrations. The mechanism of Raman scattering is different from that of infrared absorption, and Raman and IR spectra provide complementary information [80].

Here, micro-Raman spectrometry (Horiba LabRAM HR using a 532 nm laser) was employed to identify the phase structure at room temperature. It is worth noting that extreme care should be paid to the energy density of laser beam to attain the correct spectra of Cu_2O and Cu_4O_3, as these two phases are prone to oxidize into CuO in air at low temperature (< 300 ^oC). Taking Cu_4O_3 as an example, the Raman spectrum recorded at low power density of laser beam demonstrates the pure phase Cu_4O_3, whereas CuO phase is identified using high power density, as shown in Fig. 2.6.
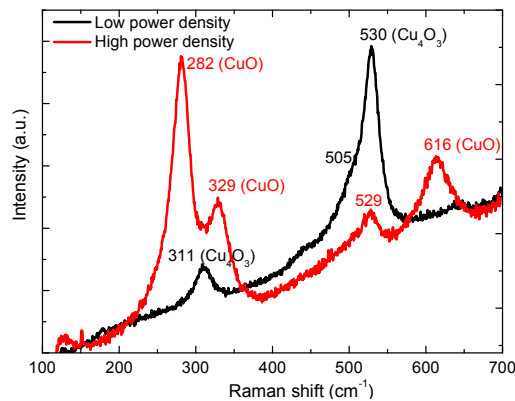
Fig. 2.6   Raman spectra of Cu_4O_3 thin film recorded at high (in red) and low (in black) power density of laser beam. The power density is controlled by the filter.

2.3.3 Hall effect measurements

An electrical current along the x (longitudinal) direction in the presence of a perpendicular magnetic field $\mathbf{B} = (0, 0, B)$ along z induces an electric field E_y along the transverse (y) direction. The schematic geometry is shown in Fig. 2. 7, where the charge accumulation is

due to the Lorentz force. The related transverse voltage is called the Hall voltage (V_H), which can be described as

$$V_H = -\frac{IB}{nte} \qquad (2\text{-}1)$$

where I is the current across the plate length, B is the magnetic field, t is the thickness of the plate, e is the elementary charge, and n is the charge carrier density of the carrier electrons [81]. The Hall effect measurements can determine accurately conductive type (p or n type), carrier density, electrical resistivity, and the mobility of carriers in semiconductors.
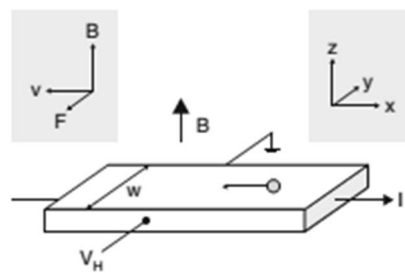
Fig. 2.7 Scheme of the Hall-effect geometry [81].

In this thesis, the electrical properties were measured using a Hall measurement system in the van der Pauw geometry (Ecopia, HMS-5000) with a DC magnetic field of 0.57 T. To be pointed out, since we grow thin films at room temperature, the carrier concentration and mobility of as-deposited Cu_2O thin films cannot be measured correctly as the mobility is out of our detecting limit. After air annealing, this could be solved. However, in the cases of Cu_4O_3 and CuO thin films, the mobility is still too low to determine correctly even with air annealing thermal treatments. Then Seebeck coefficient measurement is employed to identify the conductive type in Cu_4O_3 and CuO thin films.

2.3.4   Transmission electron microscopy

TEM is a microscopy technique in which a beam of electrons is transmitted through an ultra-thin specimen, interacting with the specimen as it passes through. Then an image is formed from the interaction of the electrons transmitted through the specimen. TEM has revolutionized   our   understanding   of   materials   by   completing   the processing-structure-properties links down to atomistic levels. It is now possible to tailor the

microstructure of materials to achieve specific sets of properties; the extraordinary abilities of modern TEM to provide almost all the structural, microstructural, and chemical information [82].

In this thesis, TEM investigation for the microstructure was performed by a state-of -the-art JEOL ARM 200-Cold FEG (point resolution 0.19 nm) fitted with a GIF Quantum ER, as shown in Fig. 2. 8. 200 kV accelerating voltage and 15 µA emission current are used. For this investigation, the cross-section TEM samples of films deposited on silicon substrates were prepared in Sarrebrücken (Germany) using a focused ion beam (FIB)-scanning electron microscope (SEM) dual beam system (FEI Helios 600) using the 'in situ' lift-out technique. Final thinning was done with low voltage milling (5 kV or 2 kV) to reduce any possible preparation artefacts.

Fig. 2.8   JEOL ARM 200 microscopy.

2.3.5　Electron energy loss spectroscopy

EELS is a useful technique in which materials are studied through the inelastic collisions with a beam of electrons, which will tell us a tremendous amount about the chemistry and the electronic structure of the sample. This method brings relevant details about the bonding/valence state, the nearest-neighbour atomic structure, the dielectric response, the free electron density, the band gap, and the specimen thickness [82].

When an electron beam transfers sufficient energy to a core-shell electron (i.e., one in the inner, more tightly bound K, L, M, etc., shells) to move it outside the attractive field of the nucleus, the atom is said to be ionized. We call the ionization-loss signal in the EELS

spectrum an 'edge,' rather than a peak. The K shell electron is in the 1 s state and gives rise to a single K edge. In the L shell, the electrons are in either $2s$ or $2p$ orbitals. If a $2s$ electron is ejected, we get an L_1 edge, and $2p^{1/2}$ or $2p^{3/2}$ electrons causes L_2 or L_3 edges, respectively. The variation in intensity, extending several tens of eV above the ionization edge onset (E_c), is the energy loss near edge structure (ELNES), also called as fine structure, which effectively mirrors the unfilled DOS above Fermi level, as shown in Fig. 2.9. White lines are the most important part in ELNES, which are intense sharp peaks on certain ionization edges. These sharp peaks arise because in certain elements the core electrons are excited into well-defined empty states, not a broad continuum. Due to the dipole-selection rule, in the case of the p state, the only permitted final states are either a s state or a d state. Consequently, the core electrons are ejected primarily into the unoccupied d states in the conduction band, since there are few available s states. Thus, $L_{2,3}$ white lines means the existence d shell with unfilled states [82].
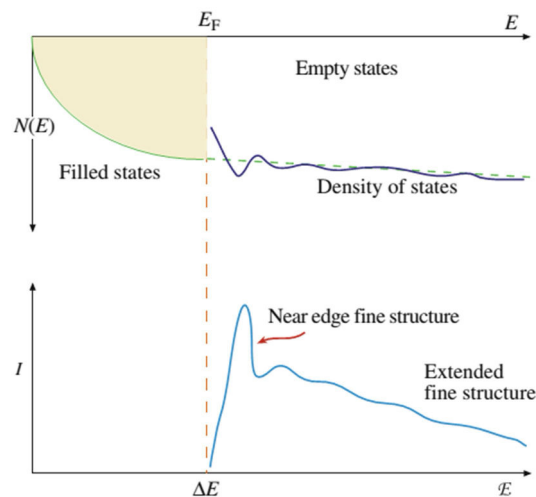
Fig. 2.9 Relationship between the empty DOS and the ELNES intensity in the ionization edge fine structure [82].

For the ELNES spectra measurements here, the accelerating voltage of 200 kV, the emission current of 5 uA and the energy dispersion of 0.05 eV/ch were used. All the spectra were acquired in the diffraction mode, with the energy resolution of 0.45~0.5 eV defined by the full width at half maximum (FWHM) of the zero loss peak (ZLP). The convergence semi-angle α and the collection semi-angle β were 7 and 18 mrad, respectively. Here the suitable acquisition time and number of frame should be chosen to record the correct ELNES

spectra of Cu_2O thin films, as long time irradiation from the electron beam has a tendency to oxidize Cu_2O into CuO, even in the vacuum (10^{-5} Pa) atmosphere.

Low acceleration voltage (80 kV) and low emission current (2 uA) are employed to avoid the relativistic effect, especially the Cerenkov radiation, and to get a FWHM of ZLP with the value of 0.3~0.35 eV in the valence EELS (VEELS) measurements.

2.3.6   Photoemission spectroscopy

Photoemission spectroscopy is based on the principle of photoelectric effect: photons from a light source are absorbed by the sample surface and induce the emission of electrons. There are two types of photoemission spectroscopy, categorized by light source: XPS (X-ray to examine core levels) and UPS (UV radiation to study the valence band)

XPS spectra are obtained by irradiating a material with a X-ray beam and simultaneously measuring the kinetic energy and number of electrons that escape from the top layer of a few nanometers of the material surfaces. XPS detects all elements with an atomic number (Z) of 3 (lithium) and above. XPS has similar function with EELS in chemical analysis, such as valence state, composition determination. But significant differences exist in the thickness analysed and the so-called chemical shift. XPS is surface sensitive with a penetration depth of a few nanometers, while electron beam passes through the sample with the thickness up to 150 nm (depending on the acceleration voltage) in EELS spectrometer equipped in a TEM. In XPS, the kinetic energies of photoelectrons that escape into the surrounding vacuum are measured by an electron spectrometer. So, the final state of the electron transition lies in a continuum far above the vacuum level and is practically independent of the specimen. In the case of a compound, any increase in binding energy of a core level, relative to its value in the pure (solid) element, is called a chemical shift. The ionization-edge threshold energies observed in EELS represent a difference in energy between the core-level initial state and the lowest energy final state of the excited electron. The corresponding chemical shifts in threshold energy are more complicated than in XPS because the lowest energy final state lies below the vacuum level and its energy depends on the valence-electron configuration [83].

UPS is analogous to XPS but the excitation source is a helium discharge source. The photon energy can be optimized for He I = 21.2 eV or He II = 44.8 eV which is significantly lower energy than Al (1486.7 eV) or Mg Kα (1253.6 eV) used in XPS. As with XPS the binding energy (E_{BE}) is related to the measured photoelectron kinetic energy (E_K) by the simple Einstein's photoelectric law. This kind of lower photon energy will result in that only the low binding energy valence electrons may be excited by the He source. A further consequence of the low photon energy is UPS is more surface sensitive than XPS and thus very sensitive to surface contamination.

All the XPS/UPS spectra were measured in a UHV chamber. The Ar^+ ion etching was performed again and again to clean the surface, until there is no evolution in the C-1s XPS spectra. The XPS source was a monochromatic Al Kα line, while the ultraviolet photon source was He I. The silver paste was put in a corner of the sample, contacting with the metallic holder. The purpose of this is to relieve the charge effect during the measurement and to identify the Fermi level by using silver as a reference.

2.4 Theoretical calculation method

Many-body perturbation theory in the *GW* approximation has emerged as a standard computational tool for the band structure prediction of semiconductors and insulators, providing a systematic improvement of band structures calculated in the local-density or generalized gradient approximations (LDA or GGA) to density functional theory (DFT). The past decade has seen considerable developments in *GW* method with different schemes. However, there is presently no single universally accepted scheme for *GW* calculations, which can fairly describe both band gaps and band structures of semiconductors, especially the transition metal oxides. In this work, a *GW* scheme with the consideration of local-field effect and an empirical on-site potential for transition metal *d* orbitals with a single parameter per transition metal cation (noted as $GW^{LF} + V_d$), has been used, which allows for reasonably predictive band gaps for different oxide stoichiometries and TM oxidation states at an acceptable computational expense [24].

The calculations are performed within the projector augmented wave (PAW) implementation of the VASP code (version 5.2). With the goal of a feasible scheme for high-throughput band-structure prediction in mind, computationally expedient PAW data sets were chosen for the present study: For oxygen, a "soft" potential was used, allowing for a relative small energy cutoff for the wave functions of 320 eV. All the calculations in this manuscript are done by Dr Stephane Lany from National Renewable Energy Laboratory in USA.

2.5   Chapter conclusions

In this chapter, the experimental and calculational details, including the thin film deposition parameters, thin film characterization methods, theoretical calculation approach and some important technical issues concerning on the characterizations have been presented. These different methods will be used in the next chapters to reveal the properties of copper oxide thin films.

Chapter 3   Tuning the structure and preferred orientation in reactively sputtered copper oxide thin films

3.1   Introduction

For scientific research or technological applications, it is of great interest to fabricate binary copper oxide thin films with high quality. Up to now, most of the usual deposition methods have been used to grow Cu_2O and CuO thin films, including magnetron sputtering [29], [31], molecular beam epitaxy [84], pulsed laser deposition [60], and electrochemical deposition [57]. Since it is difficult to stabilize Cu^{2+} and Cu^+ ions simultaneously via conventional aqueous chemistry, it is hard to synthesize pure Cu_4O_3 by electrochemical deposition and sol-gel methods. The synthesis of pure Cu_2O phase by pulsed laser deposition or molecular beam epitaxy usually requires high temperature that limits its wide applications [60], [84]. Among the various thin film deposition technologies, reactive magnetron sputtering is a good choice to grow binary copper oxides, as it allows the selective deposition of the three copper oxides, including Cu_4O_3 [29], [31] . This process is also a highly versatile technique for large area deposition at low cost.

The crystal growth orientation of thin films has great impact on the microstructure and properties of films. Thus, it is interesting to grow copper oxide thin films with tunable preferred orientation. Several parameters may be used to control the film growth in magnetron sputtering processes such as oxygen partial pressure, total pressure, substrate orientation, substrate temperature, and the use of a buffer or seed layer [21], [85]–[87]. Although lattice-matched substrates and high substrate temperature have typically been employed to tune the growth orientation, the harsh conditions are undesirable for large scale applications at low cost. Hence, controlling the growth orientation at room temperature using conventional substrates with random orientation will extend the application range of copper oxide thin films.

In this chapter, we have investigated the selective growth of the three copper oxide thin

films by reactive magnetron sputtering on glass and silicon substrates at room temperature. The influence of the oxygen flow rate and total pressure on the phase structure, growth orientation, morphology and microstructure of thin films have been studied. In addition, the concept of local epitaxial growth (LEG) to control the orientations of thin films in reactive magnetron sputtering has been investigated.

3.2 Structure of copper oxide thin films

3.2.1 Effect of the oxygen flow rate

Fig. 3.1 shows the X-ray diffractograms of copper oxide thin films grown on glass substrate at 0.5 Pa total pressure with different oxygen flow rates (12, 16, 19, 21, and 22 sccm). Depending on the oxygen flow rate, the width of the diffraction peak is high, indicating the deposition of oxides with grain size at the nanometer scale. Furthermore, the thin films may be stressed and the position of the diffraction peaks may be affected by this stress. Finally, since the three copper oxide phases present diffraction peaks close to 36°, the assignment of the diffraction peak as a function of the oxygen flow rate is a hard task. The (111) diffraction peak of Cu_2O is located at 36.428° [JCPDS 04-007-9767], while (202) and (004) diffraction peaks of Cu_4O_3 are at 35.787° and 36.342°, respectively [JCPDS 04-007-2184]. Moreover, (002) and ($\bar{1}11$) diffraction peaks of CuO are located at 35.468° and 35.559° [JCPDS 04-007-1375]. However, the increase of the oxygen flow rate in the deposition chamber should induce an increase of the oxygen concentration of the deposited films, which may be a helpful indication to assign the X-ray diffractogram.

For an oxygen flow rate fixed at 12 sccm, the intense peak close to 42.3° has been assigned to the (200) diffraction peak of cuprite. This sample also exhibits a weak diffraction peak close to 36.3° that may be assigned either to the (111) diffraction peak of Cu_2O or to the (004) of Cu_4O_3. For the oxygen flow rate fixed at 16 sccm, the intensity of this peak strongly increases while that observed at 42.3° is still intense. If the oxygen flow rate is increased to 19 sccm, new diffraction peaks located at approx. 18, 31 and 61.4° are detected. These peaks have been assigned to the paramelaconite (Cu_4O_3). For the thin film grown at the oxygen flow

rate of 21 sccm, the X-ray diffractogram shows an X-ray amorphous material (see Fig. 3.1(b)). Hence, it seems that the use of XRD as the only characterization method is not relevant to clearly distinguish the phase structures in these binary copper oxide polycrystal thin films.

Fig. 3.1 (a) X-ray diffractograms of copper oxide thin films deposited at 0.5 Pa total pressure with 12, 16, 19, 21, and 22 sccm oxygen flow rate. (b) Magnified diffractogram of thin film deposited with 21 sccm O_2.

Since Cu_2O, Cu_4O_3 and CuO have different Raman active vibrational modes [19], Raman spectrometry is a good complementary method to determine the film phase structure. Fig. 3.2 shows the Raman spectra of the copper oxide thin films previously characterized by XRD in Fig. 3.1. For films deposited at 19 sccm of oxygen, the E_g (311 and 505 cm^{-1}) and A_{1g} (531 cm^{-1}) Raman bands of Cu_4O_3 are clearly evidenced. This result is in agreement with that from XRD, indicating the use of 19 sccm in our deposition conditions leads to the synthesis of pure paramelaconite thin films. These two Raman bands are also evidenced for the films deposited at 16 sccm oxygen, accompanied by some new bands at approx. 93, 147 and 216 cm^{-1} that have been ascribed to special modes in Cu_2O [20], [88]. This demonstrates the deposition of a mixture of Cu_2O and Cu_4O_3. Since the Raman bands of paramelaconite are not detected in the film deposited at 12 sccm anymore, this sample only contains the Cu_2O phase and the weak diffraction peak close to 36.3° is related to the Cu_2O (111) diffraction peak (Fig. 3.1(a)). Moreover, when the oxygen flow rate is increased to 21 sccm, Raman analysis shows besides the A_{1g} band of Cu_4O_3, the existence of a new band close to 288 cm^{-1} that corresponds to the CuO phase. Hence, this indicates the 21 sccm oxygen flow rate results in the deposition of an

X-ray amorphous mixture of Cu_4O_3 and CuO. Finally, when the oxygen flow rate is fixed at 22 sccm, the Raman bands of Cu_4O_3 disappear and only those of CuO are evidenced. In summary, increasing the oxygen flow rate induces the progressive oxidation of the sputtered copper atoms. Combining XRD and Raman analyses, it has been shown that pure Cu_2O, Cu_4O_3 or CuO can be deposited. Between these single phase domains, biphase materials can be synthesized (Cu_2O + Cu_4O_3 or Cu_4O_3 + CuO). These results are in agreement with those previously published by Meyer et al. although their Raman spectrum of Cu_4O_3 is questionable [8].
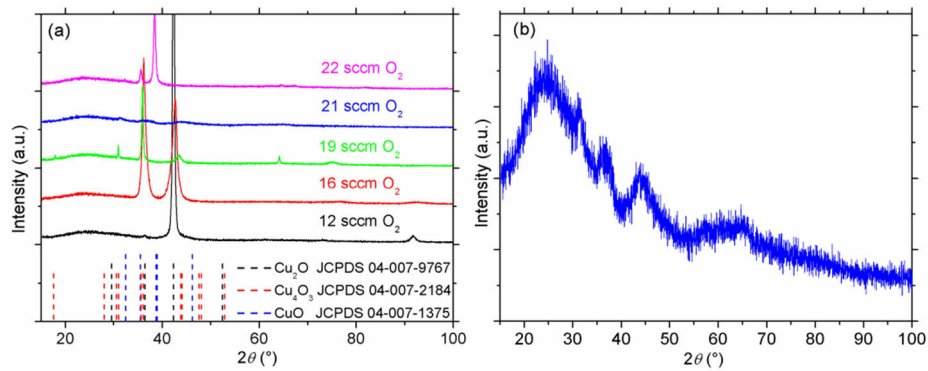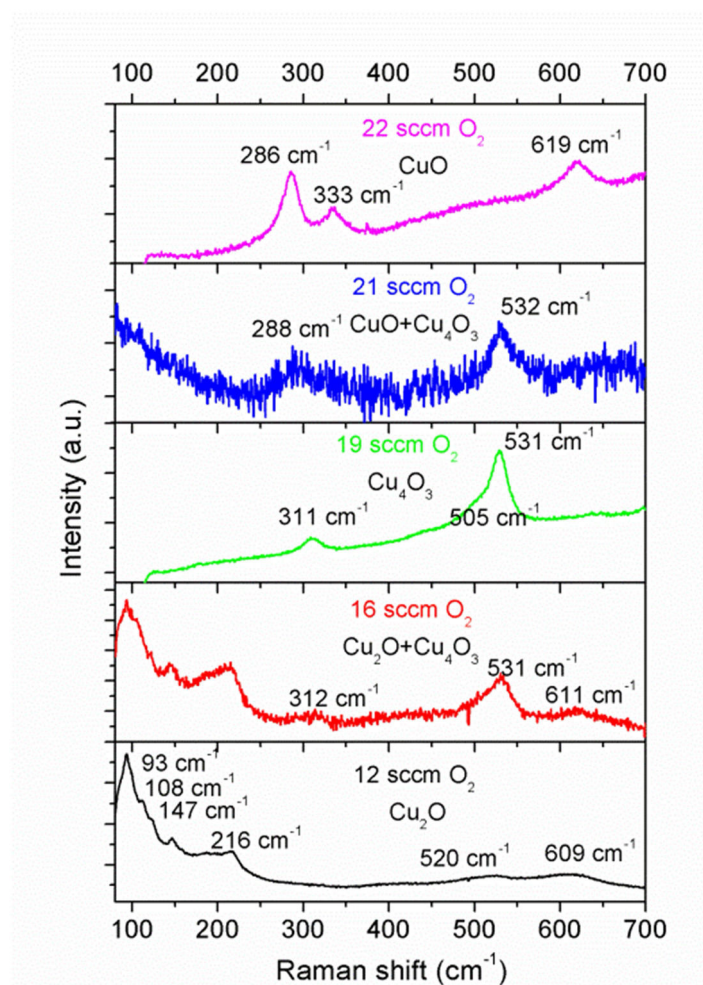

Fig. 3.2 Raman spectra of copper oxide thin films deposited at 0.5 Pa total pressure with 12, 16, 19, 21 and 22 sccm oxygen flow rate.

3.2.2 Effect of the total pressure

The combination of XRD and Raman analyses has also been used to determine the phases present in films deposited at higher pressure of 1 and 2 Pa as a function of the oxygen flow

rate by a step of 1 sccm. Fig. 3.3 shows the schematic deposition diagram of binary copper oxide thin films, which roughly describes the phase structure as the function of oxygen flow rate and total pressure. As detailed in Fig. 3.1 and 3.2, the increase of the oxygen flow rate at a given total pressure induces the evolution from single phase Cu_2O, biphase Cu_2O and Cu_4O_3, single phase Cu_4O_3, biphase Cu_4O_3 and CuO, and finally single phase CuO. It is observed that the O_2 flow rate process windows to synthesize single phase Cu_2O and Cu_4O_3 are narrow (about 2 or 3 sccm). In contrast, the process window for single phase CuO is wider. As seen in Fig. 3.3, with the increase of total pressure, the oxygen flow rate window for single phase deposition has a tendency to become narrower. Additionally, the single phase deposition domains are shifted to lower oxygen flow rate value, which can be understood considering that the increase of the total pressure reduces the mean free path of sputtered copper atoms and lowers the film deposition rate. Consequently less oxygen is required to get the expected phase. The change of the total pressure induces an increase of the oxygen partial pressure that may affect the structure of the deposited films. Then, the previous deposition diagram has been also plotted using the oxygen partial pressure instead of the total pressure (not shown here) but this diagram does not give relevant information to explain the evolution of the film structure as a function of the oxygen flow rate at various total pressures. At 0.5 Pa total pressure, the oxygen partial pressure required to deposit pure paramelaconite is about 0.16-0.17 Pa while that required to deposit Cu_4O_3 at 2 Pa is about 0.37 Pa.

Finally, it should be pointed out that some films deposited at 2 Pa exhibit cracks at the top surface resulting from tensile stress and their electrical resistivity is extremely high. This means that high total pressure is not suitable for depositing binary copper oxide thin films of good physical quality. Since the films deposited at 2 Pa show poor functional properties, this deposition conditions will not further be considered in this thesis.
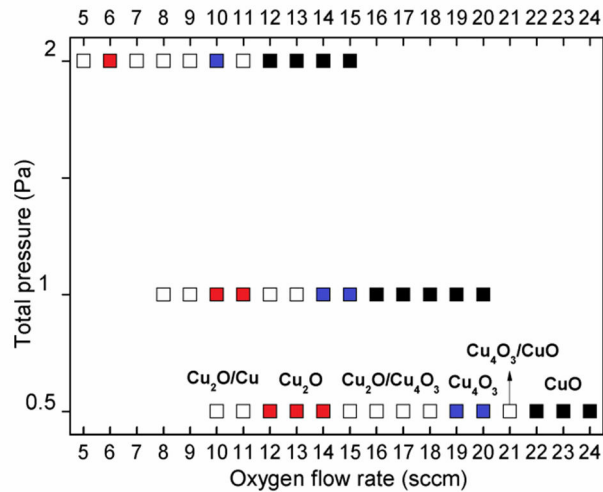
Fig. 3.3   Deposition diagram of binary copper oxide thin films as a function of oxygen flow rate and total pressure.

3.3   Tuning the preferred orientation in copper oxide thin films

3.3.1   Effect of the substrate nature

The influence of the substrate nature ((100) silicon and glass) on the growth orientation of thin films has been studied. Fig. 3.4 shows the X-ray diffractograms of Cu_2O thin films on glass and silicon substrates deposited at the same time. It clearly appears that the substrates have no effect on the growth orientation and phase structure of thin films. The same situation exists in Cu_4O_3 and CuO thin films.
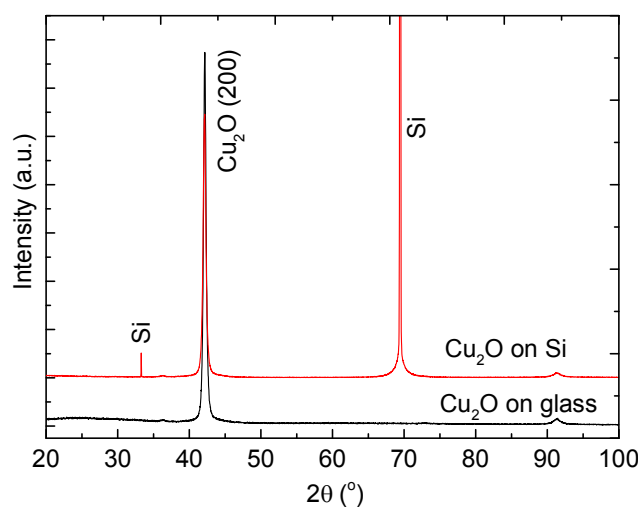
Fig. 3.4   X-ray diffractograms of Cu_2O film grown on glass and silicon substrates.

3.3.2 Preferred orientation of Cu$_2$O thin films

Since the oxygen flow rate process window for single phase Cu$_2$O deposition is narrow, the influence of this parameter on the growth orientation is quite limited (see Fig. 3.5). However, the total pressure has a significant effect on the film preferred orientation. As shown in Fig. 3.6(a), only the (200) diffraction peak of cuprite deposited at the total pressure of 0.5 Pa is clearly observed by XRD, indicating a texture along the <100> orientation. The increase of the total pressure to 1 Pa strongly modifies the X-ray diffractogram and only the (111) diffraction peak is clearly evidenced. Here, it is worth noting that the tunable texture of Cu$_2$O does not change the sign of the internal stress. Using the Stoney's method, <100> and <111> oriented Cu$_2$O thin films exhibit the compressive stress of 290 ± 10 MPa and 80 ± 20 MPa, respectively. Top-view SEM images of Cu$_2$O thin films deposited at 0.5 Pa and 1 Pa are shown in Fig. 3.6(b) and 3.6(c), respectively, which demonstrates that the grain size of film deposited at 0.5 Pa (approx. in the 20-35 nm range) is larger than that deposited at 1 Pa (approx. in the 10-25 nm range).
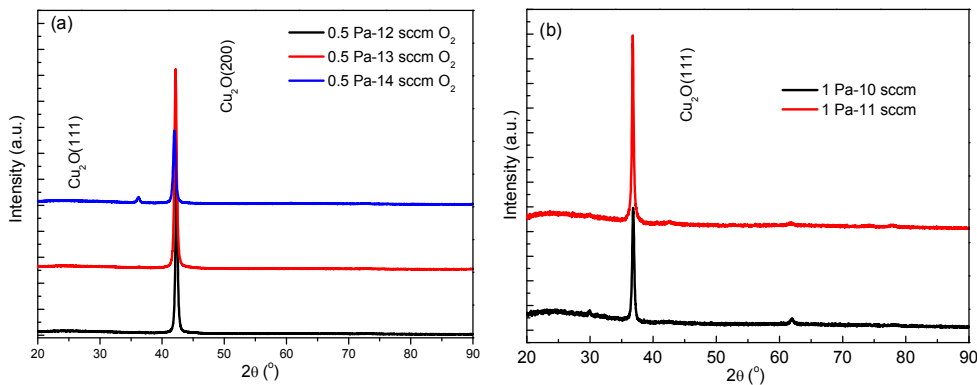
Fig. 3.5   X-ray diffractograms of single phase Cu$_2$O thin films deposited at 0.5 Pa (a) and 1 Pa (b) with different oxygen flow rates.
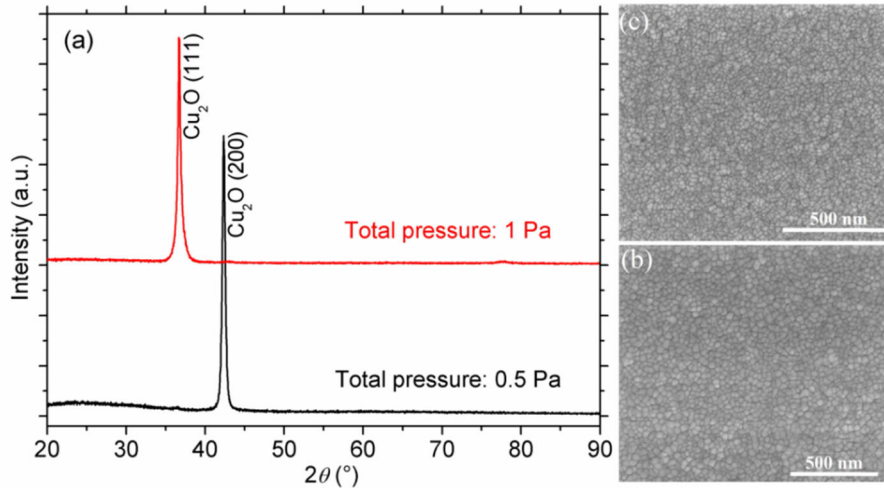
Fig. 3.6　(a) X-ray diffractograms of Cu_2O films deposited at 0.5 Pa (820 nm thick) and 1 Pa (720 nm thick). (b) and (c) are SEM images of films deposited at 0.5 and 1 Pa, respectively.

To attain further knowledge on the microstructure of a Cu_2O film deposited at 0.5 Pa on silicon substrate, TEM analyses have been performed (see Fig. 3.7). The bright and dark field images (Fig. 3.7(a) and 3.7(b), respectively) clearly show the columnar microstructure of the film with the Zone T growth mode. The contrast differences in Fig. 3.7(a) and 3.7(b) are due to the slight variations in the column orientation, which changes the Bragg diffraction condition. The size of the columns is in the 25-40 nm range, which is close to the grain size estimated by the top-view SEM, indicating that the grains observed by SEM correspond to the top of the columns. Fig. 3.7(c) is the selected area electron diffraction (SAED) pattern of a column (marked as X in Fig. 3.7(a) and 3.7(b)), which indicates that the columnar grains have <100> growth orientation. This growth orientation identified by the TEM is consistent with that obtained from XRD. The electron diffraction pattern shows some additional diffraction spots situated around the primary spots. But the top-view SAED pattern for one grain shows a diffraction pattern without additional spots. The additional diffraction spots may be due to the diffraction of another grain oriented with the same fiber texture, as the thickness of the TEM foil is estimated to be about 50~70 nm using valence electron energy loss spectroscopy (VEELS) [83], larger than the column width of 25-40 nm. Then the sample contains more than one column in the thickness direction, leading to additional diffraction spots. Hence, we can be confident that columns are single crystal. Similar situation exists in Cu_4O_3 and CuO

thin films. The high resolution TEM (HRTEM) image (as seen in Fig. 3.7(d)), shows an interplanar distance of ~0.21 nm, corresponding to the (200) planes of Cu_2O.
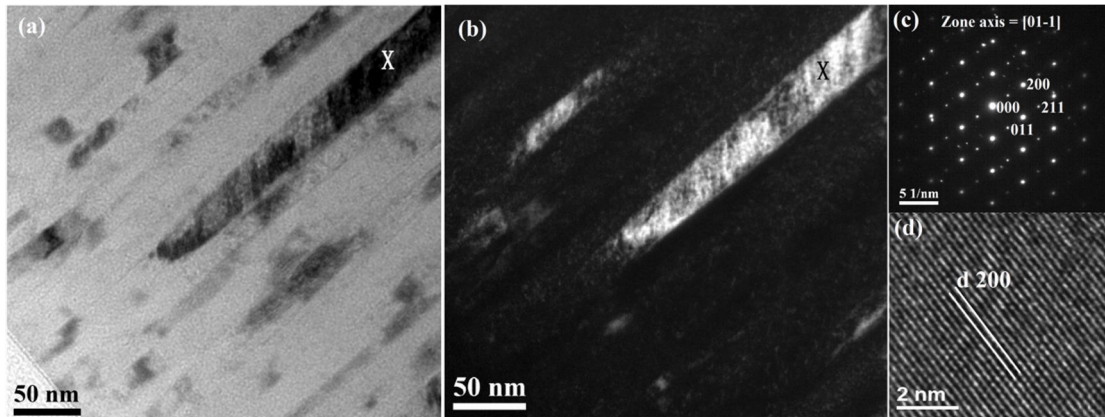
Fig. 3.7   TEM micrographies of single phase Cu_2O thin film deposited at 0.5 Pa. (a) Bright field image. (b) Dark field image. (c) Electron diffraction pattern of a column (marked as X in (a) and (b)). (d) HRTEM image.

3.3.3   Preferred orientation of Cu_4O_3 thin films

Akin to the case of Cu_2O, the oxygen flow rate has quite limit influence on the growth orientation. The preferred orientation of single phase Cu_4O_3 thin films is also strongly dependent on the total pressure: <101> orientated film is grown at 0.5 Pa total pressure while <100> preferred orientation is obtained at 1 Pa (see Fig. 3.8(a)). Fig. 3.8(b) and 3.8(c) are the top-view SEM images of single phase Cu_4O_3 thin films deposited at 0.5 Pa and 1 Pa, respectively. When the total pressure is fixed at 0.5 Pa, most of the grains exhibit a roof-type morphology due to the [101] preferred orientation in this tetragonal structure (Fig. 3.8(b)). On the other hand, the surface morphology of films deposited at 1 Pa can be depicted as elongated grains (Fig. 3.8(c)).

TEM micrographies of Cu_4O_3 thin films deposited at 0.5 Pa are shown in Fig. 3.9. The film also grows with a columnar microstructure and the column width has been estimated in the 30-70 nm range, as shown in Fig. 3.9(a) and 3.9(b). This large range comes from the distribution of in-plane grain orientation. The electron diffraction pattern of a column (marked

as Y in Fig. 3.9(a) and 3.9(b)) also confirms the <101> preferred growth orientation, as shown in Fig. 3.9(c). The HRTEM image is shown in Fig. 3.9(d), and the estimated interplanar distance of ~0.25 nm agrees well with the (202) interplanar distance of Cu_4O_3.

Fig. 3.8   (a) X-ray diffractograms of single phase Cu_4O_3 thin films deposited at 0.5 Pa (800 nm) and 1 Pa (720 nm). (b) and (c) are the SEM images of Cu_4O_3 thin films deposited at 0.5 Pa and 1 Pa, respectively.
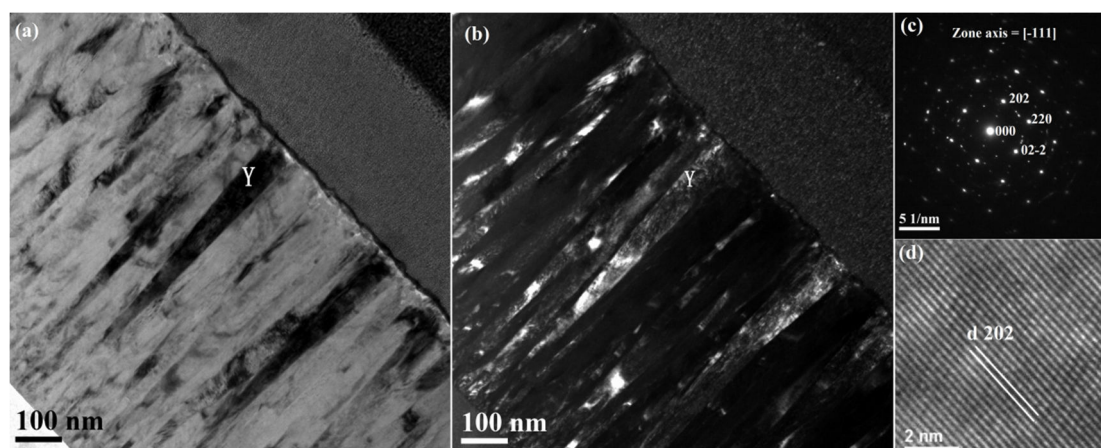
Fig. 3.9   TEM micrographies of Cu_4O_3 thin films deposited at 0.5 Pa. (a) Bright field image. (b) Dark field image. (c) Electron diffraction pattern of a column (marked as Y in (a) and 7(b)). (d) HRTEM image.

3.3.4   Preferred orientation of CuO thin films

The relationship of the preferred orientation of CuO thin films with the deposition parameters differs from that noticed in Cu_2O or Cu_4O_3 thin films. Since the oxygen flow rate

process window to synthesize single phase CuO thin films is wide (see Fig. 3.3), the oxygen flow rate may play a dominant role on the preferred orientation of CuO thin films. Fig. 3.10 shows the X-ray diffractograms and SEM images of CuO thin films deposited at 1 Pa for 10 min with different oxygen flow rates. It is worth noting that the thin films deposited at 0.5 Pa have the similar evolution of growth orientation. Referring to the JCPDS 04-007-1375 with a Cu $K_{\alpha 1}$ radiation, the CuO diffraction peaks of (002) ($2\theta = 35.468°$) and $(\bar{1}11)$ ($2\theta = 35.559°$), (111) ($2\theta = 38.754°$) and (200) ($2\theta = 38.968°$) are close, so it is hard to index the diffraction peaks at about 35° and 38° in Fig. 10(a) from this Bragg Brentano configuration. The sum of X-ray diffractograms of CuO films (1 Pa total pressure and 24 sccm oxygen flow rate) obtained at different χ angles (tilt angle on a Eulerian 4-circle diffractometer) from a Co K_{α} radiation shows that the diffraction peak at about 38° is not symmetrical (see Fig. 3.11), which indicates that both (111) and (200) diffraction planes contribute to this peak and (111) plane plays the predominant role. The SEM image of CuO thin films deposited with 16 sccm O_2 (see Fig. 3.10(b)) shows that most of the grains have a pyramidal shape, which confirms that the <111> orientation could be the main growth orientation. This observation is also in agreement with first-principle calculations that demonstrate the surface energy of {111} planes (0.74 J/m^2) is much lower than that in polar {100} planes (2.28 J/m^2) [89]. In the case of the diffraction peak at about 35° in Fig. 3.10(a) measured by Cu $K_{\alpha 1}$ radiation, the diffractograms from Co K_{α} radiation with different χ angles depicted in Fig. 3.11 still can not identify the diffraction planes, as (002) and $(\bar{1}11)$ diffraction peaks are too close to be distinguished by XRD. Since the {001} planes contain alternating planes of Cu^{2+} and O^{2-}, they are also expected to be polar surfaces with electrostatical instability and high surface energy, similar with {100} planes. Then the $(\bar{1}11)$ planes with second lower surface energy (0.86 J/m^2) [89], may play the main contribution to the diffraction peak at about 35° in Fig. 3.10(a). Hence, it is clearly shown in Fig. 3.10 that low O_2 flow rate leads to the formation of <111> preferred orientation, while high O_2 flow rate results in the $<\bar{1}11>$ texture. Here it should be noted that the stress of CuO thin films is still low. For instance, CuO thin films

deposited at 0.5 Pa total pressure with 22 and 27 sccm O_2 show <111> and <$\overline{1}11$> texture, respectively. However, their compressive stress is only 92 ± 9 MPa and 140 ± 15 MPa, respectively.
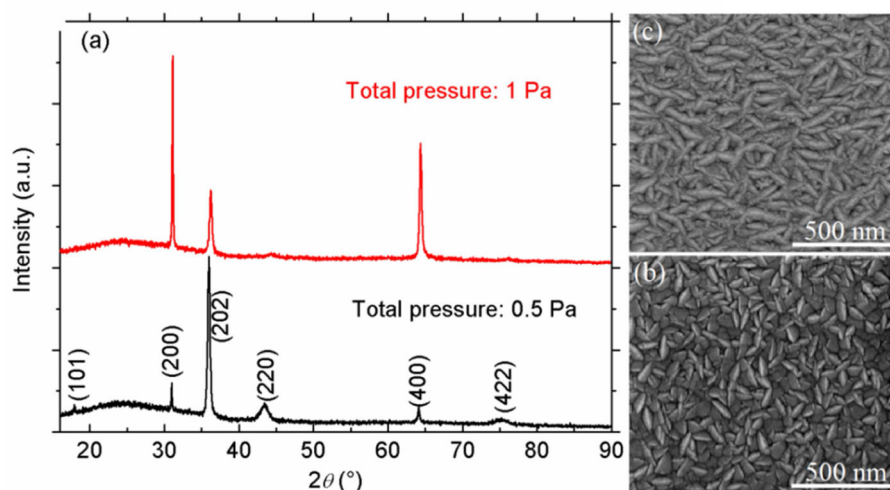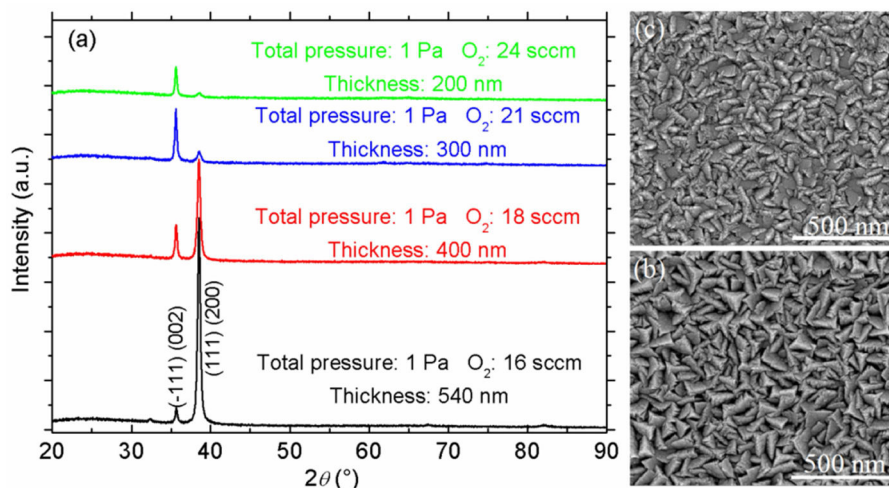

Fig. 3.10 (a) X-ray diffractograms of single phase CuO thin films deposited at 1 Pa. (b) and (c) are the SEM images of CuO thin films deposited at 1 Pa with 16 and 24 sccm oxygen flow rate, respectively.
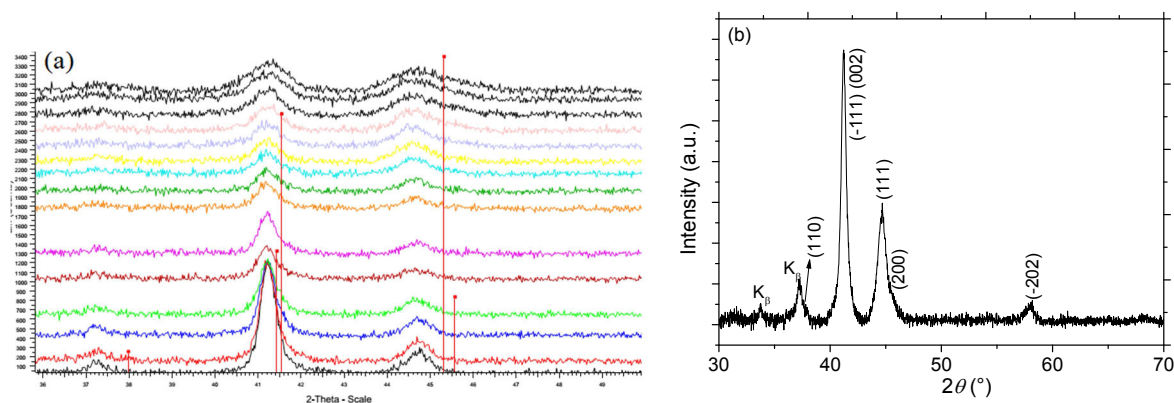
Fig. 3.11 X-ray diffractograms of single phase CuO thin films deposited at 1 Pa total pressure and 24 sccm oxygen flow rate measured by a Co K_α radiation. (a) Diffractograms measured with different χ angles (from 0° to 70° with a step of 5°). The diffraction peaks from JCPDS card (04-007-1375) is also shown. (b) The sum of the diffractograms in (a).

TEM micrographies of CuO thin films deposited at 0.5 Pa with 22 sccm O_2 flow rate, are shown in Fig. 3.12. The film exhibits a columnar growth with a column width of 20-40 nm (see Fig. 3.12(a) and 3.12(b)). The electron diffraction pattern in Fig. 3.12(c) also verifies the

<111> growth orientation. The interplanar distance measured from the HRTEM image in Fig. 3.12(d) is about 0.23 nm and this value agrees well with that of (111) planes.
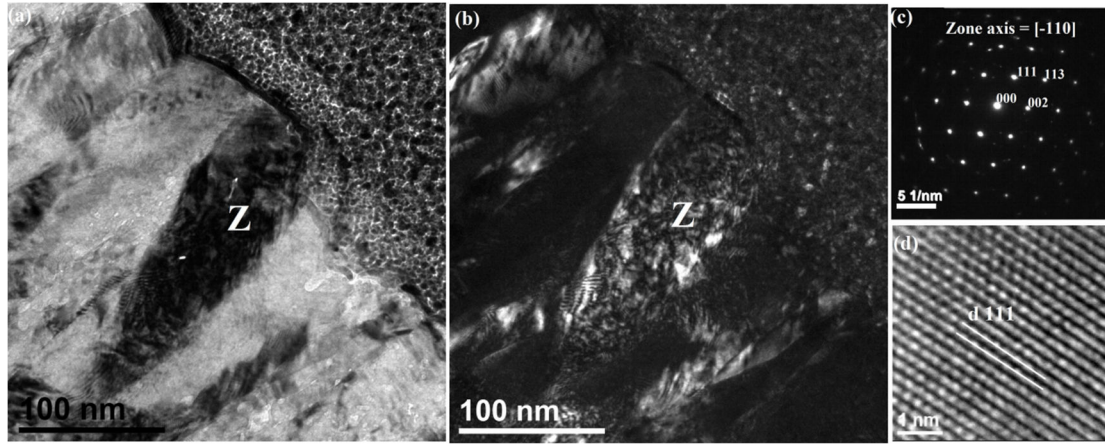
Fig. 3.12   TEM micrographies of CuO thin films deposited at 0.5 Pa with 22 sccm O_2. (a) Bright field image. (b) Dark field image. (c) Electron diffraction pattern of a column (marked as Z in Fig. 9(a) and 9(b)). (d) HRTEM image.

3.3.5   Discussion about the preferred orientation in copper oxide thin films

The evolution of thin film growth orientation is typically affected by the substrate temperature, substrate orientation, surface energy of materials, growth mode, growth rate, energetic particle bombardment, surface diffusion [85]–[87], [90]–[92]. All these factors interact with each other and form a complex system. However, here we are able to grow binary copper oxide thin films with tunable growth orientation on amorphous substrates (glass) or single crystal substrate (silicon) at room temperature. Taking Cu_2O as an example, both theoretical calculations and experiments have demonstrated that the surface energy (V) of different planes evolves in the order $V_{(100)} > V_{(110)} > V_{(111)}$ [93], [94], which means the (111) plane is the most stable. Therefore, it is deemed that low total pressure allows to produce the high surface energy of {100} planes parallel to the substrate, and high total pressure enables to form the low surface energy of {111} planes parallel to the substrate. In the case of Cu_4O_3, the atomic density has been calculated due to no reported data about the surface energy, which shows the {101} planes have fewer atomic density than {100} ones. Provided that the principle (planes with larger atomic density have smaller surface energy) exists in Cu_4O_3,

there will be an interesting phenomenon that the total sputtering pressure has a strong effect on the preferred orientations of Cu_2O and Cu_4O_3 thin films: low total pressure prefers to form the planes with high surface energy parallel to the substrates, while high total pressure facilitates the growth of planes with low surface energy parallel to the substrates. This striking feature may be related with the deposition rate and kinetic energy of impinging atoms. The low deposition rate at high total pressure, i.e. about 72 nm min^{-1} at 1 Pa for Cu_2O compared to 82 nm min^{-1} at 0.5 Pa, leads to a reduction in the flux of incoming atoms. Then adatoms have more time to diffuse on the substrate surface to relax themselves to the lowest surface energy configuration aligned parallel to the substrate [21], [91], [92]. On the other hand, low total pressure increases the contribution of the atomic bombardment process, as the collisions in the gas phase are reduced for sputtered atoms and reflected neutrals. As a consequence, the adatoms with higher kinetic energy tend to form the high surface energy configuration to maintain the equilibrium [90], [91], [95].

The tunable growth of CuO thin films is different from that in Cu_2O and Cu_4O_3 thin films, as the oxygen flow rate plays a dominant role. Hence, several reasons related to oxygen are thought to be responsible for this controllable growth in CuO. The first one is the nonstoichiometry and charge transfer [96], [97]. The calculations also show that the {111} surfaces are the most stable planes in oxygen poor condition, which agrees with our results that the <111> oriented film is formed at low oxygen flow rate. At this moment, the CuO {111} planes may be nonstoichiometric. However, with the further increase of oxygen flow rate, O_2 adsorption on {111} planes prefer to blind to the Cu site as O_2 tends to oxidize the unsaturated Cu ions [89]. Then the surface stoichiometry may change. Besides, the hole density will be enhanced after O_2 adsorption on {111} surfaces [89], which may result in the charge redistribution on the surface. Consequently, {111} planes are evolved to {$\bar{1}11$} planes with higher surface energy. Another possible cause is the bombardment effect of negative oxygen ions (O$^-$), as this kind of high energy ions has some influence on the growth orientation and crystallization [87], [98]. Usually, larger oxygen flow rate results in higher energy of O$^-$ [99], which indicates that the bombardment effect may be much more severer in CuO thin films

with large oxygen flow rate, leading to the evolution of growth orientation. Further experimental and theoretical investigations are required to clarify the mechanism.

3.4 Evidence of a local homoepitaxial growth mechanism in copper oxide thin films

3.4.1 Study of Cu_2O thin films

As previously reported, for a total sputtering pressure of 0.5 Pa and an oxygen flow rate of 13 sccm, a single diffraction peak belonging to the (100) planes of Cu_2O is found which indicates a texture along the <100> direction, as seen in Fig. 3.13. In the following this deposition conditions will be referred as "Cu_2O (I)". In contrast, the films exhibit a <111> texture for conditions corresponding to a total sputtering pressure of 1 Pa and an oxygen flow rate of 11 sccm. In the following this deposition conditions will be referred as "Cu_2O (II)". In both cases, the full width at half maximum (FWHM) of the diffraction peaks are larger than the instrumental one indicating a nanocrystalline character. Moreover, the diffraction peaks position leads for Cu_2O (I) and (II) to a cubic lattice parameter a = 0.4288 and 0.4263 nm, respectively. Since the lattice constant of bulk Cu_2O is 0.427 nm, the measured values may result from the composition shift in Cu_2O (I) and (II) layers. Here it should be pointed out that the oxygen flow rate process window for pure Cu_2O synthesis is narrow (approx. 3 sccm for 0.5 Pa total sputtering pressure and approx. 2 sccm for 1 Pa total sputtering pressure), as seen in Fig. 3.3. Within this process window, the oxygen flow rate has almost no influence on the texture of Cu_2O thin films. Fig. 3.13(b) and 3.13(c) show the (200) plane pole figure of Cu_2O (I) and (111) plane pole figure of Cu_2O (II), respectively. The pole figures for others planes, i.e. (111) for Cu_2O (I) and (200) for Cu_2O (II), have also been measured, but no preferred orientation (not shown here) has been evidenced perpendicularly to these planes. These results confirm the single layer Cu_2O thin films present a fiber texture that can be set along the <100> or <111> directions. The FWHM of the rocking curve measured along [200] and [111] directions for Cu_2O (I) and (II) are equal to 10.6° and 10.5°, respectively, indicating a similar mosaicity for both deposition conditions.
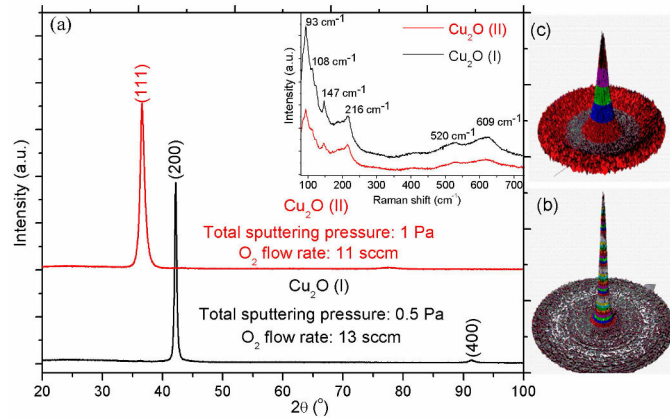
Fig. 3. 13 (a) X-ray diffractograms of single layer Cu_2O thin films deposited on glass substrates with different deposition conditions. The inset shows the corresponding Raman spectra. (b) (200) plane pole figure of thin film deposited using Cu_2O (I) condition. (c) (111) plane pole figure of thin film deposited at Cu_2O (II) condition.

Since the Cu_2O (I) and Cu_2O (II) conditions have a strong effect on the growth orientation of cuprite films, it is interesting to evaluate the resilience of the initial crystal orientation while perturbations of the synthesis parameters are applied. For this purpose, a Cu_2O thin film layer was first deposited on glass substrates using the Cu_2O (I) condition, and then a second Cu_2O layer with the same thickness (400 nm) was grown on top of it using the Cu_2O (II) condition. As shown in Fig. 3.14(a), this bilayer sample does not exhibit the two expected growth directions owing to Cu_2O (I) and (II) conditions. Only the <100> preferred orientation is evidenced by XRD, indicating that the second layer does not grow in within the <111> texture as observed for thin films deposited with the Cu_2O (II) condition. Such a result clearly evidences that the preferred orientation of the first layer sets that of the second layer. Actually, the (200) diffraction peak of the bilayer sample is composed of two parts (see Fig. 3.14(b)). This behavior can be explained considering homoepitaxy between the two layers. Although the seed layer exhibits a similar cell parameter as in the single layer configuration, the top layer shows a lower cell parameter ($a = 0.424$ nm). This likely originates from some defects induced by the competing between intrinsic growth conditions and the seed layer driving.
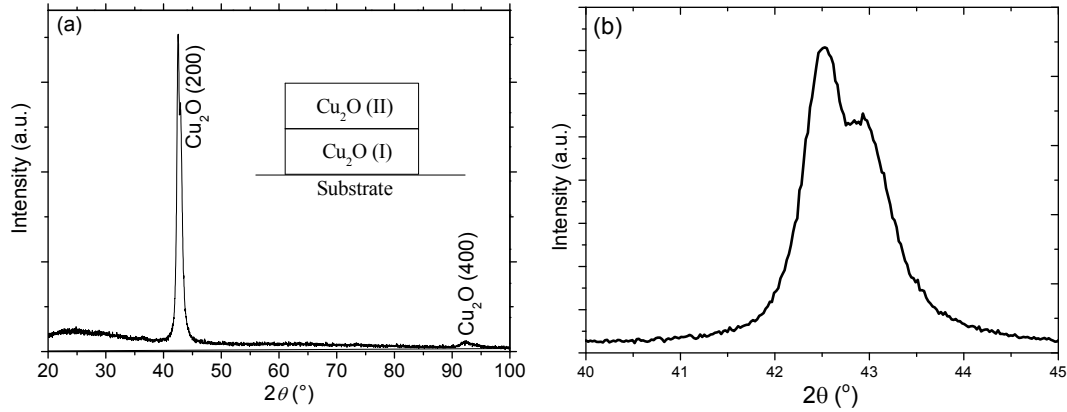
Fig. 3.14　(a) X-ray diffractogram of a Cu_2O bilayer. The inset shows the schematic growth structure (a 400 nm film with Cu_2O (I) condition on glass substrate, and then another 400 nm Cu_2O (II) film deposited on Cu_2O (I)). (b) Magnified (200) diffraction peak.

TEM analyses have been performed to investigate details of the microstructures in such homoepitaxialy grown Cu_2O thin films with a special attention paid to interfaces. The non-matched glass and silicon substrates were found to have little influence on the growth orientation and crystallization of Cu_2O thin films. Fig. 3.15(a) shows a low magnification TEM dark field image of Cu_2O (II) (400 nm) grown on Cu_2O (I) (400 nm), and Fig. 3.15(b) is the corresponding bright field image. As shown in these two images, the films exhibit a columnar morphology with the columns crossing the interface between Cu_2O (I) and Cu_2O (II) layers. Fig.3.15(c) is the high resolution TEM (HRTEM) image of this columnar interface (marked as X in Fig. 3.15(a) and 3.15(b)). The fast Fourier transform (FFT) patterns of selected regions grown under Cu_2O (I), Cu_2O (II) conditions and of their interface (marked as 1, 3, and 2 in Fig. 3.15(c)) are shown as Fig. 3.15(d), 3.15(e), and 3.15(f). The FFT patterns in Fig. 3.15(d) and 3.15(e) are very similar, which indicates that the columns in Cu_2O (I) and Cu_2O (II) are single crystals with <100> growth orientation, and confirms Cu_2O (II) is epitaxially grown on Cu_2O (I). Since this epitaxial growth occurs in the columnar level, we call it as ¨local epitaxial growth¨. It means the Cu_2O (I) layer with <100> orientation acts as a seed layer even though the Cu_2O (II) growth conditions are in favor of the much more stable <111> orientation. Note that the random in-plane orientation of the seed layer is naturally maintained in the top layer. The FFT pattern of the interface (Fig. 3.15(f)) demonstrates that local order in this region is slightly disordered. The atom scale HRTEM image of the interface

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(see Fig. 3.16) effectively confirms the occurrence of stacking faults at the interface. However, the occurrence of such defects at the interface does not prevent the homoepitaxial growth of the second layer. The disorder at the interface between Cu_2O (II) and Cu_2O (I) can be understood considering that the Cu_2O (II) conditions are energetically adapted to the formation of the <111> orientation. Indeed, the <100> oriented seed layer strongly promotes the film to grow along the <100> direction and the competitive growth results in the disorder in the initial growth stages. After a few nanometers of growth, the orientation of seed layer fully beats the spontaneous orientation and the homoepitaxial growth is set. Therefore, the schematic microstructure of this local homoepitaxial growth is depicted in Fig. 3.17, with the character of one column in the top layer epitaxially grown on column in the seed layer. We expect this to be useful to control the growth orientation precisely in a production process.
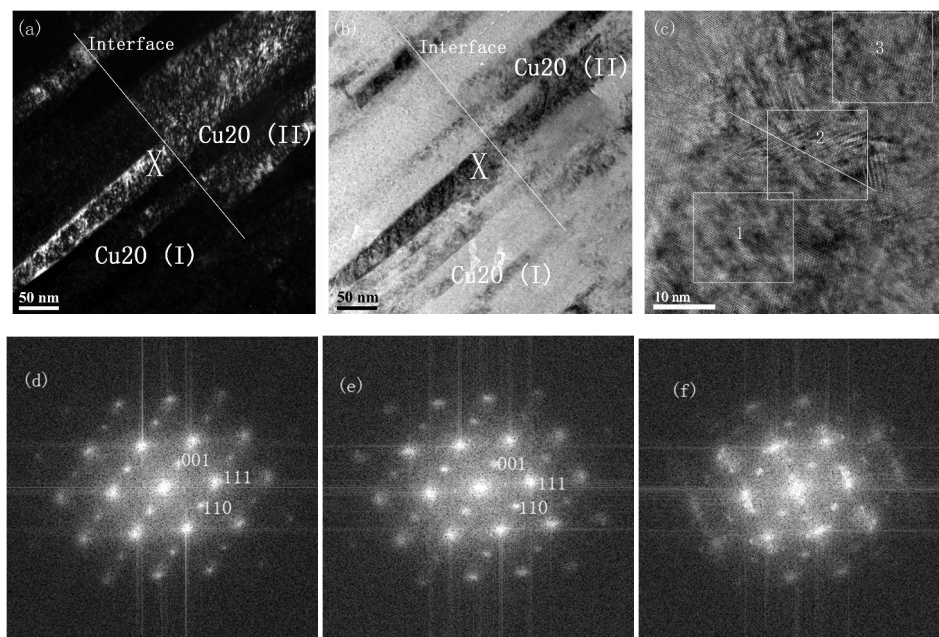
Fig. 3.15   (a) Dark field TEM image. (b) Bright field TEM image. (c) HRTEM image for a selected column (marked as X in Fig. 3.14(a) and (b)) at the interface between Cu_2O (I) and Cu_2O (II). (d), (e) and (f) are the FFT patterns for the 1, 3, and 2 regions in Fig. 3.15(c), respectively.
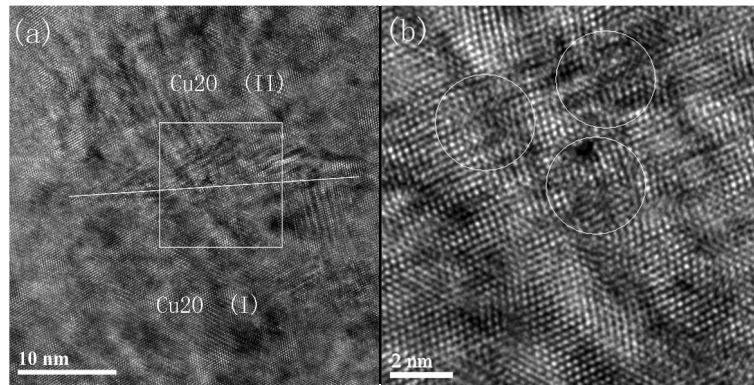
Fig. 3.16 (a) HRTEM image of the interfacebetween Cu_2O (I) and Cu_2O (II). (b) The magnified image of the selected square area in (a). The circles denote the structural defects.

Local homoepitaxial relationship
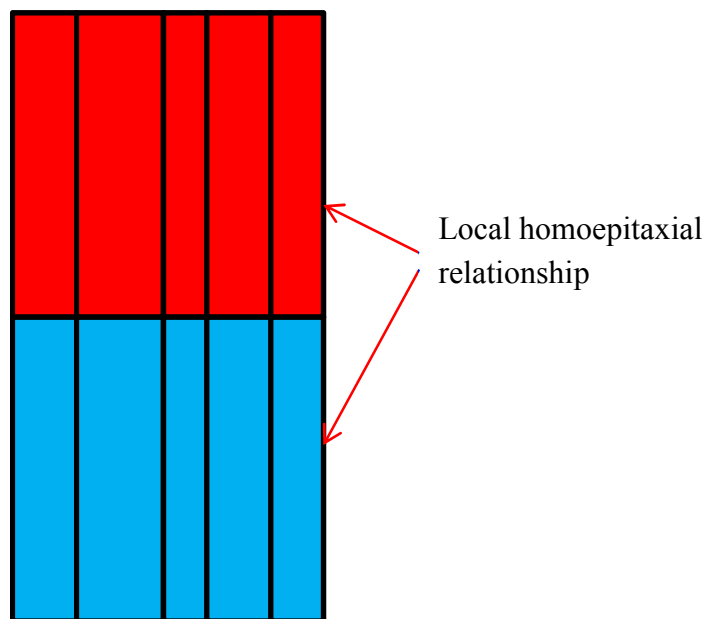
Fig. 3.17 Schematic microstructure of local homoepitaxial growth with the characteristic of one column epitaxially grown on one column. Blue and red represent seed layer and top layer, respectively.

Fig. 3.18 shows the X-ray diffractogram of Cu_2O (II) homoepitaxial films with different thicknesses of Cu_2O (I) seed layers. As shown in Fig. 3.18, a thickness of the seed layer equal to or larger than 60 nm is required for homoepitaxial growth to occur. For the thinnest seed layer, the <100> preferred orientation is not prominent, so the driving force for the growth orientation from the seed layer is not as strong as that promoted from the intrinsic growth conditions owing to Cu_2O (II).
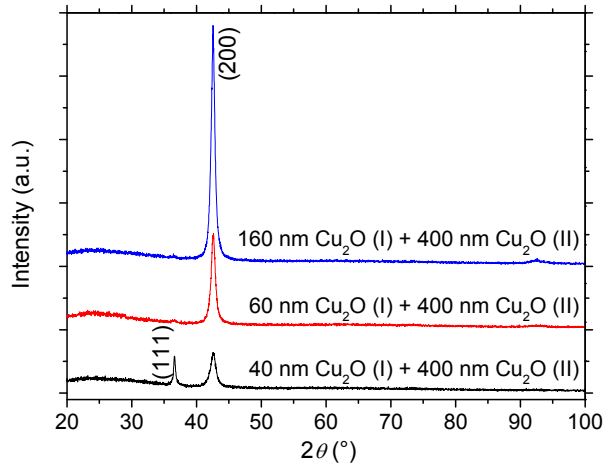
Fig. 3.18 X-ray diffractograms of homogrowth Cu_2O films with different thicknesses of Cu_2O (I) seed layers.

It is interesting to note that the contamination of the seed layer in air cannot block the homoepitaxial growth. A Cu_2O (I) seed layer with 400 nm is grown first, then the sputtering chamber is open and the seed layer is exposed to air atmosphere. One hour later, the chamber is closed and pumped to 10^{-4} Pa again. Subsequently, the Cu_2O (II) layer (400 nm) was grown on the air-exposed seed layer without any plasma cleaning. But X-ray diffractogram shows that the homoepitaxial growth still exists (see Fig. 3.19).The contamination in air does not prevent the homoepitaxial growth.
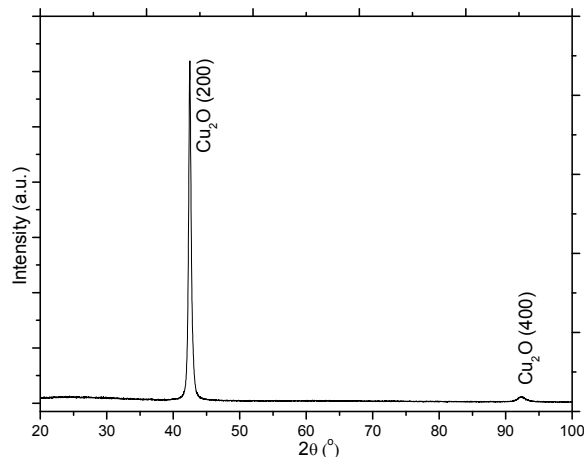
Fig. 3.19 X-ray diffractogram of Cu_2O (II) film homo-growth on air-exposed Cu_2O (I).

The epitaxial growth of <100> has been clearly evidenced here above. To check that this behavior can be extended to the <111> growth, a 400 nm-thick layer has been deposited using

Cu$_2$O (I) conditions over a Cu$_2$O (II) layer of same thickness (Fig. 3.20). Similarly to the growth of Cu$_2$O (II) on Cu$_2$O (I), the homoepitaxial growth along <111> direction also occurs. However, the critical thickness for the Cu$_2$O (II) seed layer to promote homoepitaxial growth is above 100 nm, larger than that of the Cu$_2$O (I) seed layer. This may originate from the smaller grain size in the Cu$_2$O (II) seed layer.
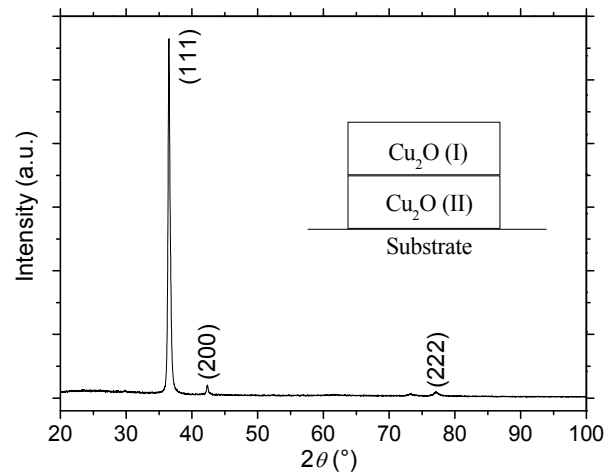
Fig. 3.20   X-ray diffractogram of (111) homoepitaxial Cu$_2$O thin film. The inset shows the schematic growth structure (a 400 nm film with Cu$_2$O (II) condition on glass substrate, and then another 400 nm Cu$_2$O (I) film deposited atop the first layer).

3.4.2   Can the local homoepitaxial growth be extended to Cu$_4$O$_3$ or CuO?

As we discussed before, the total sputtering pressure is also effective to tune the growth orientation in Cu$_4$O$_3$ (see Fig. 3.8). Then we are interested whether the local homoepitaxial behavior exists in tetragonal Cu$_4$O$_3$, or not? As shown in Fig. 3.21(a), the growth conditions (0.5 Pa and an oxygen flow rate of 19 sccm) to produce a <101> oriented film is defined as "Cu$_4$O$_3$ (I)". On the other hand, the conditions corresponding to a total sputtering pressure of 1 Pa and an oxygen flow rate of 14 sccm to form <100> texture is referred as "Cu$_4$O$_3$ (II)".

To study the growth mechanism of bilayer thin films, a Cu$_4$O$_3$ thin film layer was first deposited on glass substrates using the Cu$_4$O$_3$ (II) conditions, and then a second Cu$_4$O$_3$ layer was grown on top of it using the Cu$_4$O$_3$ (I) conditions. As shown in Fig. 3.21(b), the intensity of (200) diffraction peak in this bilayer film is enhanced a lot, while the (202) diffraction peak

is not clearly seen any more. Such results indicate that the top layer follows the <100> growth orientation of the bottom layer.

Fig. 3. 21 (a) X-ray diffractograms of single layer Cu_4O_3 thin films deposited on glass substrates with different deposition conditions. (b) X-ray diffractogram of Cu_4O_3 bilayer film, where a 720 nm film with Cu_4O_3 (II) condition was deposited on glass substrate, and then a Cu_4O_3 (I) film with 800 nm thickness deposited on the top of Cu_4O_3 (II)).

TEM analyses have been performed to investigate the microstructures in such Cu_4O_3 bilayer. Fig. 3.22(a) shows a low magnification TEM dark field image of 800 nm Cu_4O_3 (I) grown on a 720 nm Cu_4O_3 (II), and Fig. 3.22(b) is the corresponding bright field image. As shown in these two images, the films exhibit a columnar morphology with the columns crossing the interface between Cu_4O_3 (I) and Cu_4O_3 (II) layers. Fig. 3.22(c) is the HRTEM image at this interface. The FFT patterns of selected regions grown under Cu_4O_3 (I) and Cu_4O_3 (II) conditions (marked as 1 and 2 in Fig. 3.22(c)) are shown as Fig. 3.22(d) and 3.22(e). The FFT patterns in Fig. 3.22(d) and 3.22(e) demonstrate the <100> growth

orientation in these two layers along the film thickness direction, which agrees well with the results from X-ray diffractograms. Moreover, these quite similar patterns in two layers confirm Cu_4O_3 (I) is epitaxially grown on Cu_4O_3 (II) in the columnar level, with the character of one column on one column. Such kind of local homoepitaxial growth is similar with that encountered in Cu_2O thin films.
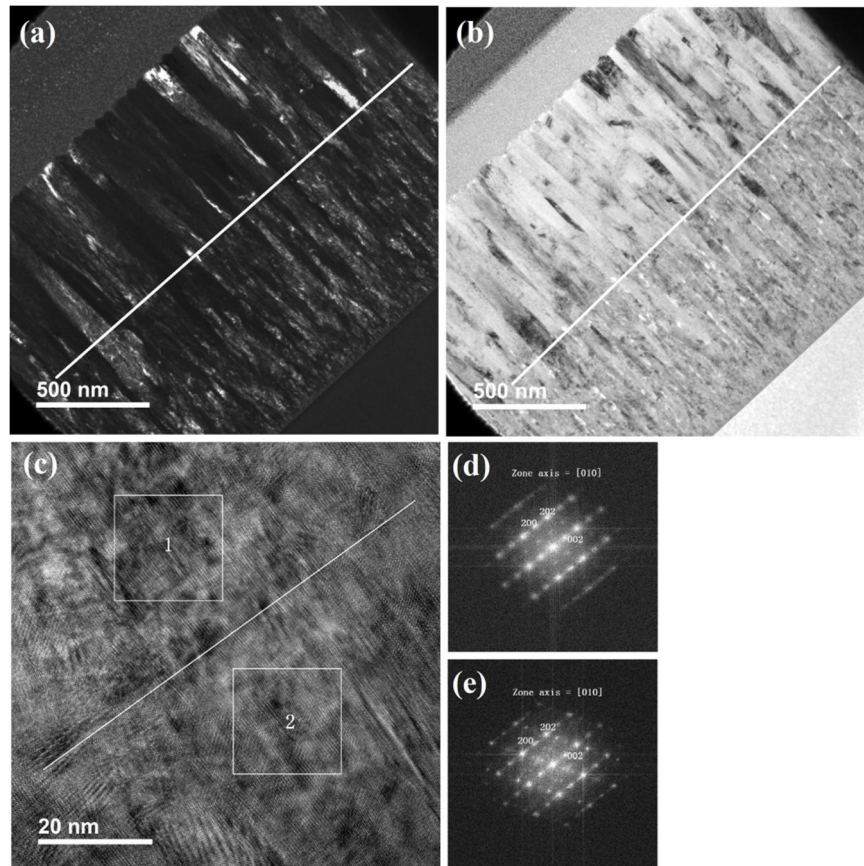
Fig. 3.22 (a) Dark field TEM image. (b) Bright field TEM image. (c) HRTEM image for a selected column at the interface between Cu_4O_3 (I) and Cu_4O_3 (II). (d) and (e) are the FFT patterns for the 1 and 2 regions in Fig. 3.22(c), respectively.

The inverse deposition sequence of the Cu_4O_3 bilayer has also been studied: a layer with Cu_4O_3 (II) conditions was deposited on the top of a Cu_4O_3 (I) layer. However, as shown in Fig. 3.23, a significant (200) diffraction peak is detected while this peak is not observed for the single layer deposited with the Cu_4O_3 (I) conditions. This (200) diffraction peak comes from the intrinsic growth conditions of Cu_4O_3 (II) (see Fig. 3.21(a)). These results show that the <101> oriented bottom layer with Cu_4O_3 (I) conditions cannot govern the growth orientation

of the top layer fully, which is different from that in Cu_4O_3 (I) grown on Cu_4O_3 (II). This seems to indicate that this <101> oriented Cu_4O_3 bottom layer can hardly promote the local homoepitaxial growth.
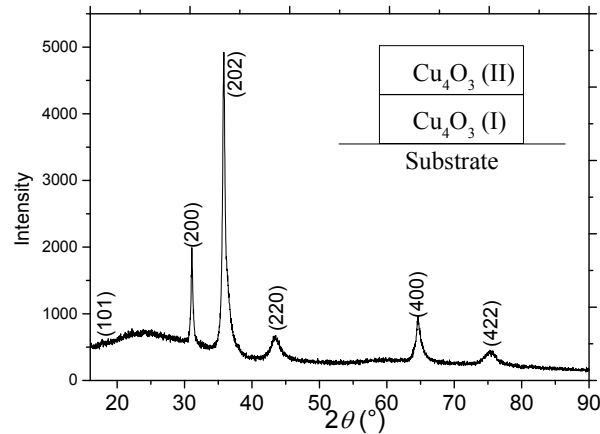
Fig. 3.23   X-ray diffractogram of a Cu_4O_3 bilayer with 800 nm Cu_4O_3 (II) film deposited on 800 nm Cu_4O_3 (I) layer.

Special growth conditions (0.9 Pa total sputtering pressure and 16 sccm O_2 flow rate), defined as "Cu_4O_3 (III)", can produce single phase Cu_4O_3 thin films without notablely preferred orientation, as shown in Fig. 3.24(a). In this case, both (200) and (202) diffractions peaks are clearly evidenced. Then, a bilayer film with 800 nm Cu_4O_3 (I) deposited on 740 nm Cu_4O_3 (III) is synthesized. Surprisingly, the X-ray diffractogram of this bilayer (see Fig. 3.24(b)), shows that the absolute intensity of (200) and (400) diffraction peaks, as well as the relative intensity ratio between (200) and (202) peaks, are enhanced a lot. This implies that the <100> growth orientation in the seed layer provides a strong driving force to set the growth orientation of the top layer.
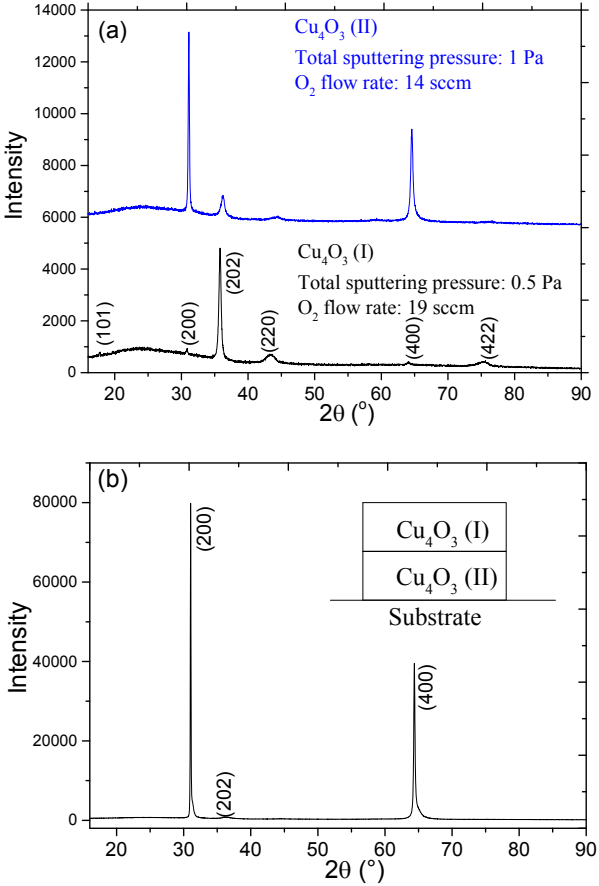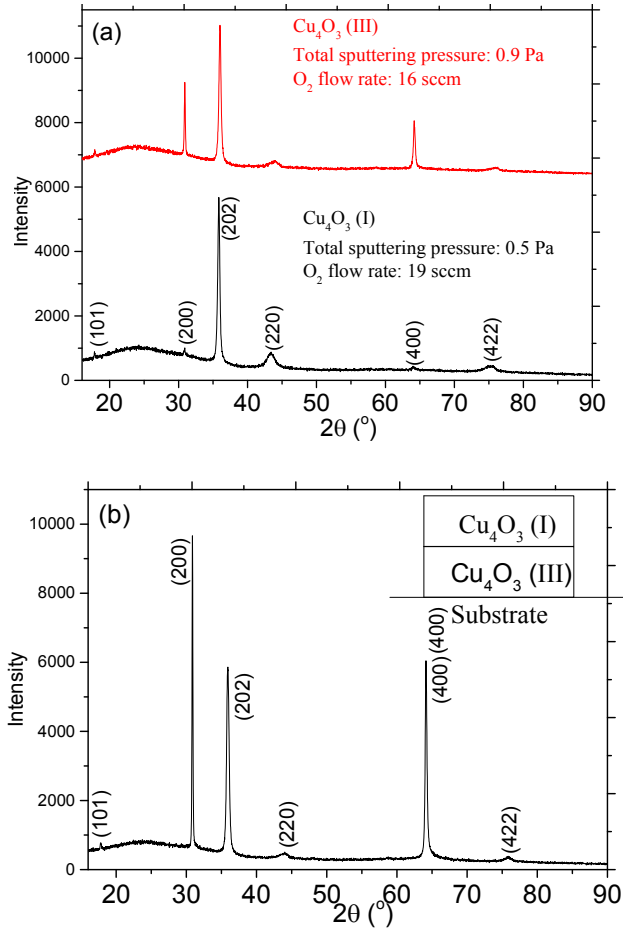
Fig. 3.24 (a) X-ray diffractograms of single layer Cu_4O_3 thin films deposited on glass substrates with different deposition conditions. (b) X-ray diffractogram of Cu_4O_3 bilayer film, where a 740 nm film with Cu_4O_3 (III) condition on glass substrate, and then another 800 nm Cu_4O_3 (I) film deposited on Cu_4O_3 (III)).

Comparing the results of bilayer films from Fig. 3. 21(b) (Cu_4O_3 (I) on Cu_4O_3 (II)), Fig. 3. 23 (Cu_4O_3 (II) on Cu_4O_3 (I)) and Fig. 3. 24(b) (Cu_4O_3 (I) on Cu_4O_3 (III)), it seems to show that only when the seed layer has high content of <100> growth orientation, the local homoepitaxy to control the top layer growth orientation of Cu_4O_3 is available. The origin of this behavior remains unknown. It is worth noting that this local homoepitaxial growth can hardly been extended into monoclinic CuO thin films, even though the growth orientation of single layer CuO films can be easily tuned by oxygen flow rates (see Fig. 3.20). Further theoretical and experimental investigations focused on the chemistry of interface are required to clarify the mechanism of this local homoepitaxial growth.

3.5   Local heteroepitaxial growth of NiO on Cu$_2$O

NiO crystallizes in the cubic rocksalt structure (space group Fm$\bar{3}$m), where the Ni^{2+} and O^{2-} ions are six-fold coordinated. Along the <111> direction, NiO consists of alternative Ni^{2+} and O^{2-} planes with Ni^{2+} or O^{2-} as terminations, giving rise to a net surface charge and an electric dipole moment (infinite surface energy) in the repeat unit perpendicular to the {111}surfaces. This leads to the polar NiO {111} surfaces [100]–[102]. Accompanied by the surface reconstruction (hydroxylation or adsorption of contamination beyond a simple bulk truncation to stabilize the polarity [100]–[102]), the polar surfaces exhibit some unique properties. For instance, NiO {111} surfaces, have larger work function than that of non-polar {100} surfaces [103]. This enables to dramatically enhance the open circuit voltage and power conversion efficiency in polymer bulk-heterojunction solar cells by inserting a <111> oriented NiO thin film as anode interfacial layer [103], [104]. Different reactive magnetron sputtering methods (including direct-current (DC), radio frequency (RF) and high-power impulse magnetron sputtering (HiPIMS)) have been used to grow NiO thin films from metallic Ni target, but most of them show <100> preferred orientation or non-preferred orientation [105]–[107]. Thus, the growth of <111> oriented NiO thin films by reactive sputtering on non-matched substrates at room temperature is still challenging.

The cubic Cu$_2$O (space group Pn-3m) with lattice constant a of 0.427 nm in bulk has similar structure with NiO (a = 0.417 nm in bulk).   The lattice mismatch in the unit cell between NiO and Cu$_2$O is about 2.4 %. On the other hand, Cu$_2$O {111} planes only contain Cu atoms, which seems to be naturally matched with the polar NiO {111} planes. From these crystallographic characters, it seems that the epitaxial criterias are fulfilled between Cu$_2$O {111} and NiO {111}. Hence, it is interesting to investigate the thin film growth mechanism of a NiO layer deposited on top of a <111> oriented Cu$_2$O layer at room temperature using the reactive magnetron sputtering process.

X-ray diffractograms of single layer NiO thin films deposited on glass substrates with different O$_2$ flow rates are shown in Fig. 3.25(a), while the Ar flow rate is fixed at 25 sccm. Within this range of oxygen flow rates, no metallic nickel is evidenced by XRD, indicating

that all the NiO thin films are single phase. The increase of the oxygen flow rate from 4 to 7 sccm does not influence the preferred orientation. However the use of higher oxygen flow rate (11 sccm) induces a decrease of the film crystallization, which may result from the reduction of sputtered atoms kinetic energy and/or the enhancement of oxygen ion bombardment. Overall, the signal to background noise ratio is weak. These X-ray diffractograms show that the crystallization of single layer NiO thin films is poor and that the preferred orientated growth is not clear.
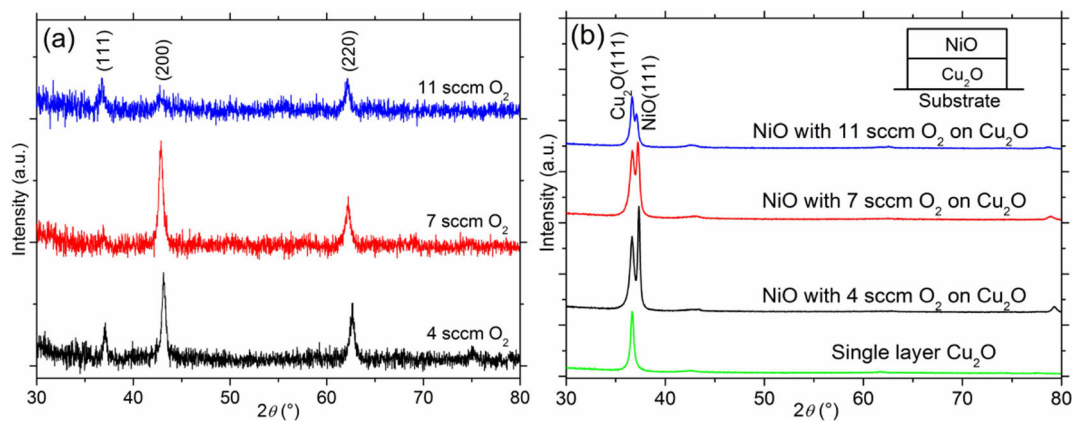
Fig. 3.25 (a) X-ray diffractograms of single layer NiO thin films (about 200 nm) deposited at various oxygen flow rates. (b) X-ray diffractograms of Cu₂O/NiO bilayers. The NiO films have been deposited using the same oxygen flow rates with those used in Fig. 25 (a). X-ray diffractogram of single layer Cu₂O is displayed in the bottom as a reference. The inset shows the schematic growth architecture (200 nm NiO grown on 360 nm Cu₂O film previously deposited on glass substrate).

X-ray diffractogram of a Cu₂O thin film (about 360 nm) deposited at 1 Pa total pressure and 11 sccm oxygen flow rate is presented in the bottom of Fig. 3.25(b). An intense (111) diffraction peak is clearly observed, indicating the highly <111> preferred orientation of this material. NiO films with about 200 nm thickness have been deposited on Cu₂O films without air contamination of the Cu₂O/NiO interface. The X-ray diffractograms of these bilayers are presented in Fig. 3.25(b). Although using the same values of oxygen flow rate for NiO deposition than those used in Fig 3.25(a), the preferred orientation and crystallization of NiO films are strongly improved by the deposition of the Cu₂O layer. Whatever the oxygen flow rate, the (200) and (220) diffraction peaks of NiO are not clearly observed anymore. On the

other hand, the 2θ diffraction angles at about 36~37° show two contributions. The first part located at approx. 36.6° is related to the Cu_2O layer and the second part with higher diffraction angle corresponds to the diffraction of the NiO (111) planes. Moreover, the intensity of NiO (111) diffraction peaks in the bilayers are much more stronger than that in single layer NiO thin films with the same thickness, demonstrating the better crystallization. Such results indicate that the preferred orientation of Cu_2O strongly governs that of the NiO layer, regardless of the NiO deposition conditions. This means the Cu_2O layer acts as a seed layer, which can be used to tune the growth orientation of the top NiO layer. Finally, the NiO (111) diffraction peak intensity in the bilayers with the same thickness has a tendency to decrease with increasing the oxygen flow rate, which could be similar to the result observed in single NiO layer.

TEM analyses have been performed to study the microstructure of bilayers. TEM images of NiO deposited with 11 sccm O_2 grown on Cu_2O are presented in Fig. 3.26. Fig. 3.26(a) shows the low magnification TEM bright field image, which demonstrates the columnar growth in both NiO and Cu_2O layers. The microdiffraction method has been employed to determine the growth orientation. The microdiffraction patterns for NiO and Cu_2O acquired from the regions almost in a line along the film growth direction, are presented in Fig. 3.26(b) and (c), respectively. Such similar patterns clearly show the heteroepitaxial growth occurs in columns between these two layers. As seen in Fig. 3.26(b) and (c), the (111) planes in these two layers are parallel to the substrate surface, which is in accordance with the results obtained by the X-ray diffraction.
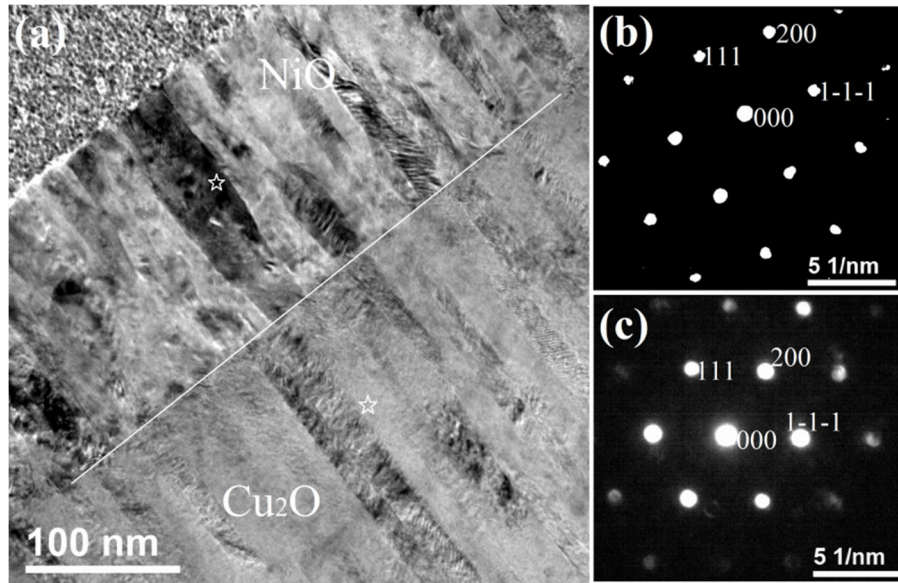
Fig. 3.26 TEM characterization of a NiO/Cu$_2$O bilayer. (a) Bright field image. (b) Microdiffraction pattern of NiO near the region of ¨star¨ in top layer. Zone axis is [$01\bar{1}$]. (c) Microdiffraction pattern of Cu$_2$O near the region of ¨star¨ in the bottom layer. Zone axis is [$01\bar{1}$].

In order to understand this local heteroepitaxial growth unambiguously, the interface region between Cu$_2$O and NiO has been investigated by HRTEM, as highlighted in Fig. 3.27(a). One Cu$_2$O column (marked as X) has a width of about 15 nm while the width of three small NiO columns (marked as 1, 2 and 3) is approx. 8, 3 nm and 4 nm. These three columns have been grown on the large Cu$_2$O one. The FFT analyses along the column growth direction have been performed. Fig. 3.27(b), (c), (d) and (e) show the FFT patterns of square regions named as 1, 1.1, 1.2, and X, respectively. The FFT pattern of Cu$_2$O (see Fig. 3.27(e)) demonstrates the <111> growth orientation of seed layer. At the interface region of 1.2, the <111> growth orientation of NiO is clearly identified by the FFT pattern in Fig. 3.27(d), which indicates that the <111> orientation of NiO is set at the initial growth. Moving to the regions of 1.1 and 1, the FFT patterns (see Fig. 3.27(c) and (b)) distinctly show the <111> growth orientation of NiO. Meanwhile, the growth orientations of other two small NiO columns (2 and 3) have been checked. As shown in Fig. 3.27(f) and (g), these two small columns also exhibit pronouncedly <111> texture. Such results clearly show that several NiO columns can grow on one Cu$_2$O column in this NiO/Cu$_2$O local heteroepitaxy. Such behavior is quite different from that reported in local epitaxial grow of Cu$_2$O films: one column of the top layer grown on one

column of the seed layer. Therefore, the schematic microstructure of this new local epitaxial growth is depicted in Fig. 3.27(h). To be pointed out here, the FFT patterns show some additional diffraction spots situated around the primary spots, which comes from the characteristics of fiber texture and small column width. The thickness of the TEM foil is estimated to be about 50~70 nm using valence electron energy loss spectroscopy, much larger than the column width. This implies the TEM foil contains several columns along the electron beam direction. Besides, the fiber texture in the Cu_2O seed layer [21], may produce the similar fiber texture in NiO. Hence, several columns with some rotational degree of freedom around the fiber axis will result in other diffraction spots.
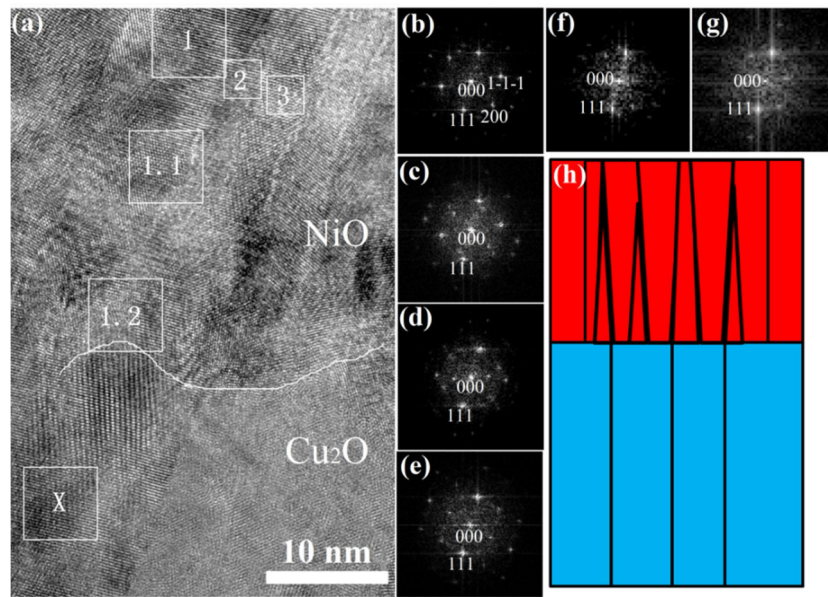
Fig. 3.27   (a) HRTEM image at the Cu_2O-NiO interface. One Cu_2O column is marked as X, while three NiO columns are marked as 1, 2 and 3. (b), (c), (d), and (e) are the FFT patterns of square regions of 1, 1.1, 1.2 and X along the column growth direction, respectively. (f) and (g) are the FFT patterns of square regions 2 and 3 perpendicular to the column growth direction, respectively. (h) Schematic drawing of growth mechanism between the Cu_2O seed layer (in blue) and the NiO top layer (in red).

The effect of the NiO thickness on its texture has also been studied (see Fig. 3.28). For single layer NiO thin films deposited with 11 sccm O_2 flow rate, the thickness strongly affects the preferred orientation. As shown in Fig. 3.28(a), 200 nm thick NiO film is poorly crystallized, while a [110] preferred orientation is evidenced when the thickness is fixed to

800 nm. This may originate from the stress value in single layer NiO. Using the Stoney's method, the compressive stress of a 200 nm thick NiO film is 2.2 ± 0.3 GPa. Higher NiO thickness may accommodate part of the stress, consequently changing the preferred orientation of NiO. The effect of the NiO thickness on its preferred orientation disappears when the NiO film is deposited on a Cu_2O seed layer (Fig. 3.28(b)). Whatever the NiO thickness, only a <111> texture is evidenced for NiO deposited on Cu_2O. The shape of the diffraction peak in the 36-37° region is dependent on the NiO thickness. For a 200 nm value, two diffraction peaks are observed as previously mentioned. The low angle peak is related to the (111) planes of the Cu_2O layer, while the high angle diffraction peak corresponds to the (111) planes of NiO. On the other hand, only one wide diffraction peak is observed for a 800 nm thick NiO film deposited on a Cu_2O one. Its position is ranging between those of (111) Cu_2O and (111) NiO. Such result can be explained considering a progressive change of the NiO contribution due to a decrease of the compressive stress.
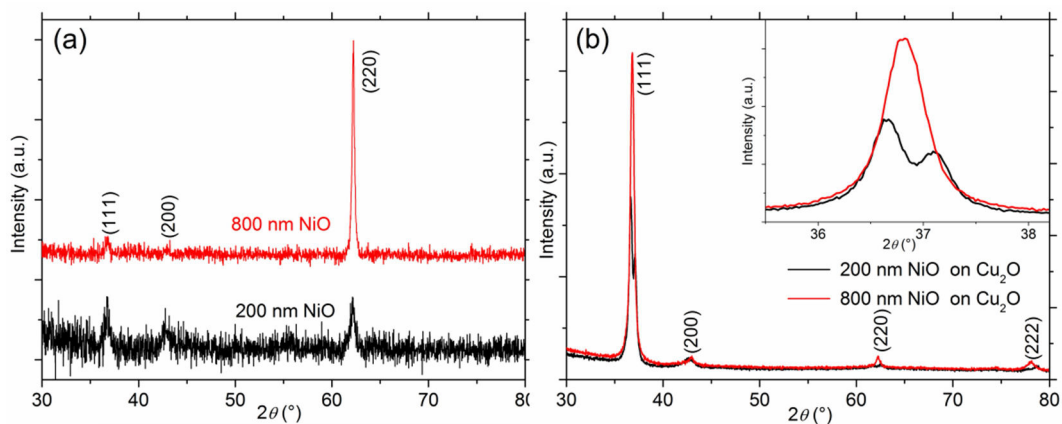
Fig. 3.28   (a) X-ray diffractograms of single layer NiO thin films with different thicknesses (200 nm and 800 nm) deposited at 11 sccm O_2 flow rate. (b)   X-ray diffractograms of NiO with different thicknesses deposited on Cu_2O seed layer with a constant thickness. The inset shows the magnified (111) diffraction peak.

The influence of Cu_2O seed layer thickness on the preferred orientation of NiO has been also investigated. 200 nm NiO films using 11 sccm O_2 have been deposited on Cu_2O seed layers with different thickness (60, 120 and 360 nm). The growth conditions (1 Pa total pressure and 11 sccm O_2 flow rate) to synthesize Cu_2O have been employed. X-ray

diffractograms show that a 60 nm seed layer has some ability to promote the growth of NiO (111) planes parallel to the substrate surface, but other diffraction peaks (like (200) and (220)) are also clearly evidenced and the crystallization of the thin film is poor (see Fig. 3.29). This means thicker Cu_2O films are necessary to attain the highly <111> preferred orientation of NiO. It is worth noting that we checked that contamination by air constituents of the Cu_2O/NiO interface does not block the growth of <111> oriented NiO. The thermal stability of <111> oriented NiO has been studied by air annealing, which demonstrates that <111> preferred orientation is quite stable even though the Cu_2O seed layer is fully oxidized into CuO.
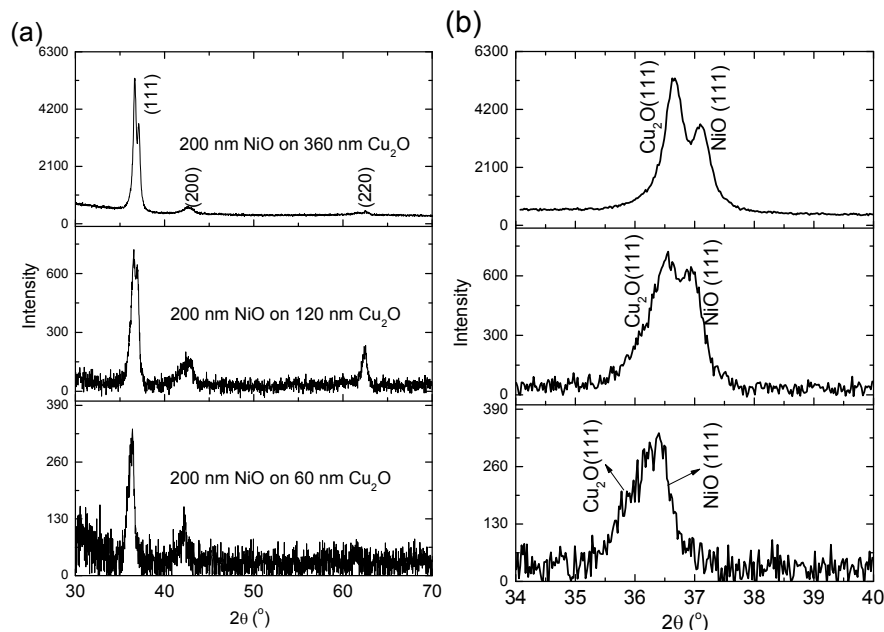
Fig. 3.29 (a) X-ray diffractograms of 200 nm NiO with 11 sccm O_2 flow rate deposited on Cu_2O seed layers with different thickness. (b) Magnified (111) diffraction peaks.

Since the preferred orientations of Cu_2O (<100> or <111>) can be tuned by changing the total sputtering pressure (see Fig. 3.6), NiO films have also been deposited on <100> oriented Cu_2O thin film. Special growth conditions (0.5 Pa total pressure and 14 sccm O_2 flow rate) have been used to grow the single layer <100> oriented Cu_2O thin films (400 nm). Then, a 200 nm thick NiO film with 11 sccm O_2 flow rate was grown ontop of the seed layer. As shown in Fig. 3.30, a (220) diffraction peak of NiO with high intensity is clearly evidenced at

approx. 62.6° as observed for NiO single layer, which indicates that this <100> oriented Cu_2O layer cannot fully support the local heteroepitaxial growth of <100> oriented NiO. This is out of our expectation that NiO thin film would fully follow the <100> orientation of Cu_2O. Comparing such a result with the <111> texture of NiO thin film on <111> oriented Cu_2O, it is believed that the atomic structures or chemistry at the interface may play an important role to drive the local heteroepitaxial growth. The surface terminations of Cu_2O {111} could be Cu or O atoms, but Cu or O atoms are not equivalent in the number and position (see Fig. 3.31). However, the terminations of NiO {111} are Ni or O atoms, and they are equivalent in number and position (see Fig. 3.31). The configurations of Cu atoms in {111} planes of Cu_2O are well matched with Ni or O atoms in {111} planes of NiO. Therefore, this local heteroepitaxial growth could be qualitatively understood like this: Cu terminations in <111> oriented Cu_2O seed layer may prefer to form the banding with O atoms when depositing the first layer of NiO, consequently giving rise to the polar <111> orientation with alternative Ni and O layers along the growth direction. Moving onto the {100} planes of Cu_2O, the surface terminations are Cu or O atoms with non-equivalent number and position. But NiO {100} are always composed of equivalent Ni and O atoms (see Fig. 3.31). This unmatched characteristic between Cu_2O and NiO {100} planes may introduce more defects and prevent the heteroepitaxial growth. Further theoretical and experimental investigations focused on the interface are required to clarify mechanism of this local heteroepitaxial growth.
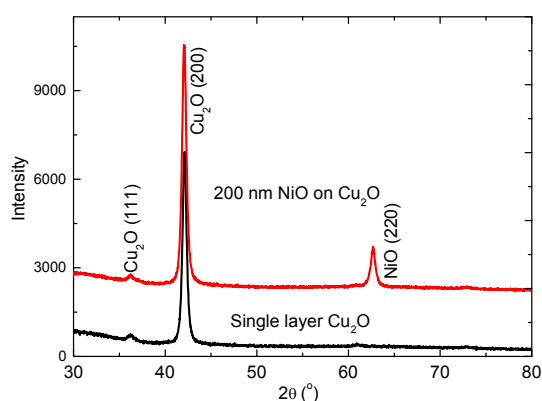
Fig. 3.30   X-ray diffractogram of NiO on <100> oriented Cu_2O thin film. The X-ray diffractogram of <100> oriented single layer Cu_2O thin film is displayed as a reference.
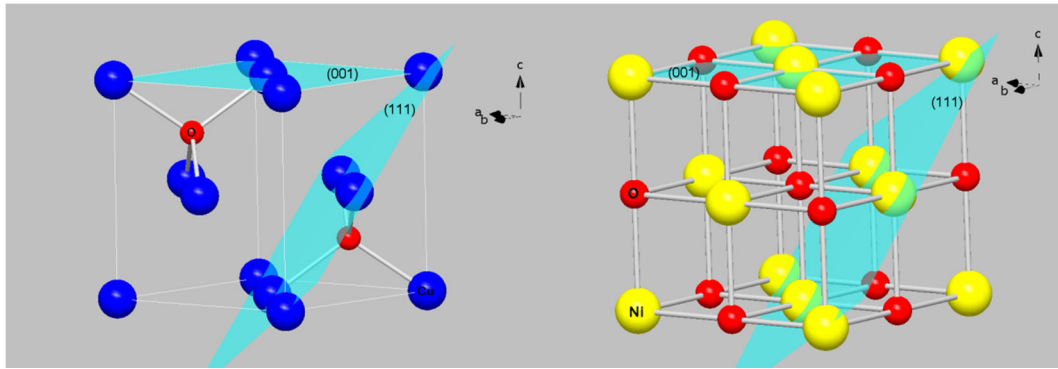
Fig. 3.31   Atomic configurations of (111) and (001) planes in Cu_2O (left) and NiO (right).

3.6   Chapter conclusions

In this chapter, we report the tunable growth in binary copper oxide thin films synthesized by reactive magnetron sputtering at room temperature. A deposition diagram, to describe the phase structure as a function of oxygen flow rate and total pressure, has been attained by combining Raman spectrometry and X-ray diffraction. The total pressure can be used to control the growth orientations of single phase Cu_2O and Cu_4O_3 thin films due to their narrow oxygen flow rate process windows. At low total pressure (0.5 Pa), Cu_2O and Cu_4O_3 exhibit a preferred orientation along the directions with the highest surface energy: [100] and [101], respectively. In contrast, planes with the lowest surface energy grow parallel to the substrate surface when the total pressure is fixed at 1 Pa. For CuO films, the preferred orientation can be controlled by the oxygen flow rate, i.e. by the oxygen stoichiometry.

Furthermore, the texture of the deposited films can also be controlled by the concept of local homoepitaxial growth. During this kind of local homoepitaxial growth experiments, a seed layer with preferred orientation is employed and another layer is deposited on top of it. The seed layer governs the growth orientation of the top layer via the homoepitaxial growth in columns with the character of one column on one column, independently of the deposition conditions of top layer. Such a behavior can promote the <111> or <100> preferred growth orientation in cubic Cu_2O thin films. On the other hand, in tetragonal Cu_4O_3 thin films, this kind of growth only produces the <100> texture and it fails to form <101> preferred orientation. Besides, no local epitaxial growth has been evidenced in monoclinic CuO thin

films. A local heteroepitaxial growth with the character of several columns on one column has been observed in bilayer films of NiO on Cu_2O, which is effective to improve the crystallization and to promote the <111> texture of NiO.

Chapter 4 Self-assembled growth of vertically aligned columnar copper oxide nanocomposite thin films on unmatched substrates

4.1 Introduction

Nanocomposite thin films have attracted much attention due to their peculiar in a large variety of applications, such as controlling the optical properties [108], [109], reducing the dielectric loss [110]–[112], tuning the magnetic and electrical transport properties [113]–[119], enhancing the electrochemical activity [120], [121], and increasing the hardness [122], [123]. The novel architecture, interfacial interplay, and interaction or coupling between the nanocomposite constituents, are thought to be responsible for these peculiar properties and new functionalities. The nanocomposite thin films are typically divided into four types from the viewpoint of microstructure, including nanoparticles in matrix, lamellar multilayer, columns in matrix and vertically aligned columnar nanocomposites[124]–[127]. Among them, vertically aligned columnar nanocomposite, where all the phases have the columnar growth along the film thickness direction, is particularly appealing as its larger interfacial area and high availability of vertical strain control than other types [124], [125].

In the past decade, tremendous progress has been made in nanocomposite thin films about designing interface-induced novel functionality. However, to the best of our knowledge, most of investigations on vertically aligned columnar oxide nanocomposites are dedicated to epitaxial films (one perovskite phase with another phase) grown on matched single-crystal oxide substrates at high temperature by pulsed laser deposition [110], [112], [115], [116], [118], [120], [124], [125]. Such matched single-crystal substrates are critical to promote the separated and independent columnar growth for different phases. Their high cost and small size, as well as the low homogeneous size of films deposited by pulsed laser deposition, are not desirable for the large-area devices. Hence, in order to promote the application of vertically aligned columnar nanocomposite thin films in different areas, it is attractive to deposit such films on unmatched substrates using a low-cost method. Magnetron sputtering is

a standard manufacturing process associated with relatively low cost and easy fabrication of large-area films. Sputtered films with single phase usually exhibit the columnar microstructure [87], [122], [128]. However, this typical columnar structure will vanish with the addition of a second phase, giving rise to a nanocrystalline composite [122]. Therefore, it is challengeable to grow biphase composite thin films with vertically aligned columnar structures on unmatched substrates by sputtering.

Binary copper oxides (Cu_2O, Cu_4O_3 and CuO), as spontaneous p-type semiconductors, have been widely studied [4], [5], [8], [27], [129]. More recently, some surprising properties have been observed in the biphase copper oxide composite thin films. For instance, a lower resistivity has been observed in biphase sputtered $Cu_2O + Cu_4O_3$ thin films than in the single phase Cu_2O or Cu_4O_3 thin films [8]. In addition, the biphase Cu_2O and Cu_4O_3 thin films can enhance the photovoltaic activity significantly in a binary copper oxide (Cu-O) light absorber [129]. However, the origin of these peculiar properties remains unknown.

In this work, for the first time, we demonstrate the vertically aligned columnar microstructure of biphase Cu_2O and Cu_4O_3 thin films on unmatched glass or silicon substrates grown by reactive magnetron sputtering. Finally, the unusual electrical properties of biphase thin films are discussed.

4.2 Vertically aligned columnar growth in biphase Cu_2O and Cu_4O_3 thin films

4.2.1 Identifying the phases by X-ray diffraction and Raman spectrometry

The diffractograms of copper oxide thin films deposited with different oxygen flow rates are presented in Fig. 4.1(a). Whatever the oxygen flow rate, two main diffraction peaks are observed at approx. 36° and 42°. The first peak may be due to the diffraction of Cu_2O (111) planes or Cu_4O_3 (202) or (004) planes and the peak located close to 42° may be related to Cu_2O (200) or Cu_4O_3 (220), as the d values in Cu_2O and Cu_4O_3 are quite close in certain planes (See Table 1.1). To obtain a more precise structural description of the films, micro-Raman spectrometry was used (see Fig. 4.1(b)). The film deposited with 14 sccm

oxygen shows a typical Raman spectrum of Cu_2O, where the T_{2g} band is observed close to 520 cm^{-1}. The bands at 93, 147 and 216 cm^{-1} are related to defects, non-stoichiometry and resonant excitation in Cu_2O [22]. A new band close to 531 cm^{-1} is evidenced when the oxygen flow rate is 15 sccm, which has been assigned to A_{1g} mode of Cu_4O_3 [19], [22]. Its intensity increases with the increase of oxygen flow rate while the bands related to Cu_2O decrease progressively. Hence, these Raman spectra clearly evidence that the films deposited with 15-18 sccm range are biphase $Cu_2O + Cu_4O_3$, and that the fraction of Cu_4O_3 can be controlled by adjusting the oxygen flow rate.
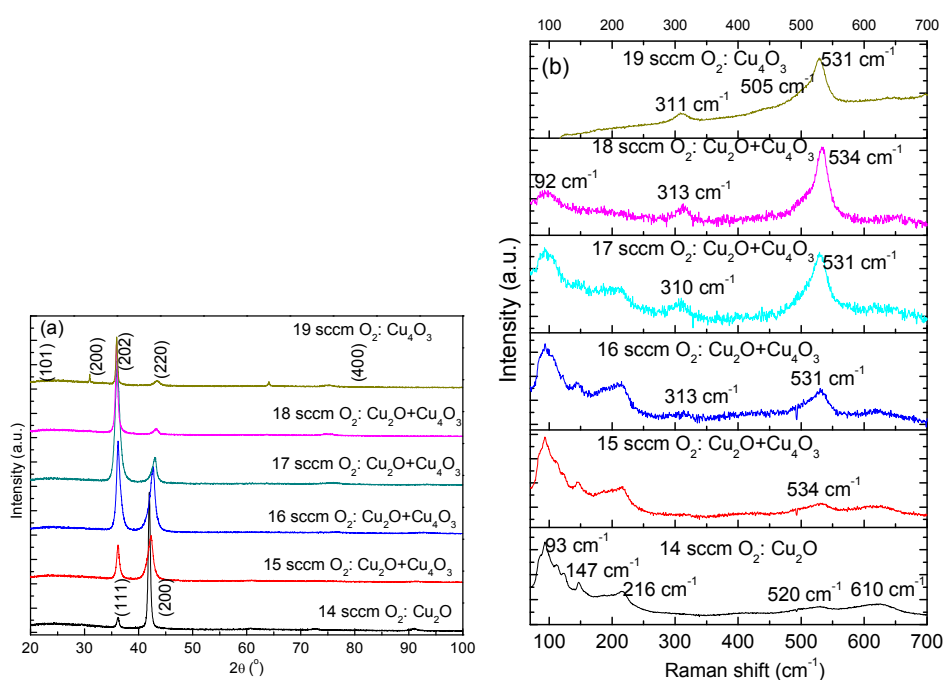
Fig. 4.1   (a) X-ray diffractograms and (b) Raman spectra of copper oxide thin films deposited with different oxygen flow rates.

4.2.2   Cross-sectional microstructure of biphase Cu_2O and Cu_4O_3 thin films

To study the microstructure of the biphase thin films, TEM analyses were carried out firstly in the cross-section. The cross-sectional TEM images of biphase Cu_4O_3 and Cu_2O thin film deposited with 17 sccm O_2 are shown in Fig. 4.2. Electron diffraction pattern on a large area is presented in Fig. 4.2(a), which can hardly distinguish Cu_2O and Cu_4O_3 phases as they exhibit close d values (see Table 1.1). Surprisingly, the dark and bright filed images in Fig. 4.2(a) and (b) show a columnar growth in the growth mode of zone T for this biphase film, and the

columns start from the film/substrate interface to the top of film, which is unusual in sputtered composite thin films. Such growth mode is quite similar with that in single phase Cu_2O and Cu_4O_3 thin films discussed in chapter 3. However, the column width of about 20-40 nm near the top of this biphase film is much smaller than that of 30-70 nm in single phase Cu_4O_3 thin films [22], indicating the existence of competing growth in this biphase thin film. Unfortunately, it is difficult to identify Cu_2O and Cu_4O_3 phases from dark field image by choosing corresponding diffraction spots, as it is hard to distinguish their diffraction spots (see Fig. 4.2(a)).
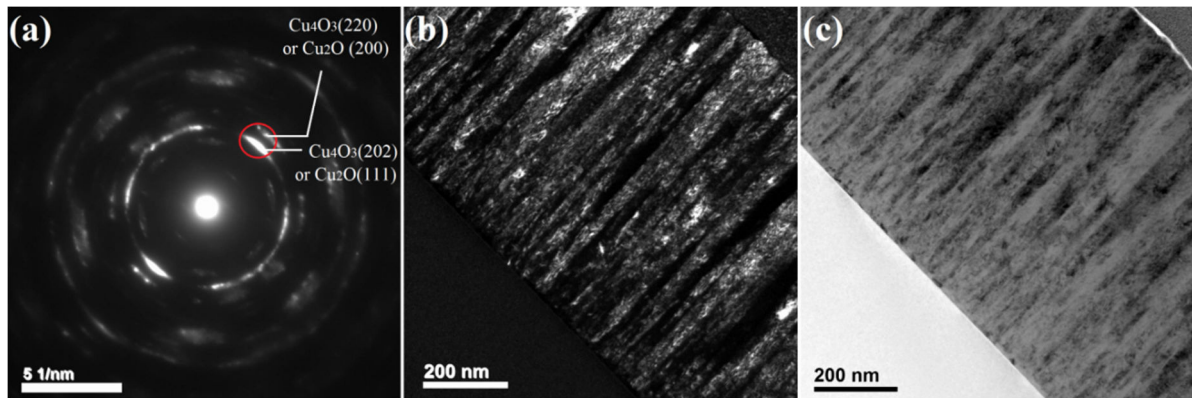
Fig. 4.2   Cross-sectional TEM images of biphase Cu_4O_3 and Cu_2O thin film. (a) Electron diffraction pattern. The red circle represents the selected region for dark field image.   (b) Dark field image. (c) Bright field image.

Furthermore, the microstructure of biphase thin film in the region close to the substrate has been studied by HRTEM, as highlighted in Fig. 4.3(a). Even at the initial growth region, the biphase film still has the columnar microstructure, with the column width of less than 10 nm. The FFT analyses along the column growth direction have been performed. Fig. 4.3(b), (c) and (d) show the FFT patterns of square regions named as 1, 2 and 3 in Fig. 4.3(a), respectively. It appears that d values of about 2.1 Å have always been observed in Fig. 4.3(b), (c) and (d) along the column growth direction. Due to the precision of electron diffraction, this d value of 2.1 Å could come from either Cu_2O (200) or Cu_4O_3 (220) planes. However, it is difficult to identify its real origin, as the information in these patterns is not sufficient to determine the phase structures. Whatever the crystalline phases, these patterns clearly

demonstrate that the columns have almost the same growth orientation along the film thickness.
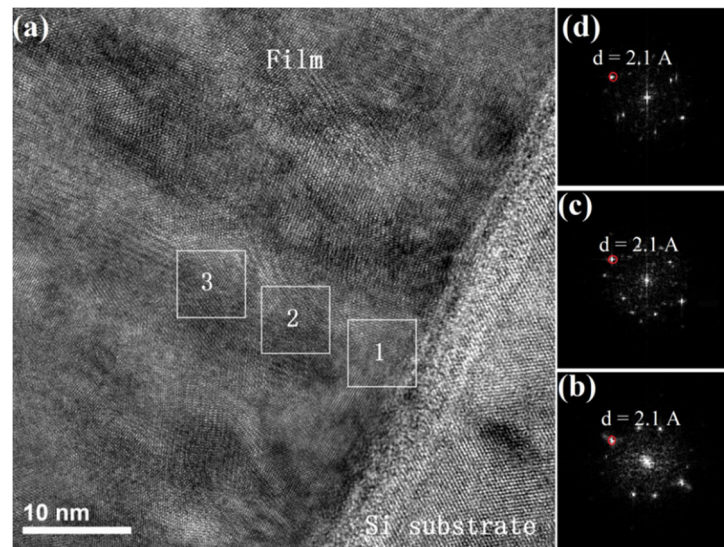
Fig. 4.3　(a) HRTEM image of biphase thin film deposited with 17 sccm O_2 at the initial growth region. Along the column growth direction, three square regions are marked as 1, 2 and 3. (b), (c) and (d) are the FFT patterns of square regions 1, 2 and 3 in (a), respectively. The red circles in (b), (c) and (d) represent the diffraction spots along the column growth direction, with the *d* values of about 2.1 Å.

Similar situations have been observed in columns with growth orientation of Cu_2O <111> or Cu_4O_3 <101>, as shown in Fig. 4.4. Fig. 4.4(a) is the HRTEM image close to the substrate, while Fig. 4.4(b), (c) and (d) are the FFT patterns of square regions marked as 1, 2 and 3 in Fig. 4.4(a). *d* values of about 2.4 Å in Fig. 4.4(b), (c) and (d) belong to Cu_2O (111) or Cu_4O_3 (202). Hence, the columnar microstructure in the biphase thin film is formed at the initial growth, and the columns have almost the same growth orientation along the film thickness. To be pointed out here, the FFT patterns in Fig. 4.3 and 4.4 are typical in polycrystalline thin films, which originate from the characteristics of small column width and fiber texture. The thickness of the TEM foil is estimated to be about 50-70 nm by valence electron energy loss spectroscopy, much larger than the column width near the substrate, which indicates that there are several columns along the TEM thin foil thickness direction at the interface region. Besides, the fiber texture observed in single phase Cu_2O or Cu_4O_3 thin films, may exist in this biphase thin film. Hence, several columns with some rotational degree of freedom around the fiber axis will result in poor diffraction spots.
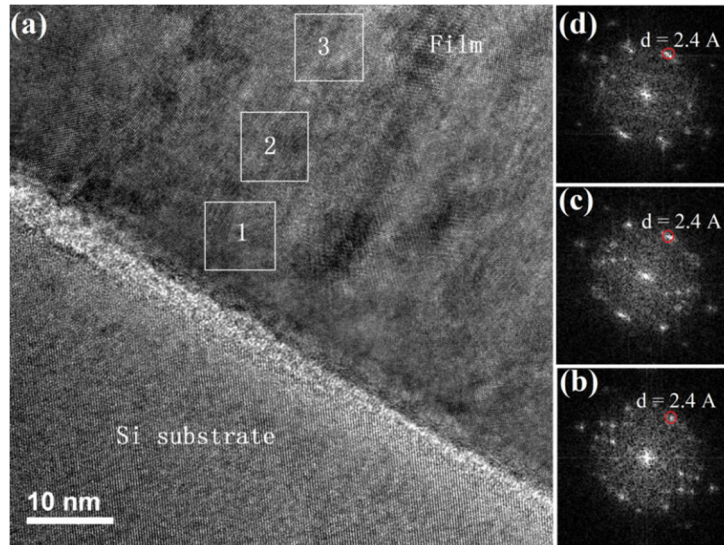
Fig. 4.4 (a) HRTEM image of biphase thin film deposited with 17 sccm O_2 at the initial growth region. Along the column growth direction, three square regions are marked as 1, 2 and 3. (b), (c) and (d) are the FFT patterns of square regions 1, 2 and 3 in (a), respectively. The red circles in (b), (c) and (d) represent the diffraction spots along the column growth direction, with the d values of about 2.4 Å.

Finally, an amorphous layer between the crystalline substrate and the copper oxide films is clearly evidenced in Figs. 4.3 and 4.4. This amorphous layer with the thickness of 3 − 5 nm corresponds to the native silicon oxide layer that has not been removed before the film deposition. Since the columnar microstructure is observed on the native silica layer, it can be concluded that the crystalline structure of silicon does not promote the growth of the films. Hence, this unique microstructure is also expected to be encountered using a glass substrate.

4.2.3 Top-view microstructure of biphase Cu_2O and Cu_4O_3 thin films

To capture the microstructure of the biphase thin film unambiguously, TEM investigations have also been performed in the top-view specimen. Electron diffraction patterns have been recorded from a lot of grains, and typical patterns are shown in Fig. 4.5. Fig. 4.5(a) is the bright field image, where the estimated grain size of about 20-40 nm is consistent with the column width in cross-sectional micrographies. In Fig. 4.5(a), grains referred as # 1, 2, 3, and 4 have been marked by circles. Fig. 4.5(b) and (c) are the selected area electron diffraction

(SAED) patterns of grains # 1 and 2, respectively, which clearly shows that these two grains are single crystal Cu_4O_3. Since the zone axis of grains # 1 and 2 are different, there is no in plane orientation of Cu_4O_3 grains. The SAED pattern of grain # 3 is presented in Fig. 4.5(d), which is the characteristic of Cu_2O. As the grain size is too small, some additional diffraction spots situated around the primary spots of single crystal Cu_2O have been observed. Then, the convergent beam electron diffraction (CBED) has been performed to the quite small grain # 4 and the pattern (see Fig. 4.5(e)) clearly manifests that this small grain is single crystal Cu_2O. A lot of single crystal grains have been selected to perform electron diffraction. Cu_4O_3 grains exhibit the zone axes of [101], [110], [100], and [-13-1], while all the measured Cu_2O grains have the zone axis of [111]. The single crystal characteristic has also been confirmed by the HRTEM images. As shown in Fig. 4.6, a single crystal Cu_2O grain is clearly evidenced by the FFT pattern.
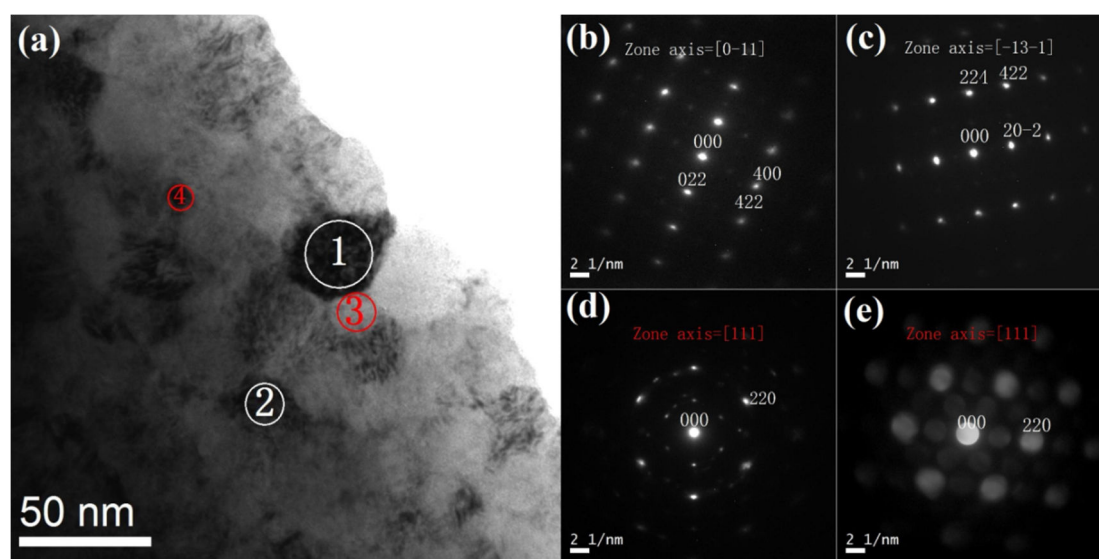
Fig. 4.5   Top-view TEM images of biphase Cu_4O_3 and Cu_2O thin film with 17 sccm O_2. (a) Bright field image. (b), (c) and (d) are the SAED patterns of grains #1, #2 and #3 in Fig. 5(a), respectively. (e) The CBED pattern of grain #4.
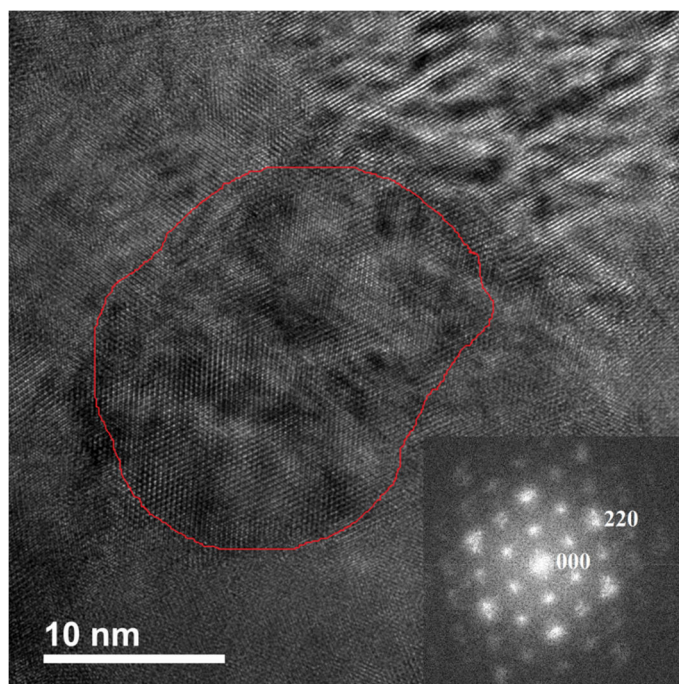
Fig. 4.6   Top-view HRTEM image of biphase Cu_4O_3 and Cu_2O thin film with 17 sccm O_2. The inset shows the FFT pattern of the selected Cu_2O grain marked by red line.

4.2.3   Discussion on the vertically aligned columnar growth mechanism

The above TEM micrographies from cross-section and top-view indicate an unusual microstructure in biphase Cu_4O_3 and Cu_2O thin films where the two phases grow independently in columnar shape. Such a microstructure is strongly different from the traditional concept that one phase is embedded into the second one that acts as matrix. Hence, the schematic microstructure of this biphase thin film is depicted in Fig. 4.7; for simplicity, we show an ordered arrangement of phases. As shown in Fig. 4.7, both phases just grow separately and independently with the columnar microstructure along the whole film thickness. This kind of unusual growth can be understood from the viewpoint of Cu_2O local homoepitaxial growth behavior reported in Chapter 3. In reactively sputtered growth of Cu_2O thin films, the Cu_2O seed layer has a strong driving force to promote the subsequent growth with the same growth orientation, independently of the deposition conditions [21]. Therefore, in this biphase thin film, the growth process can be assumed: (1) due to intermediate oxygen flow rate between those required to grow single phase Cu_2O and Cu_4O_3, some Cu_2O nucleus are formed; (2) the strong driving force resulting from the local epitaxial growth induces a

selective formation of Cu_2O on the nucleus with the same structure; (3) the local decrease of the oxygen concentration induces a segregation of oxygen adatoms towards columns with higher oxygen concentration that crystallizes in the Cu_4O_3 structure. Consequently, Cu_4O_3 and Cu_2O phases with columnar structures grow independently.
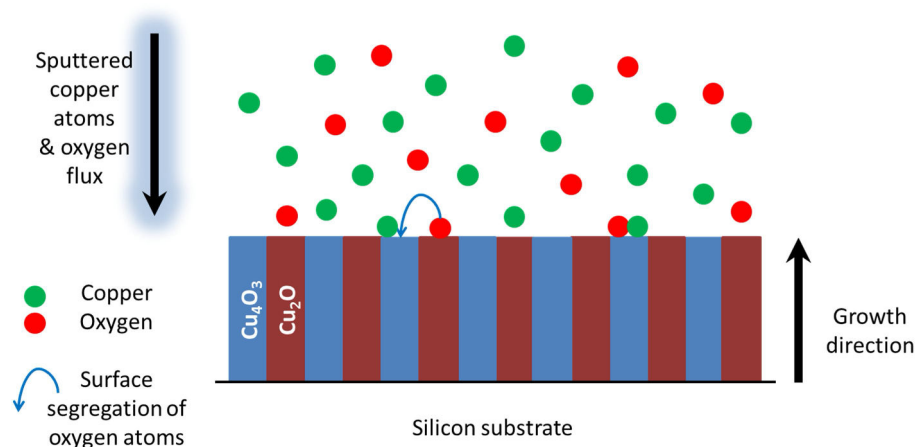
Fig. 4.7 Schematic microstructure of the biphase Cu_4O_3 and Cu_2O thin film. For simplicity, we show an ordered arrangement of phase.

As reported in Chapter 3, the oxygen flow rate allows to tune the phase structure of copper oxide films. The increase of the oxygen flow rate induces the deposition of Cu_2O, Cu_4O_3 and CuO. Moreover, between these single phases, biphase $Cu_2O + Cu_4O_3$ and $Cu_4O_3 + CuO$ films can also be synthesized. The structure and the microstructure of $Cu_4O_3 + CuO$ films have also been studied by XRD, Raman and TEM. Films deposited with 21 sccm O_2 are X-ray amorphous (Fig. 4.8(a)), but Raman analyses clearly evidence the existence of Cu_4O_3 A_{1g} mode close to 532 cm^{-1} and CuO A_g mode at about 288 cm^{-1} (Fig. 4.8(b)) [19], [22]. Compared to $Cu_2O + Cu_4O_3$ biphase films, the $Cu_4O_3 + CuO$ biphase film shows different microstructure. The cross-sectional TEM images demonstrate that the columnar growth in biphase $Cu_4O_3 + CuO$ thin film is not clear (see Fig. 4.9). Besides, the electron diffraction pattern in Fig. 4.9(a) does not exhibit preferred orientation along film thickness, which is different from that in $Cu_2O + Cu_4O_3$ biphase films. Moreover, the top-view electron diffraction patterns can hardly identify the single crystal features of grains. Hence, the vertically aligned columnar growth mechanism is not encountered in this biphase $Cu_4O_3 +$

CuO film anymore. This result can also be explained by taking into account the local homoepitaxial growth effect. Indeed, the texture of CuO films is mainly governed by the oxygen partial pressure. Thus, a local change of the oxygen concentration induces a change of the CuO preferred orientation that comes with a nucleation of a new grain without structural relationship with the previous one. Consequently, there is no local homoepitaxial growth behavior in this oxide. In the case of Cu_4O_3 phase, the [101] orientation deposited at 0.5 Pa does not allow the local homoepitaxial growth effect. Considering the occurrence of local homoepitaxial growth effect in Cu_2O thin films, the vertically aligned columnar growth mechanism in biphase Cu_2O + Cu_4O_3 films can be well described, while this growth mechanism does not exist in biphase Cu_4O_3 + CuO ones. Within this discussion, it is believed that this vertically aligned columnar growth can also be extended to other materials with certain requirements summarized as below:

- The system has to contain at least two stable or metastable phases,

- Each phase has to be deposit in crystalline form within the deposition conditions,

- The growth rate of each phase has to be close. Within the Cu-O system, the growth rate of Cu_2O is close to that of Cu_4O_3, while that of CuO is relatively low (poisoning effect of the target) [22], [29],

- At least one phase should be grown independently with a local epitaxial growth mechanism,

- The chemical compositions of the phases must be close, in order to allow the segregation of one adsorbed element on the growing surface.
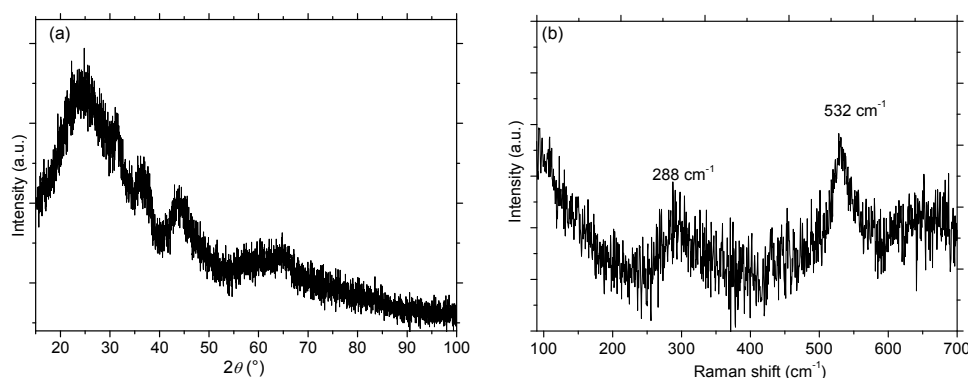
Fig. 4.8   (a) X-ray diffractogram and (b) Raman spectrum of biphase Cu_4O_3 + CuO film.
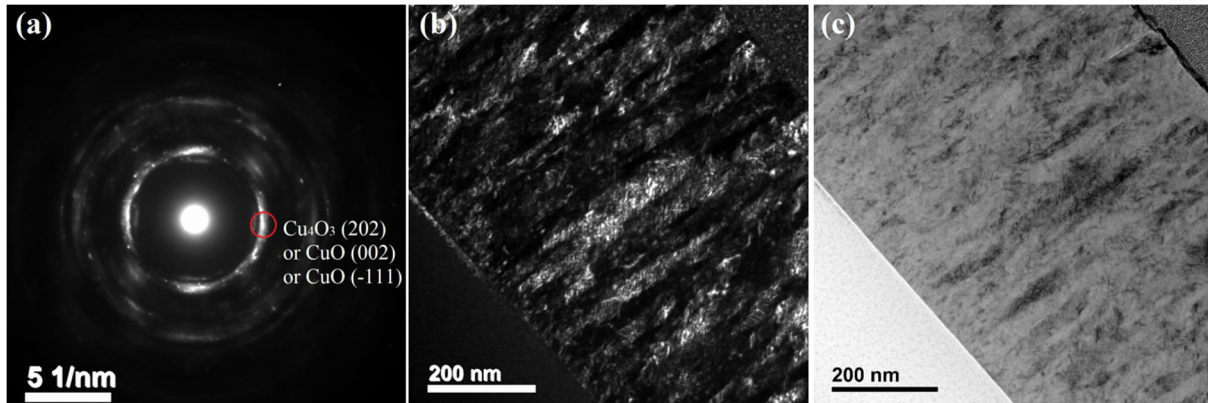
Fig. 4.9 Cross-sectional TEM micrographies of biphase Cu_4O_3 and CuO thin film. (a) Electron diffraction pattern. The red circle represents the selected region for dark field image. (b) Dark field image. (c) Bright field image.

4.3 Electrical properties of biphase Cu_2O + Cu_4O_3 thin films

The room temperature resistivity of copper oxide thin films as a function of oxygen flow rate is depicted in Fig. 4.10, which clearly reveals that the biphase thin film has lower resistivity than single phase films. This result is in agreement with that reported by Meyer et al. [8]. Since these thin films are deposited at room temperature, the hole mobility is extremely low and it is difficult to determine the carrier concentration by Hall effect measurements. For the single phase Cu_2O or Cu_4O_3 thin films, the room temperature resistivity decreases with the increase of oxygen flow rate (see Fig. 4.10), which could be qualitatively understood from the defect mechanism. Taking Cu_2O as an example, copper vacancy (V'_{Cu}) is the predominant defects to produce the hole carriers, while the formation energy of copper vacancy decreases in the oxygen rich conditions (higher oxygen flow rate) [41], [42], [56]. Then the lower resistivity of single phase Cu_2O thin films with higher oxygen flow rate can be interpreted from its larger carrier concentration due to the reduction of copper vacancy formation energy. In the case of biphase Cu_2O and Cu_4O_3 thin film, the oxygen flow rate is higher than that required to synthesis the single Cu_2O phase. Thus the Cu_2O columns may have higher carrier concentrations. In contrast, the Cu_4O_3 columns may have lower carrier concentration as the oxygen sub-stoichiometry. Consequently, the columns with different carrier concentration (high carrier concentration and low carrier concentration)

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arrange randomly, and their interface coupling may play a role for this kind of lower resistivity. Further investigations are required to clarify this unusual phenomenon.
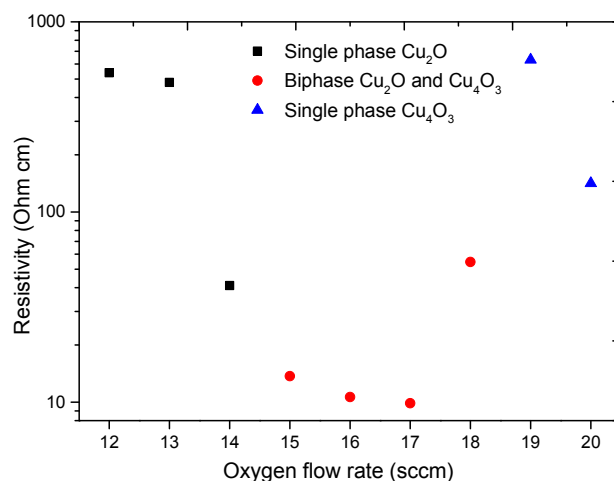
Fig. 4.10 Resistivity of copper oxide thin films as a function of oxygen flow rate.

4.4 Chapter Conclusions

Biphase Cu_2O and Cu_4O_3 thin films have been characterized by TEM from cross-section and top-view, which shows an unusual microstructure that both phases have the vertically aligned columnar growth along the whole film thickness direction. This microstructure may result from the local homoepitaxial growth of Cu_2O. The intermediate oxygen flow rate between those required to grow single phase Cu_2O and Cu_4O_3 produce some Cu_2O nucleus, and then the strong driving force resulting from the local homoepitaxial growth induces a selective formation of Cu_2O on the nucleus with the same structure, giving rise to this kind of unusual vertically aligned columnar microstructure. The lower resistivity has been observed in the biphase thin films, which may be due to the interface coupling between Cu_2O and Cu_4O_3 columns. Such a unique microstructure has not been observed in Cu_4O_3 + CuO films. This negative result may come from the lack of local epitaxial growth mechanism in single CuO films. Finally, some requirements for the self-aligned columnar nanocomposite thin films on unmatched substrates have been proposed.

Chapter 5   Optical properties and electronic structure of copper oxide thin films

5.1   Introduction

Although the stable phase of Cu_2O and CuO have been widely studied for the past three decades both experimentally [8], [29], [130]–[134] and theoretically [2], [24]–[26], [42], [56], [135], [136], there are still divergent reports regarding their electronic structure. For instance, different calculation methods have precisely predicted the direct band gap of about 2 eV in Cu_2O, but their ground-state electronic structure and band ordering exhibit striking discrepancies [24], [26], [136]. In the case of CuO, the type of band gap (direct or indirect) remains controversial [5], [32], [33], [132], [134], [135], while the valence band density of states (DOSs) calculated by different methods show notable difference [25], [33], [135]. On the other hand, the meta-stable phase Cu_4O_3 (paramelaconite), an intermediate compound between Cu_2O and CuO, has received less attention [22], [25], [28], [29], [31], giving rise to a mysterious veil. Local density approximation (LDA) with an additional potential U and Heyd-Scuseria-Erzerhof (HSE) functionals have been employed to calculate its electronic structure, whereas the resulting band gaps and DOSs are ambiguous [25], [28]. Besides, to the best of our knowledge, little is known about electronic structure of Cu_4O_3 from an experimental point of view.

Since the applications of copper oxides for energy conversion are closely linked to electronic structure, their unclear properties will restrict further developments. Hence, it is of great interest to investigate their electronic structure by a joint experimental and theoretical study. Photoemission spectroscopies with different photon energies are well-known technologies to determine the valence band electronic structure via the measurement of kinetic energy spectra of emitted photoelectrons by the photoelectric effect. On the other hand, the optical band gap is usually estimated by spectrophotometry from transmission (T) and

reflectance (R) measurements, which possesses higher precision and convenience than other optical methods, e.g., ellipsometry, especially with the presence of sub-gap absorption, as it does not require complex fitting. In the case of conduction band structure, electron energy loss spectroscopy (EELS) has rapidly grown to be a useful technique to study the unoccupied electronic states, as its great advantages of large penetration depth and high spatial resolution. For the EELS measurement, electrons are ejected from core states to unoccupied states [83], which provides the basis for a comparison between experimental empty states and theoretical conduction band states, within the consideration of dipole selection rules.

Many-body perturbation theory in the GW (Green's function calculations with screened Coulomb interaction W) approximation has emerged as a standard computational tool to predict the electronic structure of semiconductors and insulators, yielding systematical improvements with respect to other methods [24], [26], [137]–[139]. Although various GW schemes have been introduced and contested for transition metal (TM) oxides, a single universal scheme that can describe the band structure reliably for a wide range of TM oxides, is not yet available. Recently, a GW scheme with local-field effect and an empirical on-site potential for TM d orbitals with a single parameter per TM cation (noted as $GW^{LF} + V_d$), has been proposed, which allows for reasonably predictive band gaps for different oxide stoichiometries and TM oxidation states at an acceptable computational expense [24]. However, the band gap is just one characteristic of electronic structure of a semiconductor or insulator, which does not contain sufficient information to conclude the whole electronic structures.

In this work, the influence of air annealing effect on the optical and electrical properties of Cu_2O thin films has been studied in a first step. Then, we have investigated the electronic structure of Cu_2O, Cu_4O_3 and CuO from experiments and theoretical calculations. The optical band gap, full DOSs in the valence band and partial DOSs in the conduction band are determined by optical absorption, UPS and EELS spectroscopies, respectively. Meanwhile the electronic structures and absorption coefficients calculated by $GW^{LF} + V_d$ approach, are compared with experimental results and other reported calculations.

5.2 Transmittance enhancement and optical bandgap widening of Cu_2O thin films after air annealing

5.2.1 Phase structure evolution

X-ray diffractograms of as-deposited and air annealed Cu_2O thin films deposited on glass substrates are shown in Fig. 5.1 (a). The annealing duration has been fixed to 1 hour. When the annealing temperature is lower than 300 °C, only Cu_2O diffraction peaks are evidenced, indicating that these thin films remain single phased. Once the temperature is equal or higher than 300 °C, weak CuO diffraction peaks are observed. This result confirms that the temperature to oxidize Cu_2O into CuO in air is about 300 °C, which is consistent with earlier reports [29], [76]. Raman analyses (not shown here) have verified the phase structures of thin films. The magnified (200) diffraction peaks of Cu_2O thin films are depicted in Fig. 5.1 (b). A gradual shift towards higher angle values with increasing annealing temperature is evidenced. Without considering the internal stress effect on the diffraction peak position, this behavior may come from the decrease of the lattice constant from 0.43041 nm (as-deposited) to 0.43019 nm (180 °C), 0.42937 nm (260 °C), 0.42844 nm (280 °C), 0.42801 nm (300 °C), and 0.42800 (320 °C). In comparison with the lattice constant of bulk Cu_2O (0.427 nm), the shrinkage of lattice constant is due to the removal of some structural defects. X-ray diffractogram of the Cu_2O thin film annealed in vacuum at 200 °C (not shown here) indicates that the film still has the single phase structure with the lattice constant of 0.43216 nm.
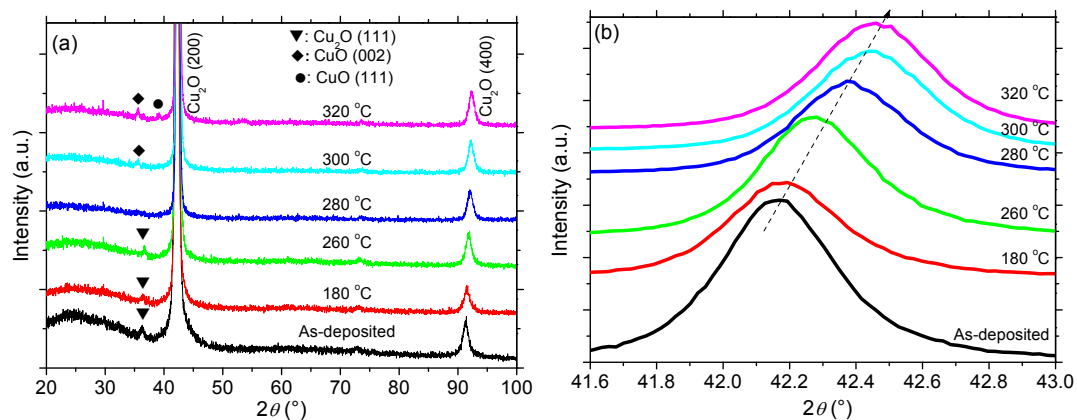
Fig.5.1 (a) X-ray diffractograms of as-deposited and air annealed Cu_2O thin films. (b) Magnified (200) diffraction peaks of Cu_2O thin films.

5.2.2 Transmittance enhancement of air annealed Cu₂O thin films

The transmittance spectra from 450 to 800 nm for Cu_2O thin films annealed in air are shown in Fig. 5.2, which clearly proves that the annealing process can enhance the transmittance in the low wavelength range (550 nm and below) when the films are single-phased. Once the annealing temperature exceeds 300 °C, the formation of CuO phase is accompanied by a decrease of the transmittance, due to its lower optical band gap [76]. Since the amount of CuO formed at 320 °C is higher than at 300 °C (higher diffraction peak intensity as shown in Fig. 5.1(a)), the optical transmittance of film annealed at 320 °C is reduced further.
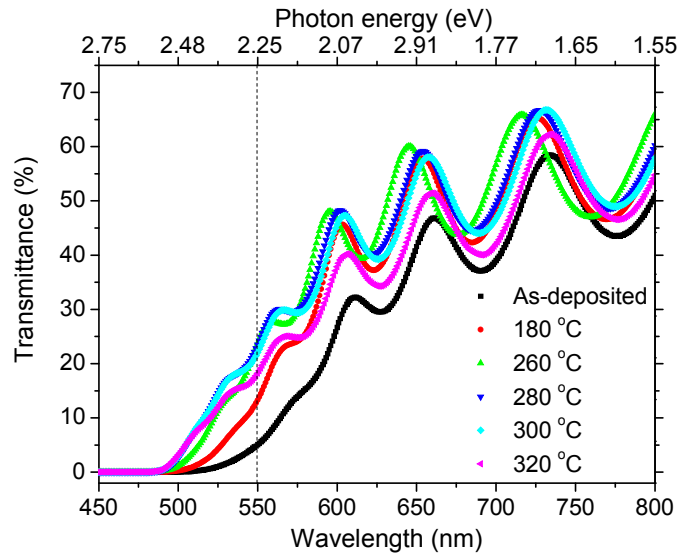
Fig. 5.2   Optical transmittance spectra of the as-deposited and air annealed Cu_2O thin films with the thickness of 820 nm.

To investigate the mechanism at the origin of this optical transmittance enhancement, the transmittance of Cu_2O thin film annealed in vacuum at 200 °C (10^{-4} Pa) has also been measured as a reference (Fig. 5.3). Since the vacuum annealing does not influence the absorption threshold, the transmittance enhancement observed after annealing in air at 180 °C clearly evidences the critical role played by oxygen in transmittance enhancement. The annealing in air at high temperature may remove some defects (consistent with the decrease of lattice constant), especially the oxygen vacancies, reducing thus the defect scattering and then

increasing the transmittance [140]. As shown in Fig. 5.3, the vacuum annealing is not effective to enhance the transmittance, which may originate from the oxygen vacancy creation or oxygen out-diffusion during the heating in the vacuum atmosphere. The electrical properties Cu_2O thin films have been also measured (see Table 5.1), and the film annealed in vacuum has a larger resistivity. This result confirms the assumption that vacuum annealing yields the formation of much more oxygen vacancies.
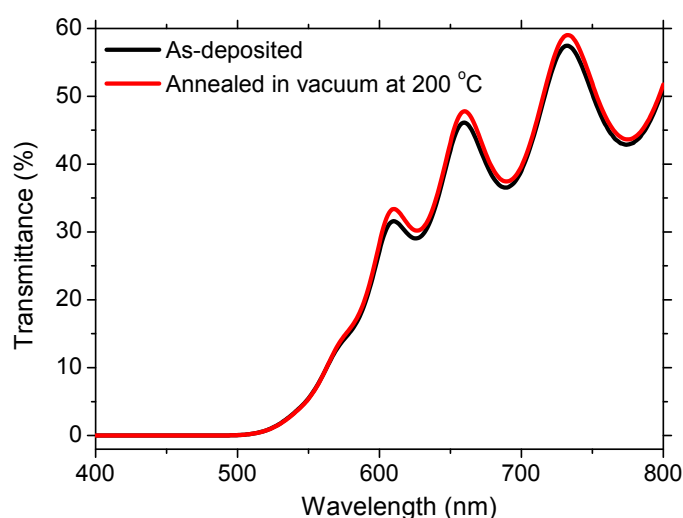
Fig. 5.3   Optical transmittance spectra of as-deposited and vacuum-annealed Cu_2O films.

Table 5.1   Properties of the as-deposited and annealed Cu_2O thin films. +: It is not reasonable to fit the optical band gap or calculate the band tail width for the biphase films. ++: The low mobility is out of the detection ability of the Hall measurement system.

Samples	Optical band gap (eV)	Urbach energy (eV)	Resistivity (Ω cm)	Mobility (cm²/Vs)	Carrier concentration (cm⁻³)
As-deposited	2.38	0.25	490	++	++
Air-180 °C	2.46	0.19	61.8	++	++
Air-260 °C	2.49	0.17	12.5	0.69	7.12×10^{17}
Air-280 °C	2.51	0.14	7.32	2.67	3.19×10^{17}
Air-300 °C	+	+	7.78	3.16	2.54×10^{17}
Air-320 °C	+	+	10.4	7.6	8.30×10^{16}
Vacuum-200 °C	2.38	0.25	549	++	++

Another possible mechanism that can improve the transmittance properties is the reduction of grain-boundary scattering linked to the larger grain size of film annealed at high temperature. Generally, the transmittance related with grain-boundary scattering in polycrystals is affected by the porosity, growth orientation and grain size [141]. A low porosity means little scattering at pores. As the refractive indexes are dependent with grain orientations in some materials, the refraction at the grain boundaries with different growth orientations will enhance, consequently the reduction of transmittance. Besides, at a given sample thickness, the small grain size will decrease the transmittance, as the light has to pass an increasing number of grain boundaries. However, in our case, the dense Cu_2O thin films with <100> preferred growth orientation have the columnar growth in Zone T and the columns extend along the whole film thickness direction. The density of Cu_2O thin film has been measured by X-ray reflectivity and the relative density (the ratio of experimental and theoretical densities) is about 99.7%, which indicates that there is little pore scattering in Cu_2O thin films. These Cu_2O thin films are highly <100> textured, so the orientation-dependent refraction at the grain boundaries is small. The columnar growth means the intrinsic quantity of the grain boundary scattering interfaces along the film thickness direction is also low. So the transmittance related with grain-boundaries scattering in these Cu_2O thin films is limited. The full width at half maximum (FWHM) of (200) diffraction peaks of single phased Cu_2O thin films are 0.397° (as-deposited), 0.386° (annealed in air at 180 °C), 0.385° (annealed in air at 260 °C), 0.374° (annealed in air at 280 °C). This small evolution of FWHMs indicates a little increase of the grain size, and this evolution is mainly due to the coalescence of the grains. This small increase of grain size may reduce the scattering at the grain boundaries and increase the transmittance, but the role of this effect is quite small as the low amount of grain boundary scattering in this kind of Cu_2O thin films.

5.2.3 Band gap widening of air annealed Cu_2O thin films

As shown in Fig. 5.2, an obvious blue-shift of absorption edge appears with increasing annealing temperature for Cu_2O thin films with single phase, which seems to indicate that the

optical band gap (E_g) enlarges after annealing in air. For Cu_2O, a semiconductor with a direct forbidden gap, earlier theories deem that a linear fit on a plot of $(\alpha E)^{2/3}$ vs. E would be reasonable to obtain the optical band gap, where α is the absorption coefficient and E is the photon energy [142]. Recent results show that the exponent value of 2/3 is also not as quite reliable as expected to determine the gap in Cu_2O [143]. In the present work, the linear fit on a plot of $(\alpha E)^2$ is still used, which is employed by most of the works dedicated to Cu_2O. The value of α is determined by transmittance (T) and reflectance (R). Fig. 5.4 shows the $(\alpha E)^2$ vs. E curves of the as-deposited and air annealed thin films that crystallize in the Cu_2O single phase. The optical band gap of Cu_2O thin films is in the range of 2.38-2.51 eV, which is consistent with the theoretical calculation value of 2.5 eV [25]. For a single phase Cu_2O film, the increase of the annealing temperature induces larger optical band gap values. In Cu_2O, the direct transition between valence band maximum (VBM, $\Gamma_{25'}$) and first conduction band minimum (CBM, Γ_1) is forbidden and the transition from VBM to the second CBM ($\Gamma_{12'}$) is allowed [24]. Thus, the measured optical band gap corresponds to the energy gap between the VBM and the second CBM.
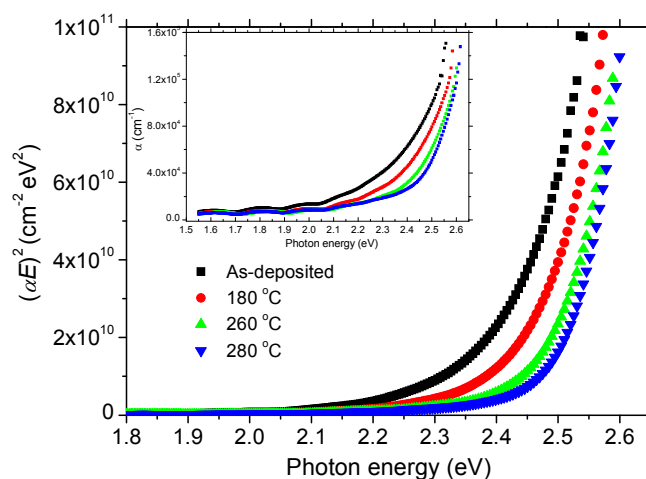
Fig. 5.4   Plot of $(\alpha E)^2$ vs. E for as-deposited and annealed Cu_2O thin films with single phase. The inset shows the absorption coefficient α.

Since the copper vacancy is thought to be the main origin for holes in Cu_2O, an annealing in air induces the partial removal of copper vacancies and a decrease of the carrier concentration (Table 5.1). These results show an unusual phenomenon in Cu_2O: the optical

band gap becomes wide while the carrier concentration decreases. The absorption coefficient (shown in the inset of Fig.5.4), obtained in this study or reported by Malerba et al. [143], always shows a non-zero value below the gap, indicating the presence of subgap absorption in Cu_2O thin films. Therefore, one of the possible mechanisms for the optical band gap widening is that the merging of defect states and bands produce band tails and, the thermal annealing in air can relieve part of the band tails. Based on this, the assumed schematic band structures of the as-deposited and air annealed films are shown in Fig. 5.5. For the as-deposited thin films, the defect levels with large density of states merge with each other to engender the defect band that is also expected to merge with the valence band to form a band tail, yielding a narrowing of the optical band gap (see Fig. 5.5(a)). After thermal annealing in air, parts of the defects are removed or suppressed, resulting in an enlargement of the measured optical band gap (see Fig. 5.5(b)). As shown in the inset of Fig. 5.4, it appears that the subgap absorption of Cu_2O thin film annealed at 280 °C is still large, which demonstrates the defect states are still of high density. In order to verify this assumption, the Urbach energy (E_u), which describes the width of the absorption tail, has been calculated using a linear portion of $\ln\alpha(E)$ below the optical band gap using the following expression [144]

$$E_u = \left[\frac{d\ln\alpha(E)}{dE} \right]^{-1} \tag{5-1}$$

The Urbach energy of single phased Cu_2O thin films is presented in Table 5.1, which clearly shows that the optical band gap increases with decreasing Urbach energy. These results support our argument that the optical band gap widening of air annealed Cu_2O thin films could be due to the reduction of the band tail.

Since the Cu_2O film annealed in air at 280 °C has less defect states than other single phased thin films, its optical band gap should be much more close to the ideal value. Considering that the energy difference between the first CBM and the second CBM is 0.45 ~ 0.51 eV, [24], [53], [55], [145], the room temperature band gap between VBM and the first CBM is estimated to be 2.00 ~ 2.06 eV, which agrees well with the theoretical calculation value of 2.03 eV [25].
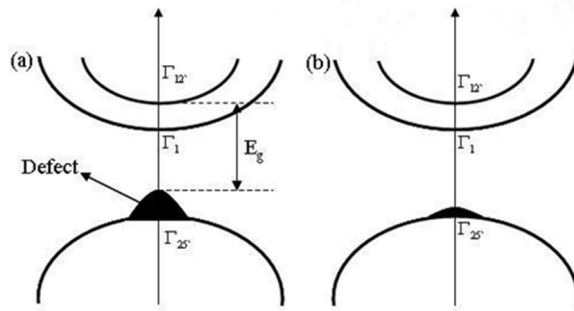
Fig. 5.5 The assumed schematic band structures of as-deposited (a) and air annealed (b) Cu$_2$O thin films.

5.2.4 Photoluminesence analyses on Cu$_2$O thin films

The defect information obtained by previous photoluminescence (PL) measurements in Cu$_2$O is controversial with recent first-principle calculations. Therefore the PL spectra of Cu$_2$O thin films have been measured to make a preliminary discussion combining experimental results with recent calculations. Fig. 5.6 shows the PL spectra of as-deposited and annealed Cu$_2$O thin films on glass substrates measured at 5 K. Several wide peaks have been observed above 2 eV. The peak near 3.1 eV (E(Γ−M)) is the recombination of the interband transition between Γ and M points [25], [55]. The peak at about 2.3 eV (E$_G$) is related with green exciton, while 2.18 eV (2pE$_Y$) and 2.02 eV (1sE$_Y$) peaks are 2p and 1s yellow excitons, respectively [54], [55]. The sharp peak at about 1.9 eV is the second order of the laser beam. The peak near 1.7 eV is a defect peak, but its origin is still debated. Previous experimental results showed that this peak can be due to the recombination of exciton bound to double charged oxygen vacancy (V_O^{2+})[8], [53]–[55]. These authors also claim that there are two other peaks at about 1.35 eV and 1.53 eV related with copper vacancy (V_{Cu}^-) and single charged oxygen vacancy (V_O^+), respectively. However, recent theoretical results obtained by several groups using different calculation methods tend to show that the oxygen vacancy in Cu$_2$O is only stable in the neutral (V_O) state [42], [44], [56]. The calculation results make sense as they can explain the impossibility to realize n-type Cu$_2$O. Provided that the single or double positive charged oxygen vacancy indeed exists in Cu$_2$O with high density, it will be

possible to synthesize n-type Cu_2O under oxygen poor conditions, but till now, no sufficient evidence can prove the presence of n-type Cu_2O. So, it seems that the assignments of defect peaks in previous studies should be discussed. In this work, only one defect peak at about 1.7 eV has been evidenced. As the dominant defect in Cu_2O is copper vacancy (0.52 eV above VBM) [52], we assume that the peak at 1.7 eV can be attributed to the recombination of first CBM to V_{Cu}^-. Based on this assumption, the band gap between the VBM and the first CBM may be evaluated to 2.22 eV at 5 K, which is quite close to the experimental value of 2.17 eV at 4 K [23]. Further experimental and theoretical investigations are needed to clarify the origins of defects in Cu_2O.
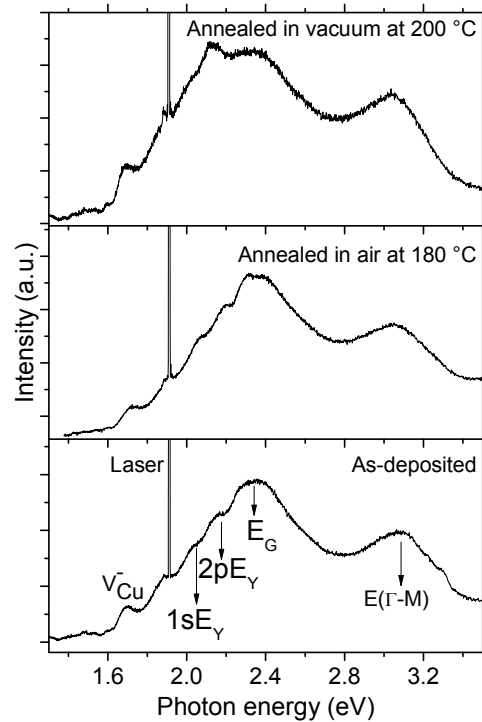
Fig. 5.6   PL spectra of as-deposited and annealed Cu_2O thin films measured at 5 K.

5.3   Electronic structure of binary copper oxide thin films

5.3.1   Band gap

The band gap of Cu_2O has already been widely studied from theoretical calculations and experiments [8], [23]–[25], [27], which gives consistent results that Cu_2O has a

direct-forbidden gap of about 2 eV and a direct optical band gap of approx. 2.5-2.7 eV, as shown in Table 5.2.

Table 5.2 The band gap energies (in eV) of Cu_2O, Cu_4O_3 and CuO obtained from $GW^{LF} + V_d$ calculations and experiments. The direct (d) or indirect (i) nature of the gap (E_g) has been noted. E_{abs} is the absorption threshold energy for direct and allowed optical transitions, which is determined from the calculated absorption coefficient α somewhat arbitrarily at $\alpha = 10^3$ cm^{-1}. E_{abs}^* is the experimental optical absorption threshold energy, which is identified from the first-order derivation.

	$GW^{LF} + V_d$ cal.		Exp.
	E_g	E_{abs}	E_{abs}^*
Cu_2O	2.03 (d) [24]	2.7 (d) [24]	2.5 [27]
Cu_4O_3	0.84 (i)	1.59 (d)	1.37
CuO	1.2 (i)	1.48 (d)	1.5

Fig. 5.7 shows the absorption coefficient (α) of Cu_4O_3 attained by optical measurements and GW calculation here, as well as by ellipsometry (Meyer et al. [8]). The calculation predicts an indirect band gap of 0.84 eV and a direct band gap of 1.59 eV, whereas the absorption becomes appreciable only at photon energies 1.59 eV (see Fig. 5.7 and Table 5.2). Checking the details of experimental optical absorption spectrum from transmittance and reflectance measurements in Fig. 5.7, it is found that the spectrum can be divided into two parts, as the red dash lines marked: when the photon energy is larger than 1.37 eV, the absorption coefficient increases sharply with increasing photon energy; below 1.37 eV, the absorption has a tendency to increase, even though there is an interference effect. This experimental absorption spectrum indicates that the optical absorption threshold energy is about 1.37 eV, which is consistent with the theoretical value of 1.59 eV. To be pointed out here, all the calculations here are done for the low temperature antiferromagnetic configurations without the consideration of defects, grain boundaries and magnetic fluctuations, which may affect the optical absorption. However, this behavior is not observed in Cu_4O_3 thin films by Meyer et al. using ellipsometry [8], which may be due to the

elimination of detailed information by the complicated fitting in ellipsometry measurements.
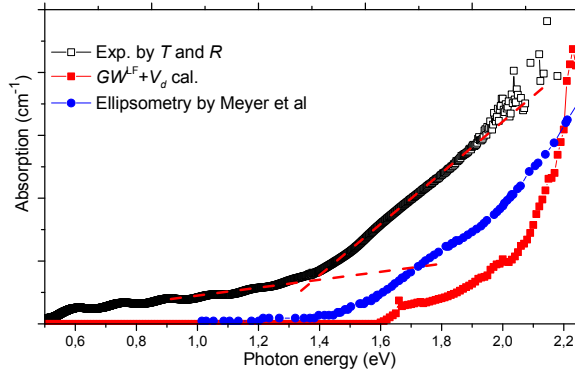
Fig. 5.7 Optical absorption coefficient of Cu_4O_3. The absorption spectrum by ellipsometry is attained from Ref. [8].

The origin of two absorption regions in experimental spectrum remains ambiguous and it could come from a variety of factors. One possible source is the phonon assisted transitions with low intensity. As the indirect band gap of 0.84 eV predicted by the $GW^{LF} + V_d$ calculation is much lower than the direct transition of 1.59 eV, the phonon assisted transitions at room temperature may lead to sub-gap absorption. On the other hand, the d-d and/or s-d excitations, or excitons, could also form sub-gap absorption, even though they have not been reported in copper oxides. Besides, the defect band tail originated the merging of defects may play a limit role for this sub-gap absorption. The defect band tail in Cu_2O has been clearly identified by the analyses of sub-gap absorption (see Fig. 5.5), which is also detected by UPS spectrum with the non-zero states close to Fermi level, e.g., in the energy range of -0.2 − 0 eV, as shown in Fig. 5.8. However, such non-zero state in the energy range of -0.1 − 0 eV is not notable in Cu_4O_3 thin film, indicating less valence band tail than that in Cu_2O thin films. In addition, the rough estimation of Urbach energy 0.77 eV (equal to 56% of the optical absorption threshold energy) contradicts to the well crystallization of Cu_4O_3 thin films, which also demonstrates the limit role of defect band tail. Indeed, the plural mechanisms may make joint contributions to the sub-gap absorption, leading to the difficulty to discuss them seperatedly. It should be noted that we do not care the absolute value of experimental absorption coefficient α in low photon energy range, as the interference effect, the noise of UV-Vis-NIR spectrometer and the

model to calculate α could cause some errors.
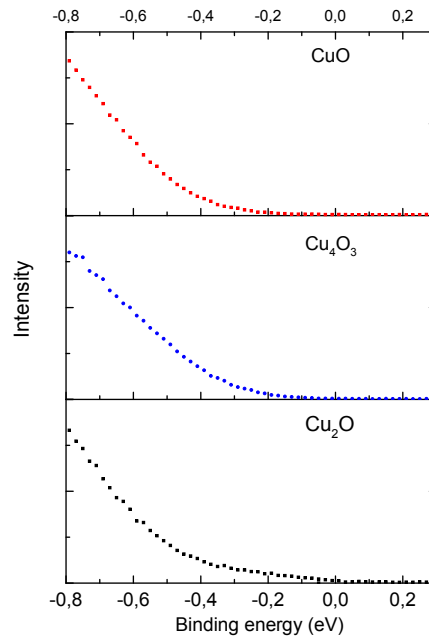
Fig. 5.8   UPS spectra of Cu_2O, Cu_4O_3 and CuO thin films near the Fermi level. Fermi level is set to be zero binding energy.

Moving onto CuO, the experimental and calculated absorption coefficient spectra are shown in Fig. 5.9. An indirect band gap of 1.2 eV and a direct band gap of 1.48 eV have been predicted by the $GW^{LF} + V_d$ approach here (see Table 5.2). As shown in Fig. 5.9, the experimental absorption of CuO thin film also possesses two different regions: the absorption rises up fast as a function of photon energy when the photon energy is over 1.5 eV; for the photon energy between 1.3 eV and 1.5 eV, there is a weak absorption, even within the consideration of interference effect. Such kind of sub-gap absorption has also been observed in single crystal CuO from 10 K and 300 K [134]. The experimental absorption onset energy of about 1.5 eV at room temperature here agrees with the theoretical value of 1.48 eV, as well as other experiments with 1.34 eV in single crystal at 300 K [134]. The UPS spectrum of CuO thin film did not show clear non-zero state in the energy range of -0.2 − 0 eV, as shown in Fig. 5.8, indicating quite a little contribution from the valence band tail. The mechanism of this weak absorption below the threshold energy in CuO thin film is as complicated as that in Cu_4O_3 thin film. Here one more thing should be noted that the gap difference between indirect

band direct band gaps in CuO is much less than Cu_4O_3, which could be a possible source for the different shapes of absorption spectra.
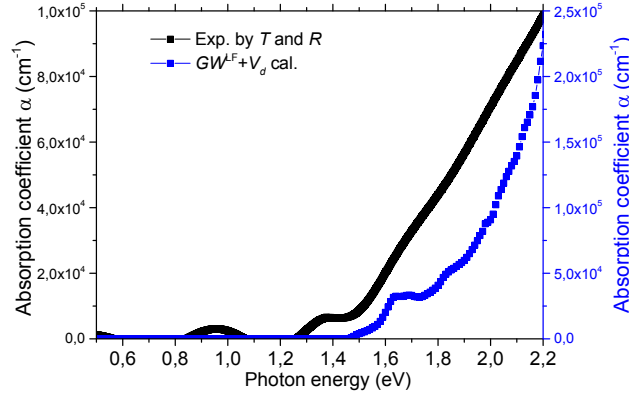
Fig. 5.9 Experimental and calculated absorption coefficient of CuO.

5.3.2   Valence band electronic structure

The p-type conductivity of Cu_2O thin film has been determined by Hall effect measurements (see Table 5.1). Here, Seebeck coefficients of Cu_4O_3 (+102 μV/K) and CuO (+180 μV/K) thin films have been attained, respectively, confirming their p-type conductivity.

The valence band electronic structure has been investigated by XPS and UPS, in comparison with the calculated density of states (DOSs). Before the detailed discussion, it is important to bear in mind that the sensitivity of O $2p$ and Cu $3d$ spectra weight varies a lot in different photoemission sources. Al Kα (1486.7 eV) and He I (21.2 eV) sources have been employed to record the valence band spectra for XPS and UPS, respectively. However, the cross-section ratios of $\sigma(O\ 2p)/\sigma(Cu\ 3d) \approx$ 0.02 and 1.41 for Al K_α and He I, respectively, are determined utilizing the known energy dependence of the photoionization cross section [146]. This means XPS primarily probes the d states, whereas O p and Cu d states are excited with comparable probabilities but more sensitive in O p in UPS.

Fig. 5.10 Experimental valence band spectra and calculated DOSs of Cu_2O. The VBM is set to zero. The theoretical total DOS (in black), O p (in red) and Cu d (in blue) PDOS are convoluted with a Gaussian broadening of 0.4 eV to mimic temperature and instrumental broadening effects. Besides, all DOSs have been normalized to integrate to unity over the valence band. UPS and XPS spectra are plotted in green and magenta, respectively.

The photoemission valence band spectra and the theoretical DOSs of Cu_2O are shown in Fig. 5.10. One can distinguish three energy regions from theoretical DOSs. Between -7 and -5 eV, it is dominated by O $2p$ character. Pronounced Cu $3d$ states are concentrated in the energy range of -4 − -2 eV. While a hybridization between Cu $3d$ and O $2p$ with close intensity, is spread from -2 to 0 eV. As shown in Fig. 5.10, the shape of total DOS is in accordance with the UPS spectrum. Considering that the calculated DOS is k point integrated, whereas the experimental curve is not [147], the overall agreement is fair. Meanwhile, in the energy range of -4 − 0 eV, XPS result shows good consistency with UPS spectra, theoretical total DOS and Cu d PDOS. Such agreement between XPS and UPS may originate from the composition of states in this energy region, where it is of notable Cu $3d$ character and only a little O $2p$ contribution. Thus, the weakness of cross-section ratio in XPS or UPS is not a serious issue, and they can give the similar results. This is not the same cases in Cu_4O_3 and CuO (we will discuss later). Looking at the dominant O $2p$ character in the energy range of -7 − -5 eV, the

theoretical DOSs exhibit similar shape with respect to UPS spectrum, but the theoretical peak positions show approx. 0.6 eV shift to high energy. The origin of this minus discrepancy remains unknown. But one should keep in mind that photoemission, especially UPS, is a surface sensitive technique whereas the *ab* initio calculations are, in general, performed for a perfect bulk band structure. Therefore, the change of surface in thin films could influence the binding energy of states [148].

Turning towards the metastable phase Cu_4O_3, a comparison between photoemission spectra and theoretical DOSs is presented in Fig. 5.11. Looking at the details of Cu *d* and O *p* PDOSs, it is shown that both are spread in a wide energy range of -8 − 0 eV, which could enhance the difficulty for UPS analyses. Three energy regions can also be identified in theoretical DOSs: between -7 and -5 eV (mainly O 2*p*); from -5 to -2 eV (significant Cu 3*d* character, but a high intensity of O 2*p*); hybridization between Cu 3*d* and more pronounced O 2*p* in the energy range of -2 − 0 eV. Our calculated full DOS by $GW^{LF} + V_d$ exhibits 4 featured peaks at about -6.5, -4.2, -3, and -1 eV, respectively, which mimics the basic shape of the UPS spectrum. However, the theoretical peak at -4.2 eV with a Cu *d* character in the total DOS is not clearly observed by the UPS, but XPS works well, which may originate from the issue of photoionization cross sections in O 2*p* and Cu 3*d* states. As mentioned above, the cross-section ratio of 1.41 between O 2*p* and Cu 3*d* for He I source indicates underestimated Cu 3*d* states, which could cause some lost Cu 3*d* featured peaks that can be detected by XPS. Moreover, the Cu *d* PDOS shows similar shape with XPS spectrum, and the significant O 2*p* character at -7 − -5 eV in DOSs reproduces the UPS features in the same energy region, which indicates the reliable calculation here.
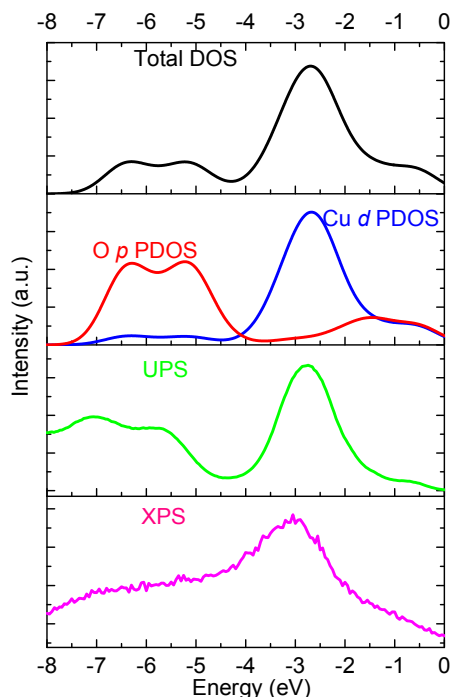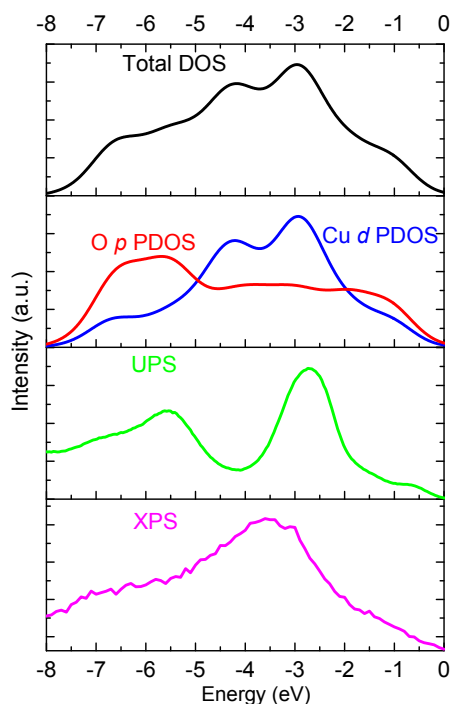
Fig. 5.11 Experimental valence band spectra and calculated DOSs of Cu_4O_3. The VBM is set to zero. The theoretical total DOS (in black), O p (in red) and Cu d (in blue) PDOS are convoluted with a Gaussian broadening of 0.4 eV to mimic temperature and instrumental broadening effects. Besides, all DOSs have been normalized to integrate to unity over the valence band. UPS and XPS spectra are plotted in green and magenta, respectively.

Moving onto CuO, our UPS spectrum here firstly is compared with other reported experimental results, as shown in Fig. 5.12. For the spectrum obtained by Greiner et al. in Ref.[149], it is an in-situ measurement from CuO thin films. Theoretically speaking, this kind of in-situ measurement is reliable as there is no contamination or no etching. However, we have also checked much more reported UPS or XPS valence band spectra of CuO from thin films [130] or single crystal [150], and it is found that most of the valence band spectra show the characteristics in Ref. [130] by Ghijsen et al. As shown in Fig. 5. 12, our UPS spectrum has the almost the same peak positions with that in Ref. [130].
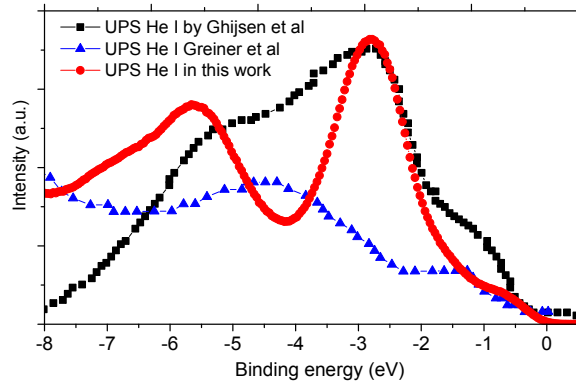
Fig. 5.12 Experimental UPS valence band spectra CuO. The other reported spectra are attained from Ref. [130] by Ghijsen et al and Ref. [149] by Greiner et al.

In Fig. 5.13, the experimental valence band spectra of CuO thin film are shown in comparison to the theoretical DOSs calculated by $GW^{LF} + V_d$ approach. As similar as Cu_4O_3, Cu d and O p PDOSs are also distributed in a wide energy range of -8 − 0 eV, and the total DOSs can be divided into three regions. O $2p$ character is notable in the energy ranges of -7 − -5 eV and -3 − 0 eV, while Cu $3d$ is concentrated in -5 − 3 eV. At first glance, the theoretical total DOS and UPS spectrum show less satisfactory agreement, as the maximum peak at -4 eV with Cu d character in the total DOS contradicts to a valley in the UPS spectrum. Indeed, the XPS with larger penetration depth and more Cu $3d$ sensitivity than UPS, succeeds to detect this peak. Furthermore, the shape of Cu d PDOS is well consistent with the XPS spectrum, indicating the fair agreement between photoemission spectra and theoretical DOSs. Regarding the valley at about -4 eV in the UPS curve, this has also been observed in Ref. [150] by Shen et al.. Shen et al. believed that this valley may come from the instability of CuO in UHV, as the freshly cleaved CuO single crystal did not show clear valley.
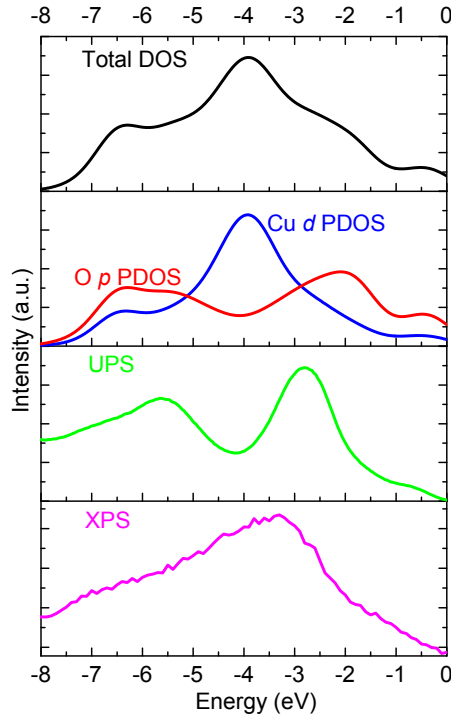
Fig. 5.13 Experimental valence band spectra and calculated DOSs of CuO. The VBM is set to zero. The theoretical total DOS (in black), O p (in red) and Cu d (in blue) PDOS are convoluted with a Gaussian broadening of 0.4 eV to mimic temperature and instrumental broadening effects. Besides, all DOSs have been normalized to integrate to unity over the valence band. UPS and XPS spectra are plotted in green and magenta, respectively.

5.3.3 XPS core level and EELS spectra

The Cu $2p_{3/2}$ XPS core level spectra of copper oxides are shown in Fig. 5.14. Satellite peaks in CuO due to the intra-atomic multiplet coupling and hybridization have been clearly observed, but they are absent in Cu_2O, which exhibits the well-known characteristics of Cu_2O and CuO and agrees well with other reported spectra [130]. Similar satellite peaks in Cu_4O_3 demonstrate the configuration of Cu^{2+} in the ground state. The FWHMs of main peaks at about 933 eV in Cu_4O_3 and CuO are 1.9 eV and 2.3, respectively, which are broader than that of 1.7 eV in Cu_2O thin films. As the similar peak shapes and peak positions of Cu $2p_{3/2}$ between Cu_4O_3 and CuO, it is believed that XPS may not be a powerful technic to distinguish them.
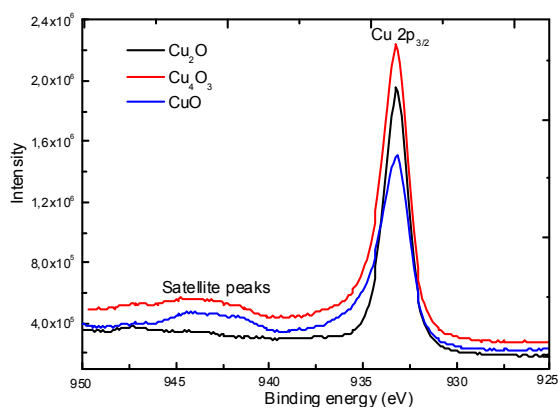
Fig. 5.14　Cu $2p_{3/2}$ core-level XPS spectra of Cu_2O, Cu_4O_3 and CuO thin films.

In order to study the electronic structures of copper oxides deeply, the EELS with the characteristic of transmission electrons is employed, superior to the surface sensitive photoemission spectroscopy. Energy loss near edge structure (ELNES) spectra of Cu $L_{2,3}$ and O K edges have been recorded, as shown in Fig. 5.15(a) and (b), respectively. The spectra shape and the relative position of Cu $L_{2,3}$ edges in CuO and Cu_2O, particular the substructure configurations (denoted as * in Fig. 5.15) in Cu_2O, are in excellent agreements with previous reports by X-ray absorption spectroscopy (XAS) [133], [136], [151], indicating the good resolution and precision of ELNES in this work. As seen in Fig. 5.15(a), strong and sharp $L_{2,3}$ white lines have been observed in Cu_2O, which is in contrast to the traditional simple ionic model. The dipole selection rules allow transitions from the $2p$ level into final states of s ($\Delta l = $ -1) or d ($\Delta l = +1$) character, but the $\Delta l = $ -1 channel is extremely low and it can be safely ignored in a first approximation [131]. Hence, the presence of L edges white lines in EELS or XAS requires the unfilled d shell. However, the traditional simple ionic model treats Cu^{1+} as a $3d^{10}$ cation with a full d shell, consequently there should be no L edges white lines in Cu_2O. However, there is no doubt that the sharp Cu $L_{2,3}$ white lines in Cu_2O can always be measured by EELS or XAS [131], [133], [136], [151]. The origin of this kind of 'unfilled' $3d$ shell in Cu_2O remains controversial. One hypothesis assumes that the $3d$ shell of metallic Cu just has 9.6 electrons, and there is only 9.5 electrons in $3d$ orbital of Cu_2O [152], [153]. Since this assumption employs the questionable white lines in metallic Cu, we believe that this hypothesis may require to be reconsidered carefully. Another one deems that the pronounced

on-site Cu $3d$-$4s$ hybridization in Cu_2O will produce significant unoccupied $4s$ states in the conduction band [136]. On the contrary, one hypothesis supposes that the empty $3d$ shell originates from the hybridization of d_z^2 and higher-energy unoccupied $4s$, which makes the d_z^2 unoccupied [154]. From the viewpoint of charge density, 0.22 electrons per atom are removed from d_z^2 states due to the hybridization [154], leading to the unfilled d shell. $GW^{LF} + V_d$ calculations also predict an unusual Cu dz^2-s hybridization and a strong Cu $3d$ contribution to the conduction band, as Cu-dz^2 and Cu-s orbitals share a common point group representation (see Ref. [24]).
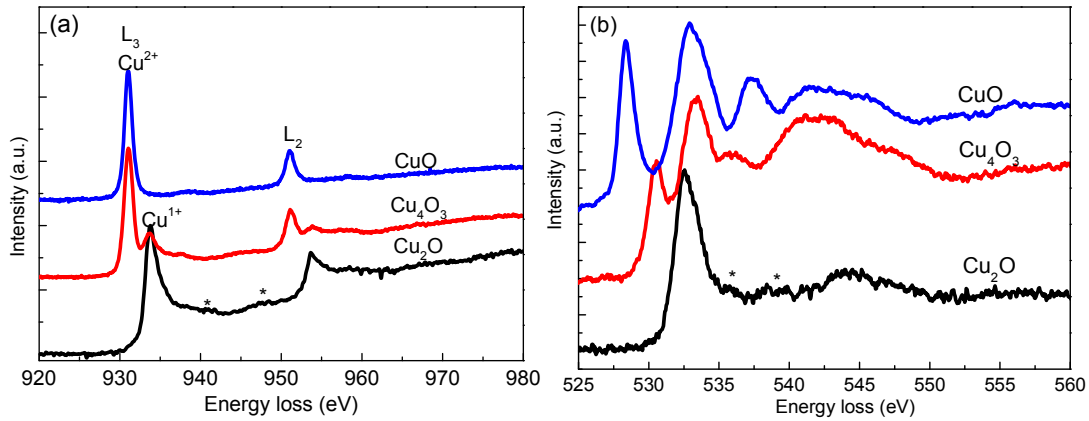
Fig. 5.15 (a) Cu $L_{2,3}$ edges (b) O K edge ELNES spectra of Cu_2O, Cu_4O_3 and CuO, normalized to the peak height.

Checking the peak positions of Cu $L_{2,3}$ white lines in Cu_2O and CuO (see Fig. 5.15(a)), it is revealed that the positions of Cu $L_{2,3}$ edges are shift to lower energy loss for the higher oxidation state. This contradicts the trends in Mn, V and Fe oxides that the energy loss moves to higher energy for the higher oxidation state [155]. Employing the Cu L_3 edges of Cu_2O and CuO as references, the white lines of Cu_4O_3 can be identified easily, where the strongest peak with the energy loss of 931.1 eV and the shake-up peak at 933.7 eV correspond to Cu^{2+} and Cu^{1+}, respectively, as shown in Fig. 5.15(a). Similar situation exists in L_2 edge. Concerning the O K edges, these three phases exhibit significant discrepancies, as shown in Fig. 5.15(b). Cu_2O shows a prominent peak at 532.5 eV and minor features at higher energy loss. In the case of Cu_4O_3, four peaks located at about 530.5, 533.4, 536 and 541 eV can be determined.

While four notable peaks with energy loss of 528.4, 532.9, 537.4, and 541 eV, are observed in CuO. Utilizing the peaks with maximum intensities at about $532 - 533$ eV as references, the existence of pre-peaks with lower energy loss, as well as their relative energy shifts, could be good indicators to distinguish these phases.

5.3.4 Conduction band electronic structure

In ELNES, L_3 edge means $2p_{3/2}$ electrons are ejected to unoccupied d states above Fermi level, while O K edge represents 1 s electrons are ejected to empty p states, within the consideration of parities between initial and final states. Then, it is interesting to perform the comparisons between experimental Cu L_3 ELNES spectrum and theoretical empty Cu d states in the conduction band, together with O K edge and O p states. Fig. 5.16 clearly shows that the theoretical empty states calculated by $GW^{LF} + V_d$ do so well for the experimental ELNES spectra in Cu and O of Cu_2O, including the basic shape, the relative position and substructure configuration. Similar comparisons in Cu_4O_3 also exhibit well consistency (see Fig. 5.17). It is worth noting that the Cu d and O p PDOSs in the conduction band of Cu_4O_3 calculated by LDA+U do not show so much accordance with the experiments. The comparisons of CuO are shown in Fig. 5.18, which demonstrates that most of the experimental features are well reproduced by the theory. Here, it is worth noting that some minus disagreement seems to exist in these comparisons, e.g. the peak at about 4 eV in O K edge of Cu_4O_3 has a shift with theoretical position (see Fig. 5.17(b)), or the peak at 6 eV in Cu d PDOS of CuO is not clearly observed in the experiments (see Fig. 5.18(a)). But we still believe that the $GW^{LF} + V_d$ calculation can describe the conduction band fairly, as most of experimental features are predicted by the theory. One possible source for this disagreement is the neglecting s state in the comparison between Cu L_3 edge and Cu d PDOS. Usually, we only consider the ejected $2p$ electrons move onto empty d states, as we did in this work. Actually, they can also move onto empty s state with very low density. When we talk about the while lines (sharp peaks), we do not consider the s state. But for the substructure peaks, s state may make contribution.
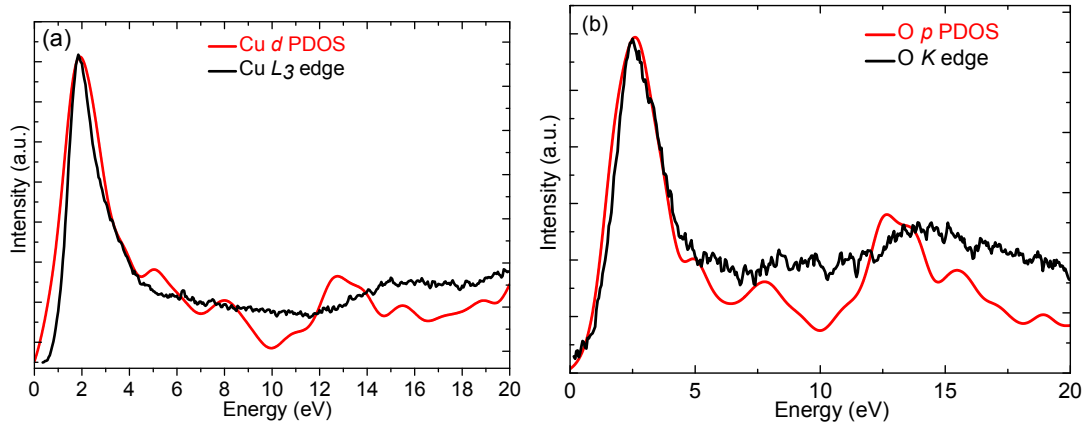
Fig. 5.16 (a) Experimental Cu L_3 edge ELNES spectrum of Cu_2O is compared with the Cu d PDOS in conduction band. (b) Experimental O K edge spectrum is compared with O p PDOS of Cu_2O in conduction band. The experimental spectra are shift to align with the leading peak of PDOSs. PDOS are convoluted with a Gaussian broadening of 0.4 eV.
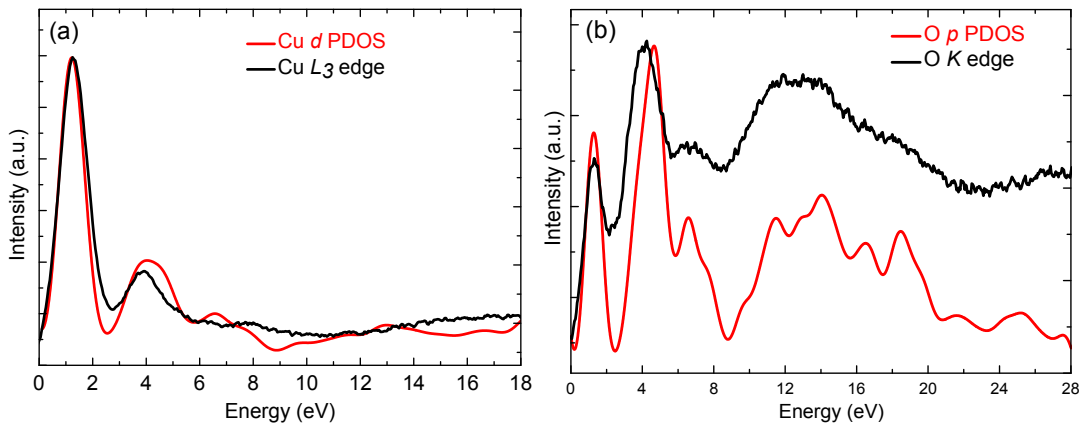
Fig. 5.17 (a) Experimental Cu L_3 edge ELNES spectrum of Cu_4O_3 is compared with the Cu d PDOS in conduction band. (b) Experimental O K edge spectrum is compared with O p PDOS of Cu_2O in conduction band. The experimental spectra are shift to align with the leading peak of PDOSs. PDOS are convoluted with a Gaussian broadening of 0.4 eV.
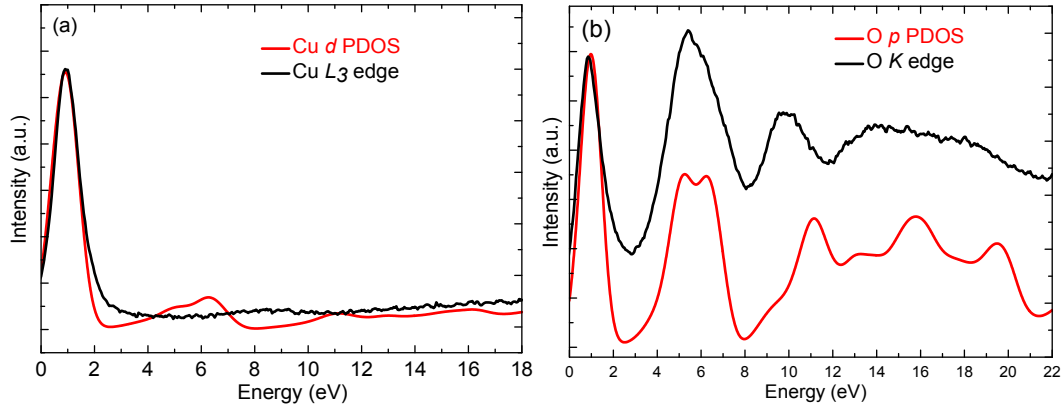
Fig. 5.18   (a) Experimental Cu L_3 edge ELNES spectrum of CuO is compared with the Cu d PDOS in conduction band. (b) Experimental O K edge spectrum is compared with O p PDOS of Cu_2O in conduction band. The experimental spectra are shift to align with the leading peak of PDOSs. PDOS are convoluted with a Gaussian broadening of 0.4 eV.

5.4   Chapter conclusions

Cu_2O thin films have been deposited on glass substrates at room temperature by reactive magnetron sputtering. As-deposited films were annealed in air to study the effect of the post-treatment on the structure, the electrical and the optical properties. Since Cu_2O is sensitive to oxidation, the thermal treatment has to be performed at temperature lower than 300 °C to keep a single Cu_2O phase. Annealing in air can increase the transmittance in visible region by the reduction of the impurity scattering. The optical band gap of Cu_2O thin films can be enlarged by increasing the annealing temperature. The partial removal of defect band tail is thought to be responsible for the increase of optical band gap. The origin of the peak at about 1.7 eV in photoluminescence spectra has been discussed preliminarily.

A joint experimental and theoretical study has been carried out to investigate the electronic structure of Cu_2O, Cu_4O_3 and CuO thin films. Optical absorption, photoemission and electron energy loss spectroscopies have been employed to determine the band gap, valence and conduction band structure, respectively, which are in comparisons with the theoretical results from many-body *GW* calculations within the consideration of local-field effect and an empirical on-site potential for transition metal d orbitals. The calculation predicts indirect band gap of 0.84 eV and direct band gap of 1.59 eV in Cu_4O_3, while the experimental optical absorption shows the threshold energy of the main absorption is about 1.37 eV at room

temperature and a sub-absorption exists below this threshold energy. In the case of CuO, theoretical calculation indicates an indirect band gap of 1.2 eV and a direct band gap of 1.48 eV, while a threshold energy of main absorption at about 1.5 eV is determined by optical absorption spectrum at room temperature and a weak sub-absorption is observed below this onset. Electron energy loss spectroscopy shows significant advance over X-ray photoemission spectroscopy to distinguish these three phases. Meanwhile, the partial density of states in conduction band measured by electron energy loss spectroscopy are fairly reproduced by the calculation. X-ray and ultraviolet photoemission spectroscopies have been combined together to study the valence band structure, while the experimental results show good consistency with the theoretical electronic structure. Therefore, the overall agreement between experimentally and theoretically determined band gap, valence and conduction band electronic structure, is remarkably satisfactory, which seems to indicate that this kind of *GW* scheme within the consideration of local-field effect and an empirical on-site potential for transition metal *d* orbitals has the potential to be universal method for electronic structure calculation. We hope that this work will stimulate further theoretical and experimental advances.

Conclusions and outlook

Binary copper oxide (Cu_2O, Cu_4O_3 and CuO) thin films have been selectively deposited on glass and silicon substrates by magnetron sputtering at room temperature from a metallic copper target in various Ar-O_2 reactive mixtures. A schematic deposition diagram, which describes the film structure as a function of O_2 flow rate and total pressure, is depicted by combining X-ray diffraction and Raman spectrometry. The oxygen flow rate process windows for Cu_2O or Cu_4O_3 single phase synthesis are narrow, while that for CuO is wider. Increasing the total pressure, the oxygen process windows to synthesize single phase Cu_2O and Cu_4O_3 have a tendency to become narrow, while the required oxygen flow rates are shifted to lower values. Between each single phase domain, the films are biphase: either Cu_2O + Cu_4O_3 or Cu_4O_3 + CuO. It is found that the deposition total pressure is a relevant parameter to control the texture and the morphology of pure Cu_2O and Cu_4O_3 films. Low total pressure favours the growth of planes with high surface energy ((100) for Cu_2O and (101) for Cu_4O_3) parallel to the substrate. On the other hand, high total pressure facilitates the growth of planes with low surface energy ((111) for Cu_2O and (100) for Cu_4O_3). The oxygen flow rate is effective to control the preferred orientation of CuO thin films that evolves from <111> to <$\bar{1}$11> with the increase of oxygen flow rate.

Local homoepitaxial growth can be used to tune the growth orientations (<111> or <100>) of Cu_2O thin films on glass and silicon substrates. Using a two steps deposition procedure, a highly textured Cu_2O thin film with controlled orientation can be formed independently of the deposition conditions. A Cu_2O layer with preferred orientation acts as a continuous seed layer, which determines the crystal orientation of the top layer grown even after air exposure and/or without specific cleaning of the surface prior to deposition. High resolution transmission electron microscopy analyses evidence that the columns of top layer epitaxially grown on

columns of seed layer, with the character of one column on one column. This kind of local homoepitaxial growth can also be extended into tetragonal Cu_4O_3 thin films, but only to produce the <100> texture. Besides, a local heteroepitaxial growth with the character of several columns on one column has been observed in bilayer films of NiO on Cu_2O. Using a <111> oriented Cu_2O seed layer, a NiO layer with highly <111> texture and good crystallization can be formed, regardless of the intrinsic growth conditions of NiO.

An unusual microstructure has been evidenced in biphase Cu_2O and Cu_4O_3 thin films, where both phases have the vertically aligned columnar growth along the whole film thickness direction. The local homoepitaxial growth behavior of Cu_2O is thought to be responsible for such a new microstructure. The intermediate oxygen flow rate between those required to synthesize pure phase Cu_2O and Cu_4O_3 induces the formation of some Cu_2O nucleus. Then the local homoepitaxial growth effect provides a strong driving force to grow Cu_2O columns along the whole film thickness from these nucleuses. Consequently, the two phases (Cu_2O and Cu_4O_3) grow separately and independently with vertically aligned columnar microstructure. Such an unusual microstructure can also be extended to other materials with certain requirements. Lower resistivity has been observed in this kind of biphase thin films than single phase thin films, which may be due to the interface coupling between Cu_2O and Cu_4O_3 columns.

As-deposited Cu_2O films exhibit high electrical resistivity and low optical transmittance. To improve the film properties, post annealing treatments in air at various temperatures have been performed. Since Cu_2O is sensitive to oxidation, the thermal treatment has to be performed at temperature lower than 300 °C to keep a single Cu_2O phase. Annealing in air can increase the transmittance in visible region by the reduction of the defect density. Moreover, the optical band gap of Cu_2O thin films is enlarged from 2.38 to 2.51 eV with increasing annealing temperature. The increase of optical band gap accompanying the reduction of Urbach energy indicates that the widening of optical band gap may result from

the partial elimination of defect band tail after thermal annealing in air. Photoluminescence analyses have been performed on as-deposited and air annealed Cu_2O films. Combining our experimental results with recent reported calculations, the peak at about 1.7 eV in photoluminescence spectra is assigned to the recombination of first conduction band minimum to copper vacancy.

Finally, to bring relevant information about the electronic structure of copper oxides, a joint experimental and theoretical study has been carried out. The calculated absorption threshold energies for direct and allowed optical transitions agree well with optical absorption experiments. Indirect band gaps with smaller values than the direct and allowed band gaps have been predicted in Cu_4O_3 and CuO by calculations, which could be responsible for the experimental sub-gap absorptions. Electron energy loss spectra of three phases exhibit pronounced difference and it could be more powerful to distinguish them than surface sensitive photoemission spectroscopies. Sharp $L_{2,3}$ white lines have been observed in Cu_2O, which indicates the empty d states in the conduction band probably due to the hybridization. The unoccupied partial density of states in conduction band probed by electron energy loss spectroscopy are well reproduced by the GW calculation. X-ray and ultraviolet photoemission spectroscopies have been combined together to study the valence band structure, while the experimental spectra show good consistency with the theoretical electronic structure. Thus, the overall agreement between experiments and calculations in band gap, valence and conduction band electronic structure is remarkably good.

The work performed during this PhD opens future investigations. We list hereafter selected points that are suitable for further studies:

- In this thesis, the total sputtering pressure or oxygen flow rate can be used to tune the preferred growth orientation of copper oxide thin films, but we only provide some qualitative explanations. Further understanding of this tunable texture requires the

consideration of the concept of "energy per atom" and the ion bombardment effect by plasma diagnostic and simulation.

- Local homoepitaxial growth with characteristic of one column on one column can promote the <100> texture in tetragonal Cu_4O_3 thin films, but it fails in the <101> orientation. This kind of growth cannot be extended to monoclinic CuO thin films, either. The origin of this behavior is still unknown. Thin films with larger column width are needed to guarantee that the transmission electron microscopy sample thickness is less than the column width. Then clear images at the interface between two layers by high resolution transmission electron microscopy or scanning transmission electron microscopy could be attained, which may provide useful information on the atomic structure and chemistry of interface. Besides, in-situ morphology measurements by atomic probe microscopy may provide the understanding of nucleation in this local homoepitaxial growth.

- Up to now, one series of thin film solar cells with the structure of glass/Ni/Cu_2O/ZnO/Al-ZnO (1.5 cm x 1.5 cm) has been prepared, but the efficiency is only 0.083% (V_{OC} = 35 mV, I_{SC} = 0.047 mA, FF = 0.312). This weak efficiency may originate from a variety of factors, such as surface recombination (Cu_2O and ZnO are not synthesized in the same deposition chamber), low mobility of Cu_2O (substrate holder is not heated), and poor metallic electrodes. In order to increase the efficiency, more series of samples are required with special consideration on these negative effects.

- It is interesting to measure the optical absorption spectra of Cu_4O_3 and CuO thin films at low temperature (liquid He), in order to suppress the phonon-assisted transitions, which may provide useful information to assess the optical absorption characteristics. Moreover, further experimental investigations on the electronic structure of strong correlated CuO are required, such as measuring the valence band structure by a synchrotron beamline with different photon energies.

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Resume

Personal profile

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Education

Ph.D (Oct. 2012 – Nov. 2015) **Materials Science and Engineering**,

Université de Lorraine, Nancy, France/ Saarland University, Saarbrücken, Germany.

M.S. (Sep. 2009 – Jun. 2012) **Materials Physics & Chemistry**, Kunming University of

Science and Technology, Kunming, China.

B.S. (Sep. 2005 — Jun. 2009) **Microelectronics**, Xiangtan University, Xiangtan, China.

Research experience

Oct. 2012 – Current: Institut Jean Lamour, UMR 7198-CNRS, France

Mainly work on the reactively sputtered growth of copper oxide thin films (Cu_2O, Cu_4O_3 and CuO) with controllable growth orientations, microstructure characterizations by microscopy, and electronic structures by a joint experimental and theoretical study, under the supervision of Prof. Jean-Francois Pierson in France and Prof. Frank Mücklich in Germany.

Sep. 2009 – Jun. 2012:   Kunming University of Science and Technology, China

Dedicated to the growth of epitaxial $La_{1-x}Sr_xCoO_3$ and $La_{1-x}Ca_xMnO_3$ thin films on vicinal cut substrates by pulsed laser deposition and the response mechanism of transverse thermoelectric effect, under the supervision of Prof. Lan Yu.

Sep. 2008 – Jun. 2009:   Xiangtan University, China

Undergraduate thesis describes the influence of Rashba spin-orbit coupling and magnetic field on conductor of a quantum wire, conducted with Prof. Yuanping Chen.

Honors and awards

Sep. 2013   SFV Student Award in 19th International Vacuum Conference

May 2014   The best poster in E-MRS 2014 Spring Meeting

Research interests

1. Functional thin film growth and characterization

2. Nanomaterials for energy conversion and storage

3. Photovoltaic solar cells

4. Transparent conductive semiconductors

Experimental Skills

Magnetron sputtering   Pulsed laser deposition

X-ray diffraction   Hall effect measurements

Electron energy loss spectroscopy (EELS)   PPMS/SQUID

UV-Vis-NIR spectroscopy   FTIR…

Publications

1. **Y. Wang**, J. Ghanbaja, S. Bruyère, F. Soldera, D. Horwat, F. Mücklich, I. Petrov, J.F. Pierson, Self-assembled growth of vertically aligned columnar copper oxide nanocomposite thin films on unmatched substrates. (In preparation)

2. **Y. Wang**, S. Lany, J. Ghanbaja, Y. Fagot-Revurat, Y.P. Chen, F. Soldera, F. Mücklich, J.F. Pierson, Electronic structure of Cu_2O, Cu_4O_3 and CuO: a joint experimental and theoretical study. (In preparation)

3. **Y. Wang**, J. Ghanbaja, S. Bruyère, P. Boulet, F. Soldera, D. Horwat, F. Mücklich, J.F. Pierson, Local heteroepitaxial growth to promote the selective growth orientation, crystallization and interband transition of sputtered NiO thin films. (In preparation)

4. **Y. Wang**, J. Ghanbaja, F. Soldera, S. Migot, D. Horwat, F. Mücklich, J.F. Pierson, Tuning the structure and preferred orientation in reactively sputtered copper oxide thin films. Applied Surface Science, 335 (2015) 85.

5. **Y. Wang**, J. Ghanbaja, F. Soldera, P. Boulet, D. Horwat, F. Mücklich, J.F. Pierson, Controlling the preferred orientation in sputter-deposited Cu_2O thin films: influence of the initial growth stage and homoepitaxial growth mechanism. Acta Materialia, 75 (2014) 207.

6. **Y. Wang**, P. Miska, D. Pilloud, D. Horwat, F. Mücklich, J.F. Pierson, Transmittance enhancement and optical band gap widening of Cu_2O thin films annealed in air. Journal of Applied Physics, 115 (2014) 073505.

7. L. Yu, **Y. Wang**, P. X. Zhang, H.-U. Habermeier, Ultrafast transverse thermoelectric response in c-axis inclined epitaxial $La_{0.5}Sr_{0.5}CoO_3$ thin films. Physica Status Solidi (Rapid Research Letters), 7 (2013) 180.

8. L. Yu, **Y. Wang**, H.-U. Habermeier, Resistivity anisotropy of layered cobaltite Na_xCoO_2 thin films. Applied Physics A, 113 (2013) 569.

9. **Y. Wang**, L. Yu, L. W. Chen, W. G. Gao, X. L. Du, L. H. Biao, Porous microstructure modification of $La_{1-x}Sr_xCoO_3$ ($0 \leq x \leq 1$) ceramics via Sr content. Materials Letters, 75 (2012) 39.

10. **Y. Wang**, L. Yu, B. Jiang, P. X. Zhang, Transverse thermoelectric response in La$_{1-x}$Sr$_x$CoO$_3$ (0.05 ≤ x ≤ 0.4) thin films with c-axis tilting. Journal of Applied Physics, 110 (2011) 123111.

11. L. Yu, **Y. Wang**, P. X. Zhang, H.-U. Habermeier, Epitaxial La$_{0.9}$Ca$_{0.1}$MnO$_3$ films grown on vicinal cut substrates for the investigation of resistivity and thermoelectric anisotropy. Journal of Crystal Growth, 322 (2011) 41.

12. L. Yu, L. Gu, **Y. Wang**, P. X. Zhang, H.-U. Habermeier, Epitaxial layered cobaltite Na$_x$CoO$_2$ thin films grown on planar and vicinal cut substrates. Journal of Crystal Growth, 328 (2011) 34.

13. L. Yu, **Y. Wang**, H. S. Li, X. Liu, P. X. Zhang, Post annealing effect on transport properties of La$_{0.67}$Ca$_{0.33}$MnO$_3$ films grown on vicinal cut substrates. Journal of Alloys and Compounds, 509 (2011) 8991.

14. G. W. Yan, L. Yu, **Y. Wang**, H. Zhang, P. X. Zhang, H.-U. Habermeier, Thermoelectric conversion via laser-induced voltage in highly textured polycrystalline Na$_x$CoO$_2$ ceramic. Journal of Applied Physics, 110 (2011) 103102.

Oral communications in conferences

1. **Y. Wang**, J. Ghanbaja, P. Boulet, D. Horwat, F. Soldera, F. Mücklich, J.F. Pierson, *Local homoepitaxial growth in reactively sputtered copper oxide thin films*, **European Materials Research Society Spring meeting (EMRS 2015 Spring)**, May. 2015, Lille (France).

2. J.F. Pierson, **Y. Wang**, J. Ghanbaja, S. Bruyère, D. Horwat, F. Soldera, F. Mücklich, *Tuning the preferred growth orientation of reactively sputtered NiO thin films*, **European Materials Research Society Spring meeting (EMRS 2015 Spring)**, May. 2015, Lille (France).

3. **Y. Wang**, J. Ghanbaja, P. Boulet, D. Horwat, F. Soldera, F. Mücklich, J.F. Pierson, *Electrical and optical properties of binary copper oxide thin films*, **5th International Symposium on Transparent Conductive Materials (TCM2014)**, Oct. 2014, Chania (Greece).

4. **Y. Wang**, J. Ghanbaja, Y. Fagot-Revurat, D. Horwat, F. Soldera, F. Mücklich, J.F. Pierson, *Structural, electrical and optical properties of reactively sputtered binary copper oxide thin films*, **European Materials Research Society fall meeting (EMRS 2014 Fall)**, Sep. 2014, Warwaw (Poland).

5. **Y. Wang**, J. Ghanbaja, F. Soldera, A. Mezin, D. Horwat, F. Soldera, F. Mücklich, J.F. Pierson, *Influence of oxygen partial pressure on the functional properties of nickel oxide sputtered films*, **European Materials Research Society fall meeting (EMRS 2014 Fall)**, Sep. 2014, Warwaw (Poland).

6. **Y. Wang**, J. Ghanbaja, D. Horwat, F. Soldera, F. Mücklich, J.F. Pierson, *Structural, electrical and optical properties of copper oxide thin films*, **International Workshop on Nanomaterials**, Sep. 2014, Nancy (France).

7. **Y. Wang**, D. Pilloud, J.F. Pierson, *Controllable growth of binary copper oxides by reactive direct-current magnetron sputtering*, **19th International Vacuum Conference (IVC-19)**, Sep. 2013, Paris (France).

8. Y. Wang, J. Ghanbaja, D. Horwat, F. Soldera, F. Mücklich, **J.F. Pierson**, *Copper oxide thin films with tuneable texture and microstructure*, **XXII International Materials Research Congress (IMRC 2013)**, Aug. 2013, Cancun (Mexico).

9. **J.F. Pierson**, Y. Wang, J. Ghanbaja, Y. Fagot-Revurat, D. Horwat, F. Soldera, F. Mücklich, *Towards an improvement of the functional properties of copper oxide thin films by the control of their composition and microstructure*, **1er colloque franco-marocain sur les Energies Nouvelles et Renouvelables (COFMER'01)**, Oct. 2014, Rabat (Maroc).

10. **J.F. Pierson**, Y. Wang, J. Ghanbaja, F. Soldera, D. Horwat, F. Mücklich, *Local epitaxial growth in sputtered copper oxide films*, **13th International Conference on Reactive Sputter Deposition (RSD 2014)**, Dec. 2014, Ghent (Belgium).

Invited talks in conferences

1. **<u>J.F. Pierson</u>**, Y. Wang, J. Ghanbaja, S. Migot, P. Boulet, F. Soldera, D. Horwat, F. Mücklich, *Growth, structure and properties of reactively sputtered copper oxide thin films*, **International Conference on Materials and Characterization Techniques (ICMCT 2014)**, Mar. 2014, Vellore (India).

2. **<u>J.F. Pierson</u>**, Y. Wang, J. Ghanbaja, D. Horwat, F. Soldera, F. Mücklich, *Consequence of local epitaxial growth on the microstructure of sputtered copper oxide films,* **Materials Research Society Spring Meeting (MRS 2015 spring)**, April 2015, San Francisco (USA).

3. **<u>J.F. Pierson</u>**, Y. Wang, J. Ghanbaja, P. Boulet, D. Horwat, F. Soldera, F. Mücklich, *Local epitaxial growth of copper oxide thin films*, **8th International Conference on Materials for Advanced Technologies (ICMAT)**, Jun. 2015, Singapore.

4. **<u>J.F. Pierson</u>**, Y. Wang, J. Ghanbaja, F. Soldera, D. Horwat, F. Mücklich, *Local epitaxial growth effect in reactively sputtered oxide thin films*, **19th Vacuum, Electron and Ion Technologies (VEIT)**, Sep. 2015, Sozopol (Bulgaria).

Poster communications in conferences

1. **Y. Wang**, J. Ghanbaja, Y. Fagot-Revurat, F. Soldera, D. Horwat, F. Mücklich, J. F. Pierson**, *Electronic structures of binary copper oxide thin films*, **European Materials Research Society Spring meeting (EMRS 2015 Spring)**, May. 2015, Lille (France).

2. **Y. Wang**, J. Ghanbaja, F. Soldera, A. Mezin, D. Horwat, F. Soldera, F. Mücklich, J.F. Pierson, *Growth and characterization of reactively sputtered NiO thin films,* **5th International Symposium on Transparent Conductive Materials (TCM2014)**, Oct. 2014, Chania (Greece).

3. Y. Wang, J. Ghanbaja, Y. Fagot-Revurat, D. Horwat, F. Soldera, F. Mücklich, **J.F. Pierson**, *Tuning the preferred growth orientation in reactively sputtered copper oxide thin films,* **14th International Conference on Plasma Surface Engineering (PSE2014)**, Sep. 2014, Garmisch (Germany).

4. Y. Wang, J. Ghanbaja, F. Soldera, A. Mezin, D. Horwat, F. Soldera, F. Mücklich, **J.F. Pierson**, *Growth of NiO thin films by reactive sputtering: roles of oxygen partial pressure and total pressure*, **14th International Conference on Plasma Surface Engineering (PSE2014)**, Sep. 2014, Garmisch (Germany).

4. Y. Wang, J. Ghanbaja, S. Migot, P. Boulet, P. Miska, D. Horwat, F. Soldera, F. Mücklich, **J.F. Pierson**, *Growth of copper oxide thin films by reactive sputtering: control of the texture and structure-properties relationship*, **European Materials Research Society spring meeting (EMRS 2014 Spring)**, May 2014, Lille (France).

5. **Y. Wang**, D. Pilloud, J. F. Pierson, *Electrical and optical properties of highly [100] textured Cu2O thin films annealed in air*, **European Materials Research Society spring meeting (EMRS 2013 Spring)**, May 2013, Strasbourg (France).

6. Y. Wang, J. Ghanbaja, D. Horwat, F. Soldera, F. Mücklich, **J.F. Pierson**, *Structure, morphology and texture of copper oxide thin films*, **9th Asian European International Conference on Plasma Surface Engineering (AEPSE 2013)**, Aug. 2013, Jeju (South Korea).

7. Y. Wang, J. Ghanbaja, F. Soldera, D. Horwat, F. Mücklich, **J.F. Pierson**, *Properties and preferred orientation in reactively sputtered NiO thin films*, **Research Society Spring Meeting (MRS 2015 spring)**, April 2015, San Francisco (USA).

8. **Y. Wang**, J. Ghanbaha, F. Soldera, D. Horwat, F. Mücklich, J.F. Pierson, Local epitaxial growth of copper and nickel oxide thin films, **Innovations on Thin Films Processing and Characterisation (ITFPC'15)** , Nov. 2015, Nancy (France).

Croissance controlleé, microstructure et structure électronique des oxydes de cuivre

Résumé : Des films minces d'oxydes de cuivre (Cu$_2$O, Cu$_4$O$_3$ et CuO) ont été déposés à température ambiante sur des substrats en verre et en silicium par pulvérisation magnétron réactive. Une attention particulière a été portée à l'influence des conditions de synthèse (débit d'oxygène et pression totale) sur la structure et l'orientation préférentielle des dépôts. La pression totale est le paramètre principal influençant la texture des films de Cu$_2$O et de Cu$_4$O$_3$. En revanche l'orientation préférentielle des films de CuO est contrôlée par le débit d'oxygène. Pour des films de Cu$_2$O et de Cu$_4$O$_3$, un phénomène de croissance épitaxique locale (CEL) a été mis en évidence. Il résulte de l'utilisation d'une première couche qui joue le rôle d'une couche de germination lors du processus de croissance. Ainsi, les films peuvent croître avec une texture donnée indépendamment de leurs conditions de synthèse. Cet effet de CEL a été mis à profit pour élaborer des films biphasés (Cu$_2$O + Cu$_4$O$_3$) qui présentent une microstructure originale. L'augmentation de la transmittance optique et du gap optique de films de Cu$_2$O a été rendue possible par des traitements thermiques dans l'air qui permettent de diminuer la densité de défauts dans les films. Finalement, les propriétés optiques et la structure électronique des oxydes de cuivre qui ont été calculées par la méthode *GW* sont en accord avec des résultats expérimentaux obtenus par absorption optique, photoémission et spectroscopie de perte d'énergie des électrons.

Mots-clés : oxydes de cuivre, films mines, microstructure, croissance épitaxique locale, structure électronique, propriétés optiques

Controllable growth, microstructure and electronic structure of copper oxide thin films

Abstract: Copper oxide (Cu$_2$O, Cu$_4$O$_3$ and CuO) thin films have been deposited on unmatched substrates by sputtering at room temperature. The influence of oxygen flow rate and total pressure on the film structure and preferred orientation has been studied. The total pressure is a relevant parameter to control the texture of Cu$_2$O and Cu$_4$O$_3$ films, while the oxygen flow rate is effective to tune the preferred orientation of CuO films. Local epitaxial growth, where epitaxial relationship exists in columns of sputtered films, has been observed in Cu$_2$O and Cu$_4$O$_3$ films by using a seed layer. The seed layer will govern the growth orientation of top layer via the local epitaxy, independently of the deposition conditions of top layer. Unusual microstructure that both phases have the vertically aligned columnar growth has been evidenced in biphase Cu$_2$O and Cu$_4$O$_3$, which may relate to the local epitaxial growth of Cu$_2$O. The lower resistivity than that in single phase films has been observed in this biphase film. Annealing in air can increase the transmittance of Cu$_2$O films in visible region by the reduction of the impurity scattering, while the optical band gap is enlarged due to the partial removal of defect band tail. The optical properties and electronic structure of copper oxides calculated by *GW* approach with an empirical on-site potential for Cu *d* orbital, are in good accordance with experimental results from optical absorption, photoemission and electron energy loss spectroscopies.

Keywords: copper oxide, thin films, microstructure, local epitaxial growth, electronic structure, optical properties